

GS1670A

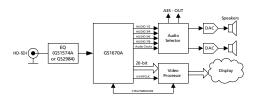
HD/SD SDI Receiver Complete with SMPTE Audio and Video Processing

Key Features

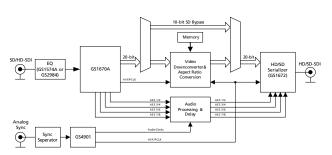
- Operation at 1.485Gb/s, 1.485/1.001Gb/s and 270Mb/s
- Supports SMPTE 292, SMPTE 259M-C and DVB-ASI
- Integrated Reclocker with low phase noise, integrated VCO
- Serial digital reclocked, or non-reclocked loop-through output
- Integrated audio de-embedder for 8 channels of 48kHz audio
- Integrated audio clock generator
- Ancillary data extraction
- Parallel data bus selectable as either 20-bit or 10-bit
- Comprehensive error detection and correction features
- Output H, V, F or CEA 861 timing signals
- 1.2V digital core power supply, 1.2V and 3.3V analog power supplies, and selectable 1.8V or 3.3V I/O power supply
- GSPI host interface
- Wide temperature range of -40°C to +85°C
- Low power operation (typically 300mW)
- Small 11mm x 11mm 100-ball BGA package
- Pb-free and RoHS compliant

Applications

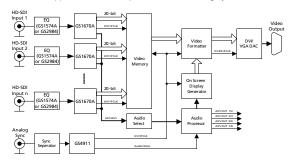
Application: 1080p30 or 720p60 Monitor



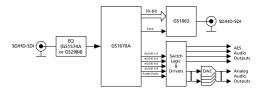
Application: Multi-format Downconverter



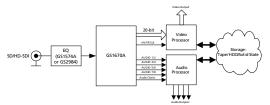
Application: Multi-input Video Monitoring System



Application: Multi-format Audio De-embedder Module



Application: Multi-format Digital VTR/Video Server



Description

The GS1670A is a multi-rate SDI Receiver which includes complete SMPTE processing, as per SMPTE 292 and SMPTE 259M-C. The SMPTE processing features can be bypassed to support signals with other coding schemes.

The device features an Integrated Reclocker with an internal VCO and a wide Input Jitter Tolerance (IJT) of 0.7UI.

A serial digital loop-through output is provided, which can be configured to output either reclocked or non-reclocked serial digital data. The serial digital output can be connected to an external cable driver.

The device operates in one of four basic modes: SMPTE mode, DVB-ASI mode, Data-Through mode or Standby mode.

In SMPTE mode, the GS1670A performs SMPTE de-scrambling and NRZI to NRZ decoding and word alignment. Line-based CRC errors, line number errors, TRS errors and ancillary data check sum errors can all be detected. The GS1670A also provides ancillary data extraction. The entire ancillary data packet is extracted, and written to host-accessible registers. Other processing functions include H:V:F timing extraction, Luma and Chroma ancillary data indication, video standard detection, and SMPTE 352M packet detection and decoding. All of the processing features are optional, and may be enabled or disabled via the Host Interface.

In DVB-ASI mode, 8b/10b decoding is applied to the received data stream.

In Data-Through mode all forms of SMPTE and DVB-ASI processing are disabled, and the device can be used as a simple serial to parallel converter.

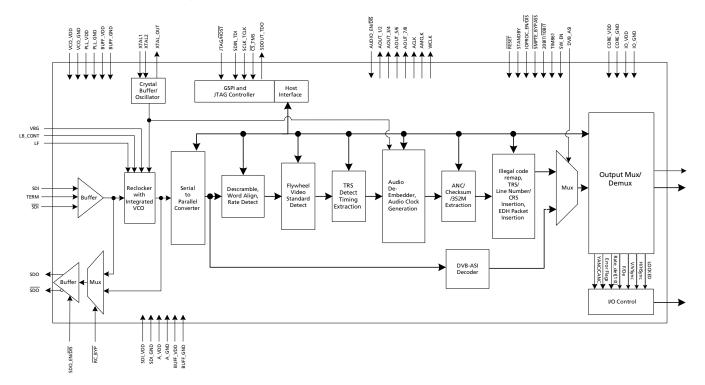
The device can also operate in a lower power Standby mode. In this mode, no signal processing is carried out and the parallel output is held static.

Parallel data outputs are provided in 20-bit or 10-bit multiplexed format for HD and SD video rates. The associated Parallel Clock input signal operates at 148.5 or 148.5/1.001MHz (HD 10-bit multiplexed modes), 74.25 or 74.25/1.001MHz (for HD 20-bit mode), 27MHz (for SD 10-bit mode) and 13.5MHz (for SD 20-bit mode).

Up to eight channels, in two groups, of serial digital audio may be extracted from the video data stream, in accordance with SMPTE 272M and SMPTE 299M. The output signal formats supported by the device include AES/EBU and three other industry standard serial digital formats. 16, 20 and 24-bit audio formats are supported at 48kHz synchronous for SD modes and 48kHz synchronous or asynchronous in HD mode. Additional audio processing features include group selection, channel swapping, ECC error detection and correction (HD mode only), and audio channel status extraction. Audio clock and control signals provided by the device include Word Clock (fs), Serial Clock (64fs), and Audio Master Clock at user-selectable rates of 128fs, 256fs or 512fs.



Functional Block Diagram



GS1670A Functional Block Diagram

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1. Pin Out

1.1 Pin Assignment

	1	2	3	4	5	6	7	8	9	10
Α	VBG	LF	LB_CONT	VCO_ VDD	STAT0	STAT1	IO_VDD	PCLK	DOUT18	DOUT17
В	A_VDD	PLL_ VDD	RSV	VCO_ GND	STAT2	STAT3	IO_GND	DOUT19	DOUT16	DOUT15
С	SDI	A_GND	PLL_ VDD	PLL_ VDD	STAT4	STAT5	RESET _TRST	DOUT12	DOUT14	DOUT13
D	SDI	A_GND	A_GND	PLL_ GND	CORE _GND	CORE _VDD	SW_EN	JTAG/ HOST	IO_GND	IO_VDD
Е	SDI_VDD	SDI_GND	A_GND	PLL_ GND	CORE _GND	CORE _VDD	SDOUT_ TDO	SDIN_ TDI	DOUT10	DOUT11
F	TERM	RSV	A_GND	PLL_ GND	CORE _GND	CORE _VDD	CS_ TMS	SCLK_ TCK	DOUT8	DOUT9
G	RSV	RSV	RC_BYP	RSV	CORE _GND	CORE _VDD	SMPTE_ BYPASS	DVB_ASI	IO_GND	IO_VDD
Н	BUFF_ VDD	BUFF_ GND	AUDIO_ EN/DIS	WCLK	TIM_861	XTAL_ OUT	<u>20bit/</u> 10bit	IOPROC_ EN/DIS	DOUT6	DOUT7
J	SDO	SDO_ EN/DIS	AOUT_1/2	ACLK	AOUT_5/6	XTAL2	IO_GND	DOUT1	DOUT4	DOUT5
K	SDO	STANDBY	AOUT_3/4	AMCLK	AOUT_7/8	XTAL1	IO_VDD	DOUT0	DOUT2	DOUT3

1.2 Pin Descriptions

Table 1-1: Pin Descriptions

Pin Number	Name	Timing	Туре	Description
A1	VBG		Analog Input	Band Gap voltage filter connection.
A2	LF		Analog Input	Loop Filter component connection.
A3	LB_CONT		Analog Input	Connection for loop bandwidth control resistor.
A4	VCO_VDD		Input Power	POWER pin for the VCO. Connect to a 1.2V \pm 5% analog supply followed by a RC filter (see 5.1 Typical Application Circuit). A 105 Ω 1% resistor must be used in the RC filter circuit. VCO_VDD is nominally 0.7V.

Table 1-1: Pin Descriptions (Continued)

Pin Number	Name	Timing	Туре	Description	
A5, A6, B5,	STAT[0:5]		Output	MULTI-FUNCTIONAL OU	JTPUT PORT.
B6, C5, C6					out Logic parameters in the DC Electrical logic level threshold and compatibility.
				Each of the STAT [0:5] p one of the following sig	ins can be configured individually to output gnals:
				Signal	Default
				H/HSYNC	STAT0
				V/VSYNC	STAT1
				F/DE	STAT2
				LOCKED	STAT3
				Y/1ANC	STAT4
				C/2ANC	_
				DATA ERROR	STAT5
				VIDEO ERROR	_
				AUDIO ERROR	_
				EDH DETECTED	_
				CARRIER DETECT	-
				RATE_DET	=
A7, D10, G10, K7	IO_VDD		Input Power	POWER connection for digital.	digital I/O. Connect to 3.3V or 1.8V DC
A8	PCLK		Output	PARALLEL DATA BUS CL	оск
					out Logic parameters in the DC Electrical logic level threshold and compatibility.
				HD 10-bit mode	PCLK @ 148.5 or 148.5/1.001MHz
				HD 20-bit mode	PCLK @ 74.25 or 74.25/1.001MHz
				SD 10-bit mode	PCLK @ 27MHz
				SD 20-bit mode	PCLK @ 13.5MHz

Table 1-1: Pin Descriptions (Continued)

Pin Number	Name	Timing	Туре	Description	
A9, A10, B8,	DOUT18, 17, 19,		Output	PARALLEL DATA BUS	
B9, B10,C8, C9, C10, E9, E10	16, 15, 12, 14, 13, 10, 11				out Logic parameters in the DC Electrical logic level threshold and compatibility.
210				20-bit mode 20bit/10bit = HIGH	SMPTE mode (SMPTE_BYPASS = HIGH and DVB_ASI = LOW): Luma data output for SD and HD data rates.
					DVB-ASI mode (<u>SMPTE_BYPASS</u> = LOW and DVB_ASI = HIGH): Not defined
					Data-Through mode (SMPTE_BYPASS = LOW and DVB_ASI = LOW): Data output
				10-bit mode 20bit/10bit = LOW	SMPTE mode (SMPTE_BYPASS = HIGH and DVB_ASI = LOW): Multiplexed Luma/Chroma data outpu for SD and HD data rates.
					DVB-ASI mode (<u>SMPTE_BYPASS</u> = LOW and DVB_ASI = HIGH): 8b/10b decoded DVB-ASI data
					Data-Through mode (SMPTE_BYPASS = LOW and DVB_ASI = LOW): Data output
B1	A_VDD		Input Power	POWER pin for analog o	ircuitry. Connect to 3.3V DC analog.
B2, C3, C4	PLL_VDD		Input Power	POWER pins for the Rec	locker PLL. Connect to 1.2V DC analog.
B3, F2, G1, G2, G4	RSV			These pins must be left	unconnected.
В4	VCO_GND		Input Power	GND pin for the VCO. Co	onnect to analog GND.
B7, D9, G9, J7	IO_GND		Input Power	GND connection for dig	ital I/O. Connect to digital GND.
C1, D1	SDI, SDI		Analog Input	Serial Digital Differentia	al Input.
C2, D2, D3, E3, F3	A_GND		Input Power	GND pins for sensitive a	nalog circuitry. Connect to analog GND.
C7	RESET_TRST		Input	CONTROL SIGNAL INPUT	Г
					t Logic parameters in the DC Electrical logic level threshold and compatibility.
				and to reset the JTAG se	
				Normal mode (JTAG/HO	ST = LOW): nal blocks are set to default conditions and
				all digital output signals	s become high impedance.
				·	eration of the device resumes.
				JTAG test mode (JTAG/H	·
				When LOW, all function sequence is reset.	al blocks are set to default and the JTAG tes
				When HIGH, normal operafter RESET_TRST is de-a	eration of the JTAG test sequence resumes asserted.



Table 1-1: Pin Descriptions (Continued)

SDI_VDD Input Power POWER pin for SDI buffer. Connect to 3.3V DC analog.	Pin Number	Name	Timing	Туре	Description
D6, E6, F6, G0RE_VDD	D4, E4, F4	PLL_GND		Input Power	GND pins for the Reclocker PLL. Connect to analog GND.
D7 SW_EN Input CONTROL SIGNAL INPUT Please refer to the Input Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. Used to enable switch-line locking, as described in Section 4.9.1. D8 JTAG/HOST Input CONTROL SIGNAL INPUT Please refer to the Input Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. Used to select JTAG test mode or host interface mode. When JTAG/HOST is HIGH, the host interface port is configured fo JTAG test. When JTAG/HOST is LOW, normal operation of the host interface port resumes. E1 SDI_VDD Input Power POWER pin for SDI buffer. Connect to 3.3V DC analog. E2 SDI_GND Input Power GND pin for SDI buffer. Connect to analog GND. E7 SDOUT_TDO Output COMMUNICATION SIGNAL OUTPUT Pleaser refer to the Output Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. GSPI serial data output/test data out. In JTAG mode (JTAG/HOST = HIGH), this pin is used to shift test results from the device. In host interface mode, this pin is used to read status and configuration data from the device. Note: GSPI selightly different than the SPI. For more details on GSP please refer to 4.19 GSPI - HOST Interface. E8 SDIN_TDI Input COMMUNICATION SIGNAL INPUT Please refer to the Input Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. GSPI serial data in/test data in. In JTAG mode (JTAG/HOST = HIGH), this pin is used to shift test data into the device. In host interface mode, this pin is used to write address and configuration data words into the device.		CORE_GND		Input Power	GND connection for device core. Connect to digital GND.
Please refer to the Input Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. Used to enable switch-line locking, as described in Section 4.9.1. D8 JTAG/HOST Input CONTROL SIGNAL INPUT Please refer to the Input Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. Used to select JTAG test mode or host interface mode, when JTAG/HOST is HIGH, the host interface port is configured fo JTAG test. When JTAG/HOST is LOW, normal operation of the host interface port resumes. E1 SDI_VDD Input Power GND pin for SDI buffer. Connect to 3.3V DC analog. E2 SDI_GND Input Power GND pin for SDI buffer. Connect to analog GND. E7 SDOUT_TDO Output COMMUNICATION SIGNAL OUTPUT Please refer to the Output Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. GSPI serial data output/test data out. In JTAG mode (JTAG/HOST = HIGH), this pin is used to shift test results from the device. In host interface mode, this pin is used to read status and configuration data from the device. Note: GSPI is slightly different than the SPI. For more details on GSP please refer to 4.19 GSPI - HOST Interface. E8 SDIN_TDI Input COMMUNICATION SIGNAL INPUT Please refer to the Input Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. GSPI serial data in/test data in. In JTAG mode (JTAG/HOST = HIGH), this pin is used to shift test dat into the device. In host interface mode, this pin is used to write address and configuration data words into the device.		CORE_VDD		Input Power	POWER connection for device core. Connect to 1.2V DC digital.
Characteristics table for logic level threshold and compatibility. Used to enable switch-line locking, as described in Section 4.9.1. D8 JTAG/HOST Input CONTROL SIGNAL INPUT Please refer to the Input Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. Used to select JTAG test mode or host interface mode. When JTAG/HOST is HIGH, the host interface port is configured fo JTAG test. When JTAG/HOST is LOW, normal operation of the host interface port resumes. E1 SDI_VDD Input Power POWER pin for SDI buffer. Connect to 3.3V DC analog. E2 SDI_GND Input Power GND pin for SDI buffer. Connect to analog GND. E7 SDOUT_TDO Output COMMUNICATION SIGNAL OUTPUT Please refer to the Output Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. GSPI serial data output/test data out. In JTAG mode (JTAG/HOST = HIGH), this pin is used to shift test results from the device. In host interface mode, this pin is used to read status and configuration data from the device. Note: GSPI is slightly different than the SPI. For more details on GSP please refer to 4.19 GSPI - HOST interface. E8 SDIN_TDI Input COMMUNICATION SIGNAL INPUT Please refer to the Input Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. GSPI serial data in/test data in. In JTAG mode (JTAG/HOST = HIGH), this pin is used to shift test dat into the device. In host interface mode, this pin is used to write address and configuration data words into the device.	D7	SW_EN		Input	CONTROL SIGNAL INPUT
D8 JTAG/HOST Input CONTROL SIGNAL INPUT Please refer to the Input Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. Used to select JTAG test mode or host interface mode. When JTAG/HOST is HIGH, the host interface port is configured fo JTAG test. When JTAG/HOST is LOW, normal operation of the host interface port resumes. E1 SDL_VDD Input Power POWER pin for SDI buffer. Connect to 3.3V DC analog. E2 SDL_GND Input Power GND pin for SDI buffer. Connect to analog GND. E7 SDOUT_TDO Output COMMUNICATION SIGNAL OUTPUT Please refer to the Output Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. G5PI serial data output/test data out. In JTAG mode (JTAG/HOST = HIGH), this pin is used to shift test results from the device. In host interface mode, this pin is used to read status and configuration data from the device. Note: G5PI is slightly different than the SPI. For more details on G5P please refer to 4.19 G5PI - HOST Interface. E8 SDIN_TDI Input COMMUNICATION SIGNAL INPUT Please refer to the Input Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. G5PI serial data in/test data in. In JTAG mode (JTAG/HOST = HIGH), this pin is used to shift test dat into the device. In host interface mode, this pin is used to write address and configuration data words into the device.					
Please refer to the Input Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. Used to select JTAG test mode or host interface mode. When JTAG/HOST is HIGH, the host interface port is configured fo JTAG test. When JTAG/HOST is LOW, normal operation of the host interface port resumes. E1 SDI_VDD Input Power POWER pin for SDI buffer. Connect to 3.3V DC analog. E2 SDI_GND Input Power GND pin for SDI buffer. Connect to analog GND. E7 SDOUT_TDO Output COMMUNICATION SIGNAL OUTPUT Please refer to the Output Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. G5PI serial data output/test data out. In JTAG mode (JTAG/HOST = HIGH), this pin is used to shift test results from the device. Note: G5PI is slightly different than the SPI. For more details on GSF please refer to 4.19 GSPI - HOST Interface. E8 SDIN_TDI Input COMMUNICATION SIGNAL INPUT Please refer to the Input Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. G5PI serial data in/test data in. In JTAG mode (JTAG/HOST = HIGH), this pin is used to shift test dat into the device. In host interface mode, this pin is used to write address and configuration data words into the device.					Used to enable switch-line locking, as described in Section 4.9.1.
Characteristics table for logic level threshold and compatibility. Used to select JTAG test mode or host interface mode. When JTAG/HOST is HIGH, the host interface port is configured fo JTAG test. When JTAG/HOST is LOW, normal operation of the host interface port resumes. E1 SDI_VDD Input Power POWER pin for SDI buffer. Connect to 3.3V DC analog. E2 SDI_GND Input Power GND pin for SDI buffer. Connect to analog GND. E7 SDOUT_TDO Output COMMUNICATION SIGNAL OUTPUT Please refer to the Output Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. GSPI serial data output/test data out. In JTAG mode (JTAG/HOST = HIGH), this pin is used to shift test results from the device. In host interface mode, this pin is used to read status and configuration data from the device. Note: GSPI is slightly different than the SPI. For more details on GSP please refer to 4.19 GSPI - HOST Interface. E8 SDIN_TDI Input COMMUNICATION SIGNAL INPUT Please refer to the Input Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. GSPI serial data in/test data in. In JTAG mode (JTAG/HOST = HIGH), this pin is used to shift test dat into the device. In host interface mode, this pin is used to write address and configuration data words into the device.	D8	JTAG/HOST		Input	CONTROL SIGNAL INPUT
When JTAG/HOST is HIGH, the host interface port is configured fo JTAG test. When JTAG/HOST is LOW, normal operation of the host interface port resumes. E1 SDI_VDD Input Power POWER pin for SDI buffer. Connect to 3.3V DC analog. E2 SDI_GND Input Power GND pin for SDI buffer. Connect to analog GND. E7 SDOUT_TDO Output COMMUNICATION SIGNAL OUTPUT Please refer to the Output Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. GSPI serial data output/test data out. In JTAG mode (JTAG/HOST = HIGH), this pin is used to shift test results from the device. Note: GSPI is slightly different than the SPI. For more details on GSP please refer to 4.19 GSPI - HOST Interface. E8 SDIN_TDI Input COMMUNICATION SIGNAL INPUT Please refer to the Input Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. GSPI serial data in/test data in. In JTAG mode (JTAG/HOST = HIGH), this pin is used to shift test dat into the device. In host interface mode, this pin is used to write address and configuration data words into the device.					
BI SDI_VDD Input Power POWER pin for SDI buffer. Connect to 3.3V DC analog. E2 SDI_GND Input Power GND pin for SDI buffer. Connect to analog GND. E7 SDOUT_TDO Output COMMUNICATION SIGNAL OUTPUT Please refer to the Output Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. GSPI serial data output/test data out. In JTAG mode (JTAG/HOST = HIGH), this pin is used to shift test results from the device. In host interface mode, this pin is used to read status and configuration data from the device. Note: GSPI is slightly different than the SPI. For more details on GSP please refer to 4.19 GSPI - HOST Interface. E8 SDIN_TDI Input COMMUNICATION SIGNAL INPUT Please refer to the Input Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. GSPI serial data in/test data in. In JTAG mode (JTAG/HOST = HIGH), this pin is used to shift test dat into the device. In host interface mode, this pin is used to write address and configuration data words into the device.					Used to select JTAG test mode or host interface mode.
E1 SDI_VDD Input Power POWER pin for SDI buffer. Connect to 3.3V DC analog. E2 SDI_GND Input Power GND pin for SDI buffer. Connect to analog GND. E7 SDOUT_TDO Output COMMUNICATION SIGNAL OUTPUT Please refer to the Output Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. GSPI serial data output/test data out. In JTAG mode (JTAG/HOST = HIGH), this pin is used to shift test results from the device. In host interface mode, this pin is used to read status and configuration data from the device. Note: GSPI is slightly different than the SPI. For more details on GSP please refer to 4.19 GSPI - HOST Interface. E8 SDIN_TDI Input COMMUNICATION SIGNAL INPUT Please refer to the Input Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. GSPI serial data in/test data in. In JTAG mode (JTAG/HOST = HIGH), this pin is used to shift test dat into the device. In host interface mode, this pin is used to write address and configuration data words into the device.					When JTAG/HOST is HIGH, the host interface port is configured for JTAG test.
E2 SDI_GND Input Power GND pin for SDI buffer. Connect to analog GND. E7 SDOUT_TDO Output COMMUNICATION SIGNAL OUTPUT Please refer to the Output Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. GSPI serial data output/test data out. In JTAG mode (JTAG/HOST = HIGH), this pin is used to shift test results from the device. In host interface mode, this pin is used to read status and configuration data from the device. Note: GSPI is slightly different than the SPI. For more details on GSP please refer to 4.19 GSPI - HOST Interface. E8 SDIN_TDI Input COMMUNICATION SIGNAL INPUT Please refer to the Input Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. GSPI serial data in/test data in. In JTAG mode (JTAG/HOST = HIGH), this pin is used to shift test dat into the device. In host interface mode, this pin is used to write address and configuration data words into the device.					
E8 SDIN_TDI Input COMMUNICATION SIGNAL OUTPUT Please refer to the Output Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. GSPI serial data output/test data out. In JTAG mode (JTAG/HOST = HIGH), this pin is used to shift test results from the device. In host interface mode, this pin is used to read status and configuration data from the device. Note: GSPI is slightly different than the SPI. For more details on GSF please refer to 4.19 GSPI - HOST Interface. E8 SDIN_TDI Input COMMUNICATION SIGNAL INPUT Please refer to the Input Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. GSPI serial data in/test data in. In JTAG mode (JTAG/HOST = HIGH), this pin is used to shift test dat into the device. In host interface mode, this pin is used to write address and configuration data words into the device.	E1	SDI_VDD		Input Power	POWER pin for SDI buffer. Connect to 3.3V DC analog.
Please refer to the Output Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. GSPI serial data output/test data out. In JTAG mode (JTAG/HOST = HIGH), this pin is used to shift test results from the device. In host interface mode, this pin is used to read status and configuration data from the device. Note: GSPI is slightly different than the SPI. For more details on GSP please refer to 4.19 GSPI - HOST Interface. E8 SDIN_TDI Input COMMUNICATION SIGNAL INPUT Please refer to the Input Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. GSPI serial data in/test data in. In JTAG mode (JTAG/HOST = HIGH), this pin is used to shift test data into the device. In host interface mode, this pin is used to write address and configuration data words into the device.	E2	SDI_GND		Input Power	GND pin for SDI buffer. Connect to analog GND.
Characteristics table for logic level threshold and compatibility. GSPI serial data output/test data out. In JTAG mode (JTAG/HOST = HIGH), this pin is used to shift test results from the device. In host interface mode, this pin is used to read status and configuration data from the device. Note: GSPI is slightly different than the SPI. For more details on GSP please refer to 4.19 GSPI - HOST Interface. E8 SDIN_TDI Input COMMUNICATION SIGNAL INPUT Please refer to the Input Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. GSPI serial data in/test data in. In JTAG mode (JTAG/HOST = HIGH), this pin is used to shift test dat into the device. In host interface mode, this pin is used to write address and configuration data words into the device.	E7	SDOUT_TDO		Output	COMMUNICATION SIGNAL OUTPUT
In JTAG mode (JTAG/HOST = HIGH), this pin is used to shift test results from the device. In host interface mode, this pin is used to read status and configuration data from the device. Note: GSPI is slightly different than the SPI. For more details on GSF please refer to 4.19 GSPI - HOST Interface. E8 SDIN_TDI Input COMMUNICATION SIGNAL INPUT Please refer to the Input Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. GSPI serial data in/test data in. In JTAG mode (JTAG/HOST = HIGH), this pin is used to shift test dat into the device. In host interface mode, this pin is used to write address and configuration data words into the device.					
results from the device. In host interface mode, this pin is used to read status and configuration data from the device. Note: GSPI is slightly different than the SPI. For more details on GSF please refer to 4.19 GSPI - HOST Interface. E8 SDIN_TDI Input COMMUNICATION SIGNAL INPUT Please refer to the Input Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. GSPI serial data in/test data in. In JTAG mode (JTAG/HOST = HIGH), this pin is used to shift test dat into the device. In host interface mode, this pin is used to write address and configuration data words into the device.					GSPI serial data output/test data out.
configuration data from the device. Note: GSPI is slightly different than the SPI. For more details on GSP please refer to 4.19 GSPI - HOST Interface. E8 SDIN_TDI Input COMMUNICATION SIGNAL INPUT Please refer to the Input Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. GSPI serial data in/test data in. In JTAG mode (JTAG/HOST = HIGH), this pin is used to shift test dat into the device. In host interface mode, this pin is used to write address and configuration data words into the device.					
please refer to 4.19 GSPI - HOST Interface. E8 SDIN_TDI Input COMMUNICATION SIGNAL INPUT Please refer to the Input Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. GSPI serial data in/test data in. In JTAG mode (JTAG/HOST = HIGH), this pin is used to shift test dat into the device. In host interface mode, this pin is used to write address and configuration data words into the device.					
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Characteristics table for logic level threshold and compatibility. GSPI serial data in/test data in. In JTAG mode (JTAG/HOST = HIGH), this pin is used to shift test dat into the device. In host interface mode, this pin is used to write address and configuration data words into the device.	E8	SDIN_TDI		Input	COMMUNICATION SIGNAL INPUT
In JTAG mode (JTAG/ HOST = HIGH), this pin is used to shift test dat into the device. In host interface mode, this pin is used to write address and configuration data words into the device.					
into the device. In host interface mode, this pin is used to write address and configuration data words into the device.					
configuration data words into the device.					In JTAG mode (JTAG/ $\overline{\text{HOST}}$ = HIGH), this pin is used to shift test data into the device.
F1 TERM Analog Input Decoupling for internal SDI termination resistors.					
	F1	TERM		Analog Input	Decoupling for internal SDI termination resistors.



Table 1-1: Pin Descriptions (Continued)

Pin Number	Name	Timing	Туре	Description
F7	CS_TMS		Input	COMMUNICATION SIGNAL INPUT
				Please refer to the Input Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility.
				Chip select / test mode start.
				In JTAG mode (JTAG/ $\overline{\text{HOST}}$ = HIGH), this pin is Test Mode Start, used to control the operation of the JTAG test.
				In host interface mode (JTAG/HOST = LOW), this pin operates as the host interface chip select and is active LOW.
F8	SCLK_TCK		Input	COMMUNICATION SIGNAL INPUT
				Please refer to the Input Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility. Serial data clock signal. In JTAG mode (JTAG/HOST = HIGH), this pin is the JTAG clock.
				In host interface mode (JTAG/HOST = LOW), this pin is the host interface serial bit clock.
			All JTAG/host interface addresses and data are shifted into/out of the device synchronously with this clock.	
F9, F10, H9,	DOUT8, 9, 6, 7, 1,		Output	PARALLEL DATA BUS
H10, J8, J9, J10, K8, K9, K10	4, 5, 0, 2, 3	Tiease refer to	Please refer to the Output Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility.	
Kio				20-bit mode 20-bit mode SMPTE mode (SMPTE_BYPASS = HIGH and DVB_ASI = LOW): Chroma data output for SD and HD data rates.
				DVB-ASI mode (SMPTE_BYPASS = LOW and DVB_ASI = HIGH): Not defined
				Data-Through mode (SMPTE_BYPASS = LOW and DVB_ASI = LOW): Data output
				10-bit mode Forced LOW 20bit/10bit = LOW
G3	RC_BYP		Input	CONTROL SIGNAL INPUT
				Please refer to the Input Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility.
				When this pin is LOW, the serial digital output is the buffered version of the input serial data. When this pin is HIGH, the serial digital output is the reclocked version of the input serial data.



Table 1-1: Pin Descriptions (Continued)

Pin Number	Name	Timing	Туре	Description
G 7	SMPTE_BYPASS		Input/Output	CONTROL SIGNAL INPUT/OUTPUT
				Please refer to the Input/Output Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility.
				Indicates the presence of valid SMPTE data.
				When the AUTO/MAN bit in the host interface register is HIGH (Default), this pin is an OUTPUT. SMPTE_BYPASS is HIGH when the device locks to a SMPTE compliant input. SMPTE_BYPASS is LOW under all other conditions.
				When the AUTO/MAN bit in the host interface register is LOW, th pin is an INPUT:
				No SMPTE scrambling takes place, and none of the I/O processing features of the device are available when SMPTE_BYPASS is set LOW.
				When SMPTE_BYPASS is set HIGH, the device carries out SMPTE scrambling and I/O processing.
				When SMPTE_BYPASS and DVB_ASI are both set LOW, the device operates in Data-Through mode.
G8	DVB_ASI		Input/Output	CONTROL SIGNAL INPUT
				Please refer to the Input/Output Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility.
				Used to enable/disable DVB-ASI data extraction in manual mode.
				When the AUTO/MAN bit in the host interface is LOW, this pin is input and when the DVB_ASI pin is set HIGH the device will carry of DVB_ASI data extraction and processing. The SMPTE_BYPASS pin must be set LOW. When SMPTE_BYPASS and DVB_ASI are both set LOW, the device operates in Data-Through mode.
				When the AUTO/MAN bit in the host interface is HIGH (default), DVB-ASI is configured as a status output (set LOW), and DVB-ASI input streams are not supported or recognized.
H1	BUFF_VDD		Input Power	POWER pin for the serial digital output 50Ω buffer. Connect to 3. DC analog.
H2	BUFF_GND		Input Power	GND pin for the cable driver buffer. Connect to analog GND.
НЗ	AUDIO_EN/DIS		Input	CONTROL SIGNAL INPUT
				Please refer to the Input Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility.
				Enables or disables audio extraction.
H4	WCLK		Output	48kHz word clock for Audio.
				Please refer to the Output Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility.
H5	TIM_861		Input	CONTROL SIGNAL INPUT
				Please refer to the Input Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility.
				Used to select CEA-861 timing mode.
				When TIM_861 is HIGH, the device outputs CEA 861 timing signal (HSYNC/VSYNC/DE) instead of H:V:F digital timing signals.
Н6	XTAL_OUT		Digital Output	Buffered 27MHz crystal output. Can be used to cascade the crysta signal.



Table 1-1: Pin Descriptions (Continued)

Pin Number	Name	Timing	Туре	Description
H7	20bit/10bit		Input	CONTROL SIGNAL INPUT
				Please refer to the Input Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility.
				Used to select the output bus width. HIGH = 20-bit, LOW = 10-bit.
H8	IOPROC_EN/DIS		Input	CONTROL SIGNAL INPUT
			·	Please refer to the Input Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility.
				Used to enable or disable audio and video processing features. When IOPROC_EN is HIGH, the audio and video processing feature of the device are enabled. When IOPROC_EN is LOW, the processin features of the device are disabled, and the device is in a low-latency operating mode.
J1, K1	SDO, SDO		Output	Serial Data Output Signal.
				50Ω CML buffer for interfacing to an external cable driver.
				Serial digital output signal operating at 1.485Gb/s, 1.485/1.001Gb/and 270Mb/s.
J2	SDO_EN/ DIS		Input	CONTROL SIGNAL INPUT
				Please refer to the Input Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility.
				Used to enable/disable the serial digital output stage.
				When SDO_EN/DIS is LOW, the serial digital output signals, SDO ar SDO, are both pulled HIGH.
				When SDO_EN/DIS is HIGH, the serial digital output signals, SDO ar SDO, are enabled.
J3	AOUT_1/2		Output	Serial Audio Output; Channels 1 and 2.
				Please refer to the Output Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility.
J4	ACLK		Output	64fs sample clock for audio.
				Please refer to the Output Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility.
J5	AOUT_5/6		Output	Serial Audio Output; Channels 5 and 6.
				Please refer to the Output Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility.
J6, K6	XTAL2, XTAL1	,	Analog Input	Input connection for 27MHz crystal.
K2	STANDBY		Input	CONTROL SIGNAL INPUT
				Please refer to the Input Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility.
				When this pin is set HIGH, the device is placed in a power-saving mode. No data processing occurs, and the digital I/Os are powered down.
				In this mode, the serial digital output signals, SDO and $\overline{\text{SDO}}$, are both pulled HIGH.
K3	AOUT_3/4		Output	Serial Audio Output; Channels 3 and 4.
				Please refer to the Output Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility.



Table 1-1: Pin Descriptions (Continued)

Pin Number	Name	Timing	Туре	Description
K4	AMCLK		Output	Oversampled master clock for audio (128fs, 256fs, 512fs selectable). Please refer to the Output Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility.
K5	AOUT_7/8		Output	Serial Audio Output; Channels 7 and 8. Please refer to the Output Logic parameters in the DC Electrical Characteristics table for logic level threshold and compatibility.



2. Electrical Characteristics

2.1 Absolute Maximum Ratings

Table 2-1: Absolute Maximum Ratings

Parameter	Value/Units
Supply Voltage, Digital Core (CORE_VDD)	-0.3V to +1.5V
Supply Voltage, Digital I/O (IO_VDD)	-0.3V to +4.0V
Supply Voltage, Analog 1.2V (PD_VDD, VCO_VDD)	-0.3V to +1.5V
Supply Voltage, Analog 3.3V (SDI_VDD, BUFF_VDD, A_VDD)	-0.3V to +4.0V
Input Voltage Range (digital inputs)	-2.0V to +5.25V
Operating Temperature Range	-20°C to +85°C
Functional Temperature Range	-40°C to +85°C
Storage Temperature Range	-50°C to +125°C
Peak Reflow Temperature (JEDEC J-STD-020C)	260°C
ESD Sensitivity, HBM (JESD22-A114)	2kV

NOTES:

Absolute Maximum Ratings are those values beyond which damage may occur. Functional operation under these conditions or at any other condition beyond those indicated in the AC/DC Electrical Characteristics sections is not implied.

2.2 Recommended Operating Conditions

Table 2-2: Recommended Operating Conditions

 $T_A = -20$ °C to + 85°C, unless otherwise shown.

Parameter	Symbol	Conditions	Min	Тур	Max	Units	Notes
Supply Voltage, Digital Core	CORE_VDD	_	1.14	1.2	1.26	V	_
Comple Valence Binital VO	IO VDD	1.8V mode	1.71	1.8	1.89	V	_
Supply Voltage, Digital I/O	IO_VDD -	3.3V mode	3.13	3.3	3.47	V	_
Supply Voltage, PLL	PLL_VDD	_	1.14	1.2	1.26	V	_
Supply Voltage, Analog	A_VDD	_	3.13	3.3	3.47	V	1
Supply Voltage, Serial Digital Input	SDI_VDD	_	3.13	3.3	3.47	V	1
Supply Voltage, CD Buffer	BUFF_VDD	_	3.13	3.3	3.47	V	1

NOTES:

1. The 3.3V supplies must track the 3.3V supply of an external EQ and external CD.



2.3 DC Electrical Characteristics

Table 2-3: DC Electrical Characteristics

Parameter	Symbol	Conditions	Min	Тур	Max	Units	Notes
System							
+1.2V Supply Current	I _{1V2}	10/20bit HD	_	175	215	mA	_
		10/20bit SD	-	145	180	mA	
		DVB_ASI	_	135	165	mA	-
+1.8V Supply Current	I _{1V8}	10/20bit HD	_	20	21	mA	
		10/20bit SD	-	6	7	mA	
		DVB_ASI	-	6	7	mA	-
+3.3V Supply Current	I _{3V3}	10/20bit HD	-	65	75	mA	
		10/20bit SD	=	35	45	mA	
		DVB_ASI	=	35	45	mA	-
Total Device Power	P _{1D8}	10/20bit HD	-	300	360	mW	
$(IO_VDD = 1.8V)$		10/20bit SD	-	235	305	mW	
		DVB_ASI	-	235	305	mW	-
		Reset	_	200	_	mW	
		Standby	_	16	44	mW	
Total Device Power P _{3D3} (IO_VDD = 3.3V)	P _{3D3}	10/20bit HD	_	430	530	mW	-
		10/20bit SD	_	290	370	mW	
		DVB_ASI	_	290	370	mW	
		Reset	_	220	_	mW	-
		Standby	_	16	44	mW	
Digital I/O							
Input Logic LOW	V _{IL}	3.3V or 1.8V operation	IO_VSS -0.3	-	0.3 x IO_VDD	V	-
Input Logic HIGH	V _{IH}	3.3V or 1.8V operation	0.7 x IO_VDD	-	IO_VDD +0.3	V	_
Output Logic LOW	V _{OL}	IOL = 5mA, 1.8V operation	_	_	0.2	V	_
Output Logic LOW	VOL	IOL = 8mA, 3.3V operation	-	-	0.4	V	_
Output Logic HIGH	V _{OH}	IOH = 5mA, 1.8V operation	1.4	_	_	V	-
Output Logic High	VOH	IOH = 8mA, 3.3V operation	2.4	-	-	V	_
Serial Input							
Serial Input Common Mode Voltage	=	50 Ω load	2.5	SDI_VDD -(0.75/2)	SDI_VDD -(0.55/2)	V	-
Serial Output							
Serial Output Common Mode Voltage	-	50Ω load	BUFF_VDD -(0.6/2)	BUFF_VDD -(0.45/2)	BUFF_VDD -(0.35/2)	V	-



Table 2-3: DC Electrical Characteristics (Continued)

Guaranteed over recommended operating conditions unless otherwise noted.

Parameter Symbol Conditions Wiln Typ Max Units Not	Parameter	Symbol	Conditions	Min	Тур	Max	Units	Notes
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Notes:

The output drive strength of the digital outputs can be programmed through the host interface. please see Table 4-28: Video Core Configuration and Status Registers, register 06Dh for details.



2.4 AC Electrical Characteristics

Table 2-4: AC Electrical Characteristics

Parameter	Symbol	Conditi	ions	Min	Тур	Max	Units	Notes
System								
Device Latency:		HD		79	_	83	PCLK	_
AUDIO_EN = 1,	_	SD		50	-	59	PCLK	_
SMPTE mode, IOPROC_EN = 1								
Device Latency:		HD		44	_	48	PCLK	_
AUDIO_EN = 0,	_	SD		44	_	48	PCLK	_
SMPTE mode, IOPROC_EN = 1								
Device Latency:		HD		33	_	36	PCLK	-
AUDIO_EN = 0, SMPTE mode, IOPROC_EN = 0	-	SD		32	-	35	PCLK	-
Device Latency:		HD		6	-	9	PCLK	-
AUDIO_EN = 0, SMPTE bypass, IOPROC_EN = 0	-	SD		5	-	9	PCLK	-
Device Latency: DVB-ASI	_	SD		12	-	16	PCLK	-
Reset Pulse Width	t _{reset}	_		1	-	-	ms	-
Parallel Output								
Parallel Clock Frequency	f _{PCLK}	_		13.5	-	148.5	MHz	-
Parallel Clock Duty Cycle	DC _{PCLK}	_		40	-	60	%	-
Output Data Hold Time (1.8V)	t _{oh}	HD 10-bit	DBUS	1.0	-	-	ns	1
		6pF Cload	STAT	1.0	-	-	ns	1
		HD 20-bit	DBUS	1.0	-	-	ns	1
		6pF Cload	STAT	1.0	-	-	ns	1
		SD 10-bit	DBUS	19.4	-	-	ns	1
		6pF Cload	STAT	19.4	-	-	ns	1
		SD 20-bit	DBUS	38.0	-	-	ns	1
		6pF Cload	STAT	38.0	-	_	ns	1



Table 2-4: AC Electrical Characteristics (Continued)

Parameter	Symbol	Condit	ions	Min	Тур	Max	Units	Notes
Output Data Hold Time (3.3V)	t _{oh}	HD 10-bit	DBUS	1.0	_	_	ns	2
		6pF Cload	STAT	1.0	-	-	ns	2
		HD 20-bit	DBUS	1.0	-	-	ns	2
		6pF Cload	STAT	1.0	-	-	ns	2
		SD 10-bit	DBUS	19.4	-	-	ns	2
		6pF Cload	STAT	19.4	-	=	ns	2
		SD 20-bit	DBUS	38.0	-	=	ns	2
		6pF Cload	STAT	38.0	-	-	ns	2
Output Data Delay Time (1.8V)	t _{od}	HD 10-bit	DBUS	-	-	3.7	ns	3
		15pF Cload	STAT	-	-	4.4	ns	3
		HD 20-bit	DBUS	_	-	3.7	ns	3
		15pF Cload	STAT	-	-	4.4	ns	3
		SD 10-bit	DBUS	-	-	22.2	ns	3
		15pF Cload	STAT	-	-	22.2	ns	3
		SD 20-bit	DBUS	-	-	41.0	ns	3
		15pF Cload	STAT	-	-	41.0	ns	3
Output Data Delay Time (3.3V)	t _{od}	HD 10-bit	DBUS	-	-	3.7	ns	4
		15pF Cload	STAT	-	-	4.1	ns	4
		HD 20-bit	DBUS	-	-	3.7	ns	4
		15pF Cload	STAT	_	-	4.1	ns	4
		SD 10-bit	DBUS	_	-	22.2	ns	4
		15pF Cload	STAT	-	-	22.2	ns	4
		SD 20-bit	DBUS	-	-	41.0	ns	4
		15pF Cload	STAT	_	_	41.0	ns	4

Table 2-4: AC Electrical Characteristics (Continued)

Parameter	Symbol	Condit	ions	Min	Тур	Max	Units	Notes
Output Data Rise/Fall Time (1.8V)	t _r /t _f	All modes	STAT	_	_	0.4	ns	1
		6pF Cload	DBUS	-	-	0.4	ns	1
			AUDIO	-	-	0.6	ns	1
		All modes	STAT	-	-	1.5	ns	3
		15pF Cload	DBUS	-	-	1.4	ns	3
			AUDIO	-	-	2.3	ns	3
Output Data Rise/Fall Time (3.3V)	t _r /t _f	t _r /t _f All modes 6pF Cload	STAT	-	-	0.5	ns	2
		брг Сюад	DBUS	-	-	0.4	ns	2
			AUDIO	-	-	0.6	ns	2
		All modes	STAT	-	-	1.6	ns	4
		15pF Cload -	DBUS	-	-	1.4	ns	4
				-	-	2.2	ns	4
Serial Digital Input								
Serial Input Data Rate	DR _{SDI}	-		0.27	-	1.485	Gb/s	_
Serial Input Swing	ΔV _{SDI}	Differential with 100Ω load		500	800	1100	mVp-p	-
Serial Input Jitter Tolerance	ТЦ	Nominal loop bandwidth	Square wave mod.	0.7	0.8	-	UI	-
Serial Digital Output								
Serial Output Data Rate	DR _{SDO}	_		0.27	_	1.485	Gb/s	
Serial Output Swing	$\Delta V_{ m SDO}$	Differential v		350	_	600	mVp-p	-
Serial Output Rise Time 20% ~ 80%	tr _{SDO}	-		_	_	180	ps	_
Serial Output Fall Time 20% ~ 80%	tf _{SDO}	_		_	_	180	ps	_
Serial Output Intrinsic Jitter	t _{OJ}	SMPTE color		_	_	100	ps	_
		SMPTE color		-	-	400	ps	-
Serial Output Duty Cycle	DCD _{SDD}	HD)	_	10	_	ps	_
Distortion		SD		-	20	-	ps	-
Synchronous lock time	-	-		=	-	25	μs	_



Table 2-4: AC Electrical Characteristics (Continued)

Guaranteed over recommended operating conditions unless otherwise noted.

Parameter	Symbol	Conditions	Min	Тур	Max	Units	Notes
Asynchronous lock time	-	Manual mode, noise immunity disabled	100	-	350	μs	5
		Auto mode, noise immunity disabled	100	-	600	μς	5
		Noise immunity enabled	100	-	1200	μs	5
Lock time from power-up		After 20 minutes at -20°C	-	325		ms	5
GSPI							
GSPI Input Clock Frequency	f _{SCLK}	50% levels	-	-	60	MHz	5
GSPI Input Clock Duty Cycle	DC _{SCLK}	- 3.3V or 1.8V operation	40	50	60	%	5
GSPI Input Data Setup Time	-	-	1.5	_	-	ns	5
GSPI Input Data Hold Time	-	<u>-</u>	1.5	-	-	ns	5
GSPI Output Data Hold Time	-	-	1.5	-	-	ns	5
CS low before SCLK rising edge	-	-	1.5	-	-	ns	5
Time between end of command word (or data in Auto-Increment mode) and the first SCLK of the following data word - write cycle	-	-	37.1	-	-	ns	5
Time between end of command word (or data in Auto-Increment mode) and the first SCLK of the following data word - read cycle	-	-	148.4	-	-	ns	5
CS high after SCLK falling edge	_	-	37.1	_	_	ns	5

Notes:

- 1. 1.89V and 0°C.
- 2. 3.47V and 0°C.
- 3. 1.71V and 85°C
- 4. 3.13V and 85°C
- 5. Timing parameters defined in Section 4.19.3



3. Input/Output Circuits

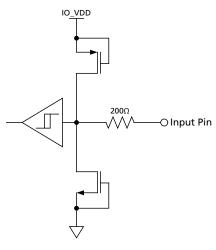


Figure 3-1: Digital Input Pin with Schmitt Trigger (20bit/10bit, AUDIO_EN/DIS, CS_TMS, SW_EN, IOPROC_EN/DIS, JTAG/HOST, RC_BYP, RESET_TRST, SCLK_TCK, SDIN_TDI, SDO_EN/DIS, STANDBY, TIM_861)

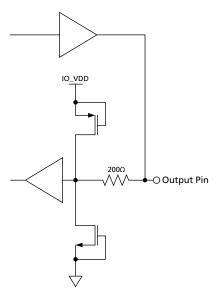


Figure 3-2: Bidirectional Digital Input/Output Pin - Configured to Output unless in Reset Mode. (ACLK, AMCLK, AOUT_1/2, AOUT_3/4, AOUT_5/6, AOUT_7/8, DVB_ASI, SMPTE_BYPASS, WCLK)

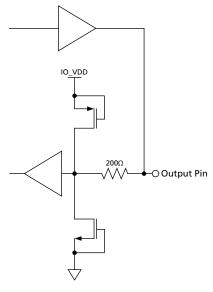


Figure 3-3: Bidirectional Digital Input/Output Pin with programmable drive strength. These pins are configured to output unless in Reset Mode; in which case they are high-impedance. The drive strength can be set by writing to address 06Dh in the host interface register. (DOUT0, DOUT1, DOUT2, DOUT3, DOUT4, DOUT5, DOUT6, DOUT7, DOUT8, DOUT9, SDOUT_TDO, STAT0, STAT1, STAT2, STAT3, STAT4, STAT5, XTAL_OUT, DOUT10, DOUT11, DOUT12, DOUT13, DOUT14, DOUT15, DOUT16, DOUT17, DOUT18, DOUT19, PCLK)

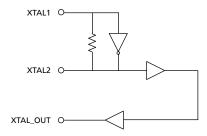


Figure 3-4: XTAL1/XTAL2/XTAL-OUT

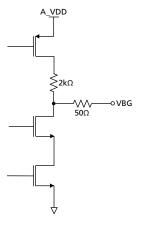


Figure 3-5: VBG

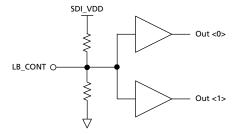


Figure 3-6: LB_CONT

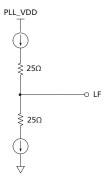


Figure 3-7: Loop Filter

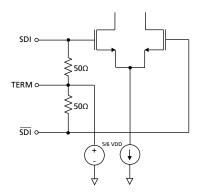


Figure 3-8: SDI/SDI and TERM

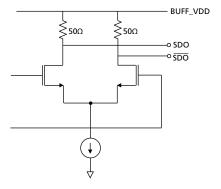


Figure 3-9: SDO/SDO

4. Detailed Description

4.1 Functional Overview

The GS1670A is a multi-rate, multi-standard receiver with integrated SMPTE video processing as well as an integrated audio de-embedder, compliant with SMPTE 292 and SMPTE 259M-C signals.

The GS1670A includes an integrated reclocker, serial data loop through output, robust serial-to-parallel conversion, integrated SMPTE video processing, and additional processing functions such as audio extraction, ancillary data extraction, EDH support, and DVB-ASI decoding.

The device supports four distinct modes of operation that can be set through external device pins or by programming internal registers through the host interface; SMPTE mode, Data-Through mode, DVB-ASI mode and Standby mode.

In SMPTE mode, all video processing features, ancillary data extraction, and audio de-embedding features are enabled by default.

In DVB-ASI mode, the GS1670A carries out 8b/10b decoding and generates 10-bit parallel DVB-ASI compliant data.

In Data-Through mode, the device operates as a simple serial to parallel converter. No additional processing features are enabled.

Standby mode is the low power consumption mode of the device. In this mode, the internal reclocker will unlock, and the internal configuration registers will not be accessible through the host interface.

The GS1670A includes a JTAG interface for boundary scan testing.

4.2 Serial Digital Input

The GS1670A can accept serial digital inputs compliant with SMPTE 292 and SMPTE 259M-C. The serial digital input buffer features 50Ω input termination and can be DC-coupled to Gennum's SD/HD-capable equalizers.

4.3 Serial Digital Loop-Through Output

The GS1670A contains a 100Ω differential serial output buffer which can be configured to output either a retimed or a buffered version of the serial digital input. The SDO and $\overline{\text{SDO}}$ outputs of this buffer can interface directly to a SD/HD-capable, SMPTE compliant Gennum cable driver. See 5.1 Typical Application Circuit on page 125.

When the $\overline{RC_BYP}$ pin is set HIGH, the serial digital output is the re-timed version of the serial input.

When the \overline{RC} _BYP pin is set LOW, the serial digital output is simply the buffered version of the serial input, bypassing the internal reclocker.



The output can be disabled by setting the SDO_EN/ $\overline{\text{DIS}}$ pin LOW. The output is also disabled when the STANDBY pin is asserted HIGH. When the output is disabled, both SDO and $\overline{\text{SDO}}$ pins are set to VDD and remain static.

The SDO output is muted when the $\overline{RC_BYP}$ pin is set HIGH and the PLL is unlocked (LOCKED pin is LOW). When muted, the output is held static at logic '0' or logic '1'.

Table 4-1: Serial Digital Output

SDO_EN/DIS	RC_BYP	SDO/ SDO
0	Х	Disabled
1	1	Re-timed
1	0	Buffered (not re-timed)

NOTE: the serial digital output is muted when the GS1670A is unlocked.

4.4 Serial Digital Reclocker

The GS1670A includes both a PLL stage and a sampling stage.

The PLL is comprised of two distinct loops:

- A coarse frequency acquisition loop sets the centre frequency of the integrated Voltage Controlled Oscillator (VCO) using an external 27MHz reference clock
- A fine frequency and phase locked loop aligns the VCO's phase and frequency to the input serial digital stream

The frequency lock loop results in a very fast lock time.

The sampling stage re-times the serial digital input with the locked VCO clock. This generates a clean serial digital stream, which may be output on the SDO/ $\overline{\text{SDO}}$ output pins and converted to parallel data for further processing. Parallel data is not affected by $\overline{\text{RC_BYP}}$. Only the SDO is affected by this pin.

4.4.1 PLL Loop Bandwidth

The fine frequency and phase lock loop in the GS1670A reclocker is non-linear. The PLL loop bandwidth scales with the jitter amplitude of the input data stream; automatically reduces bandwidth in response to higher jitter. This allows the PLL to reject more of the jitter in the input data stream and produce a very clean reclocked output.

The loop bandwidth of the GS1670A PLL is defined with 0.2UI input jitter. The bandwidth is controlled by the LB_CONT pin. Under nominal conditions, with the LB_CONT pin floating and 0.2UI input jitter applied, the loop bandwidth is set to 1/1000 of the frequency of the input data stream. Connecting the LB_CONT pin to 3.3V reduces the bandwidth to half of the nominal setting. Connecting the LB_CONT pin to GND increases the bandwidth to double the nominal setting. Table 4-2 below summarizes this information.



Table 4-2: PLL Loop Bandwidth

Input Data Rate	LB_CONT Pin Connection	Loop Bandwidth (MHz) ¹
SD	3.3V	0.135
	Floating	0.27
	0V	0.54
HD	3.3V	0.75
	Floating	1.5
	0V	3.0

¹Measured with 0.2UI input jitter applied

4.5 External Crystal/Reference Clock

The GS1670A requires an external 27MHz reference clock for correct operation. This reference clock is generated by connecting a crystal to the XTAL1 and XTAL2 pins of the device. See Application Reference Design on page 125. Table 4-3 shows XTAL characteristics.

Alternately, a 27MHz external clock source can be connected to the XTAL1 pin of the device, as shown in Figure 4-1.

The frequency variation of the crystal including aging, supply and temperature variation, should be less than +/-100ppm.

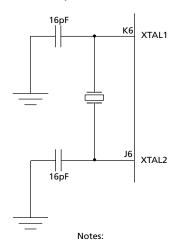
The equivalent series resistance (or motional resistance) should be a maximum of 50Ω .

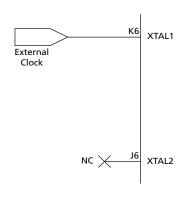
The external crystal is used in the frequency acquisition process. It has no impact on the output jitter performance of the part when the part is locked to incoming data. Because of this, the only key parameter is the frequency variation of the crystal that is stated above.



External Crystal Connection

External Clock Source Connection





1. Capacitor values listed represent the total capacitance, including discrete capacitance and parasitic board capacitance.

2.XTAL1 serves as an input, which may alternatively accept a 27MHz clock source.

Figure 4-1:27MHz Clock Sources

Table 4-3: Input Clock Requirements

Parameter	Min	Тур	Max	UOM	Notes
XTAL1 Low Level Input Voltage (V _i)	=	=	20% of VDD_IO	V	3
XTAL1 High Level Input Voltage (V _{ih})	80% of VDDIO	-	-	V	3
XTAL1 Input Slew Rate	2	-	-	V/ns	3
XTAL1 to XOUT Prop. Delay (High to Low)	1.3	1.5	2.3	ns	3
XTAL1 to XOUT Prop. Delay (Low to High)	1.3	1.6	2.3	ns	3

NOTES:

Valid when the cell is used to buffer an external clock source which is connected to the XTAL1 pin, then nothing should be connected to the XTAL2 pin.

4.6 Lock Detect

The LOCKED output signal is available by default on the STAT3 output pin, but may be programmed to be output through any one of the six programmable multi-functional pins of the device; STAT[5:0].

The LOCKED output signal is set HIGH by the Lock Detect block under the following conditions:



Table 4-4: Lock Detect Conditions

Mode of Operation	Mode Setting	Condition for Locked
Data-Through Mode	SMPTE_BYPASS = LOW DVB_ASI = LOW	Reclocker PLL is locked.
SMPTE Mode	SMPTE_BYPASS = HIGH DVB_ASI = LOW	Reclocker PLL is locked two consecutive TRS words are detected in a two-line window.
SMPTE Mode with Lock Noise-Immunity Enabled	SMPTE_BYPASS = HIGH DVB_ASI = LOW Bit 0x085[10] set to 1 AUTO/MAN = HIGH	Reclocker PLL is locked. Two consecutive TRS words are detected in a two-line window. The last two detected TRS words must have the same alignment.
		NOTE: Auto mode only. Not supported in Manual mode.
DVB_ASI Mode	SMPTE_BYPASS = LOW DVB_ASI = HIGH Bit AUTO/MAN = LOW	Reclocker PLL is locked 32 consecutive DVB_ASI words with no errors are detected within a 128-word window.

NOTE 1: The part will lock to ASI Auto mode, but could falsely unlock for s9ome ASI input patterns.

NOTE 2: In Standby mode, the reclocker PLL unlocks. However, the LOCKED signal retains whatever state it previously held. So, if before Standby assertion, the LOCKED signal is HIGH, then during standby, it remains HIGH regardless of the status of the PLL.

4.6.1 Asynchronous Lock

The lock detection algorithm is a continuous process, beginning at device power-up or after a system reset. It continues until the device is powered down or held in reset.

The device first determines if a valid serial digital input signal has been presented to the device. If no valid serial data stream has been detected, the serial data into the device is considered invalid, and the LOCKED signal is LOW.

Once a valid input signal has been detected, the asynchronous lock algorithm enters a "hunt" phase, in which the device attempts to detect the presence of either TRS words or DVB-ASI sync words.

By default, the device powers up in auto mode (the AUTO/ $\overline{\text{MAN}}$ bit in the host interface is set HIGH). In this mode, the device operating frequency toggles between HD and SD rates as it attempts to lock to the incoming data rate. The PCLK output continues to operate, and the frequency may switch between 148.5MHz, 74.25MHz, 27MHz and 13.5MHz.

When the device is operating in manual mode (AUTO/MAN bit in the host interface is LOW), the operating frequency needs to be set through the host interface using the RATE_DET bit. In this mode, the asynchronous lock algorithm does not toggle the operating rate of the device and attempts to lock within a single standard. Lock is achieved within three lines of the selected standard.



4.6.2 Signal Interruption

The device tolerates a signal interruption of up to $10\mu s$ without unlocking, as long as no TRS words are deleted by this interruption. If a signal interruption of greater than $10\mu s$ is detected, the lock detection algorithm may lose the current data rate, and LOCKED will de-assert until the data rate is re-acquired by the lock detection block.

4.7 SMPTE Functionality

4.7.1 Descrambling and Word Alignment

The GS1670A performs NRZI to NRZ decoding and data descrambling according to SMPTE 292/SMPTE 259M-C and word aligns the data to TRS sync words.

When operating in manual mode (AUTO/ \overline{MAN} = LOW), the device only carries out SMPTE decoding, descrambling and word alignment when the $\overline{SMPTE_BYPASS}$ pin is set HIGH and the DVB_ASI pin is set LOW.

When operating in Auto mode (AUTO/ \overline{MAN} = HIGH), the GS1670A carries out descrambling and word alignment to enable the detection of TRS sync words. When two consecutive valid TRS words (SAV and EAV), with the same bit alignment have been detected, the device word-aligns the data to the TRS ID words.

TRS ID word detection is a continuous process. The device remains in SMPTE mode until TRS ID words fail to be detected.

NOTE: Both 8-bit and 10-bit TRS headers are identified by the device.

4.8 Parallel Data Outputs

The parallel data outputs are aligned to the rising edge of the PCLK.

4.8.1 Parallel Data Bus Buffers

The parallel data bus, status signal outputs and control signal input pins are all connected to high-impedance buffers.

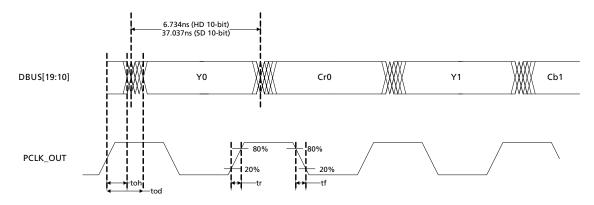
The device supports 1.8 or 3.3V (LVTTL and LVCMOS levels) supplied at the IO_VDD and IO_GND pins.

All output buffers (including the PCLK output), are set to high-impedance in Reset mode $(\overline{RESET_TRST} = LOW)$.



I/O Timing Specs:

10-bit SDR Mode:

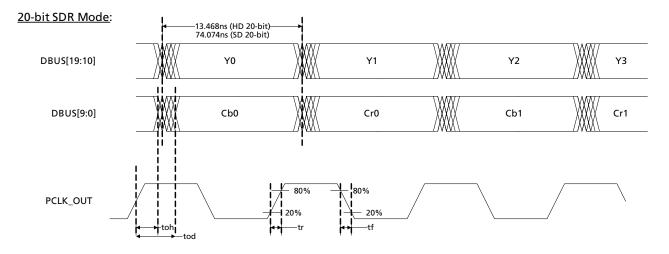


	10bHD Mode												
	3.3V							1.8V					
	toh	tr/tf (min)	Cload	tod	tr/tf (max)	Cload	toh	tr/tf (min)	Cload	tod	tr/tf (max)	Cload	
dbus	1.000ns	0.400ns		3.700ns	1.400ns	45.5	1.000ns	0.400ns	C E	3.700ns	1.400ns	15 5	
stat	1.000ns	0.500ns	6 pF	4.100ns	1.600ns	15 pF	1.000ns	0.400ns	6 pF	4.400ns	1.500ns	15 pF	

	10bSD Mode												
	3.3V							1.8V					
		toh	tr/tf (min)	Cload	tod	tr/tf (max)	Cload	toh	tr/tf (min)	Cload	tod	tr/tf (max)	Cload
d	bus	19.400ns	0.400ns	Fa 6	22.200ns	1.400ns	15 pF	19.400ns	0.400ns	fq 6	22.200ns	1.400ns	15 pF
st	tat	19.400ns	0.500ns	о рг	22.200ns	1.600ns	15 pr	19.400ns	0.400ns	о рг	22.200ns	1.500ns	тэ рг

Figure 4-2: PCLK to Data and Control Signal Output Timing - SDR Mode 1

I/O Timing Specs:



	20bHD Mode											
	3.3V							1.8V				
	toh	tr/tf (min)	Cload	tod	tr/tf (max)	Cload	toh	tr/tf (min)	Cload	tod	tr/tf (max)	Cload
dbus	1.000ns	0.400ns	C E	3.700ns	1.400ns	15 pF	1.000ns	0.400ns	aF 6	3.700ns	1.400ns	15 pF
stat	1.000ns	0.500ns	6 pF	4.100ns	1.600ns	15 pr	1.000ns	0.400ns	о рг	4.400ns	1.500ns	тэ рг

	20bSD Mode											
	3.3V							1.8V				
	toh	tr/tf (min)	Cload	tod	tr/tf (max)	Cload	toh	tr/tf (min)	Cload	tod	tr/tf (max)	Cload
dbus	38.000ns	0.400ns	<i>c</i> -	41.000ns	1.400ns	155	38.000ns	0.400ns	6 5	41.000ns	1.400ns	15 55
stat	38.000ns	0.500ns	6 pF	41.000ns	1.600ns	15 pF	38.000ns	0.400ns	6 pF	41.000ns	1.500ns	15 pF

Figure 4-3: PCLK to Data and Control Signal Output Timing - SDR Mode 2

The GS1670A has a 20-bit output parallel bus, which can be configured for different output formats as shown in Table 4-5.

Table 4-5: GS1670A Output Video Data Format Selections

Output Data Format		Pin/Regist	er Bit Setting	DOUT[9:0]	DOUT[19:10]	
roilliat	20BIT /10BIT	RATE_ SEL	SMPTE_ BYPASS	DVB-ASI		
20-bit demultiplexed HD format	HIGH	LOW	HIGH	LOW	Chroma	Luma
20-bit data output HD format	HIGH	LOW	LOW	LOW	DATA	DATA
20-bit demultiplexed SD format	HIGH	HIGH	HIGH	LOW	Chroma	Luma
20-bit data output SD format	HIGH	HIGH	LOW	LOW	DATA	DATA

Table 4-5: GS1670A Output Video Data Format Selections (Continued)

Output Data Format		Pin/Regist	er Bit Setting	DOUT[9:0]	DOUT[19:10]			
Tomat	20BIT /10BIT	RATE_ SEL	SMPTE_ BYPASS	DVB-ASI				
10-bit multiplexed HD format	LOW	LOW	HIGH	LOW	Driven LOW	Luma/Chroma		
10-bit data output HD format	LOW	LOW	LOW	LOW	Driven LOW	DATA		
10-bit multiplexed SD format	LOW	HIGH	HIGH	LOW	Driven LOW	Luma/Chroma		
10-bit data output SD format	LOW	HIGH	LOW	LOW	Driven LOW	DATA		
DVB-ASI format	LOW	HIGH	-	HIGH	DOUT19 = WORD_ERR DOUT18 = SYNC_OUT DOUT17 = H_OUT DOUT16 = G_OUT DOUT15 = F_OUT DOUT14 = E_OUT DOUT13 = D_OUT DOUT12 = C_OUT DOUT11 = B_OUT DOUT10 = A_OUT			

NOTE: When in Auto Mode, swap RATE_SEL with RATE_DET.

4.8.2 Parallel Output in SMPTE Mode

When the device is operating in SMPTE mode ($\overline{SMPTE_BYPASS}$ = HIGH and DVB_ASI = LOW), data is output in either Multiplexed or Demultiplexed form depending on the setting of the 20bit/ $\overline{10bit}$ pin.

When operating in 20-bit mode ($20bit/\overline{10bit} = HIGH$), the output data is demultiplexed Luma and Chroma data for SD and HD data.

When operating in 10-bit mode $(20bit/\overline{10bit} = LOW)$, the output data is multiplexed Luma and Chroma data for SD and HD data rates. In this mode, the data is presented on the DOUT[19:10] pins, with DOUT[9:0] being forced LOW.

4.8.3 Parallel Output in DVB-ASI Mode

In DVB-ASI mode, the $20bit/\overline{10bit}$ pin must be set LOW to configure the output parallel bus for 10-bit operation.

DVB-ASI mode is enabled when the AUTO/ \overline{MAN} bit is LOW, $\overline{SMPTE_BYPASS}$ pin is LOW and the DVB_ASI pin is HIGH.

The extracted 8-bit data is presented on DOUT[17:10] such that DOUT[17:10] = HOUT \sim AOUT, where AOUT is the least significant bit of the decoded transport stream data.

In addition, the DOUT19 and DOUT18 pins are configured as DVB-ASI status signals WORDERR and SYNCOUT respectively.

SYNCOUT is HIGH whenever a K28.5 sync character is output from the device.



WORDERR is HIGH whenever the device has detected a running disparity error or illegal code word.

4.8.4 Parallel Output in Data-Through Mode

This mode is enabled when the <u>SMPTE_BYPASS</u> and DVB_ASI pins are LOW.

In this mode, data is passed to the output bus without any decoding, descrambling or word-alignment.

The output data width (10-bit or 20-bit) is controlled by the setting of the $20bit/\overline{10bit}$ pin.

4.8.5 Parallel Output Clock (PCLK)

The frequency of the PCLK output signal of the GS1670A is determined by the output data rate and the $20bit/\overline{10bit}$ pin setting. Table 4-6 lists the output signal formats according to the data format selected in Manual mode (AUTO/MAN bit in the host interface is set LOW), or detected in Auto mode (AUTO/MAN bit in the host interface is set HIGH).

Table 4-6: GS1670A PCLK Output Rates

Output Data Format		PCLK Rate			
romat -	20bit/ 10bit	RATE_DET	SMPTE_ BYPASS	DVB-ASI	_
20-bit demultiplexed HD format	HIGH	LOW	HIGH	LOW	74.25 or 74.25/1.001MHz
20-bit data output HD format	HIGH	LOW	LOW	LOW	74.25 or 74.25/1.001MHz
20-bit demultiplexed SD format	HIGH	HIGH	HIGH	LOW	13.5MHz
20-bit data output SD format	HIGH	HIGH	LOW	LOW	13.5MHz
10-bit multiplexed HD format	LOW	LOW	HIGH	LOW	148.5 or 148.5/1.001MHz
10-bit data output HD format	LOW	LOW	LOW	LOW	148.5 or 148.5/1.001MHz
10-bit multiplexed SD format	LOW	HIGH	HIGH	LOW	27MHz
10-bit data output SD format	LOW	HIGH	LOW	LOW	27MHz
10-bit ASI output SD format	LOW	HIGH	LOW	HIGH	27MHz

4.9 Timing Signal Generator

The GS1670A has an internal timing signal generator which is used to generate digital FVH timing reference signals, to detect and correct certain error conditions and automatic video standard detection.

The timing signal generator is only operational in SMPTE mode $(\overline{SMPTE}_BYPASS = HIGH)$.

The timing signal generator consists of a number of counters and comparators operating at video pixel and video line rates. These counters maintain information about the total line length, active line length, total number of lines per field/frame and total active lines per field/frame for the received video standard.

It takes one video frame to obtain full synchronization to the received video standard.

NOTE: Both 8-bit and 10-bit TRS words are identified by the device. Once synchronization has been achieved, the timing signal generator continues to monitor the received TRS timing information to maintain synchronization.

The timing signal generator re-synchronizes all pixel and line based counters on every received TRS ID. Note that for correct operation of the timing signal generator, the SW_EN input pin must be set LOW, unless manual synchronous switching is enabled (Section 4.9.1).

4.9.1 Manual Switch Line Lock Handling

The principle of switch line lock handling is that the switching of synchronous video sources will only disturb the horizontal timing and alignment, whereas the vertical timing remains in synchronization - i.e. switching between video sources of the same format.

To account for the horizontal disturbance caused by a synchronous switch, the word alignment block and timing signal generator automatically re-synchronizes to the new timing immediately if the synchronous switch happens during the designated switch line, as defined in SMPTE recommended practice RP168-2002.

The device samples the SW_EN pin on every PCLK cycle. When a Logic LOW to HIGH transition on this pin is detected anywhere within the active line, the word alignment block and timing signal generator re-synchronize immediately to the next TRS word.

This allows the system to force immediate lock on any line, if the switch point is non-standard.

To ensure proper switch line lock handling, the SW_EN signal should be asserted HIGH anywhere within the active portion of the line on which the switch has taken place, and should be held HIGH for approximately one video line. After this time period, SW_EN should be de-asserted. SW_EN should be held LOW during normal device operation.

NOTE: It is the rising edge of the SW_EN signal, which generates the switch line lock re-synchronization. This edge must be in the active portion of the line containing the video switch point.



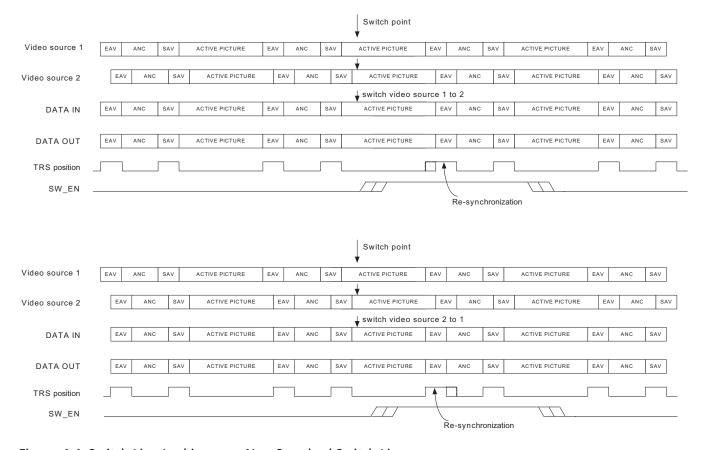


Figure 4-4: Switch Line Locking on a Non-Standard Switch Line

4.9.2 Automatic Switch Line Lock Handling

The synchronous switch point is defined for all major video standards in SMPTE RP168-2002. The device automatically re-synchronizes the word alignment block and timing signal generator at the switch point, based on the detected video standard.

The device, as described in Section 4.9.1 and Figure 4-4 above, implements the re-synchronization process automatically, every field/frame. The switch line is defined as follows:

- For 525 line interlaced systems: resynchronization takes place at then end of lines 10 & 273
- For 525 line progressive systems: resynchronization takes place at then end of line 10
- For 625 line interlaced systems: resynchronization takes place at then end of lines 6 & 319
- For 625 line progressive systems: resynchronization takes place at then end of line 6
- For 750 line progressive systems: resynchronization takes place at then end of line 7
- \bullet For 1125 line interlaced systems: resynchronization takes place at then end of lines 7 & 568
- For 1125 line progressive systems: resynchronization takes place at then end of line 7

NOTE: Unless indicated by SMPTE 352M payload identifier packets, the GS1670A does not distinguish between 1125-line progressive segmented-frame (PsF) video and 1125-line interlaced video operating at 25 or 30fps. However. PsF video operating at 24fps is detected by the device.



A full list of all major video standards and switching lines is shown in Table 4-7.

Table 4-7: Switch Line Position for Digital Systems

System	Frame Rate & Structure	Pixel Structure		Signal Standard	Parallel Interface	Serial Interface	Line No.
1125	60/I	1920x1080	4:2:2	274M	274M + RP211		7/569
	50/I			274M	+ RP211		
	30/P			274M	+ RP211		7
	25/P			274M	+ RP211		
	24/P			274M	+ RP211		
	30/PsF			274M	+ RP211		
	25/PsF			274M	+ RP211		
	24/PsF			274M	+ RP211		
750	60/P	1280x720	4:2:2	29	96M	292	7
	50/P			29	96M		
	30/P			29	96M		
	25/P			29	296M		
	24/P			296M			
625	50/P	720x576	4:2:2	BT.1358	349M	292	6
				BT.1358	347M	344M	
				BT.1358	BT.1358	BT.1362	
			4:2:0	BT.1358	349M	292	
				BT.1358	BT.1358	BT.1362	
	50/I	960x576	4:2:2	BT.601	349M	292	6/319
				BT.601	BT.656	259M	
		720x576	4:4:4:4	BT.799	349M	292	
				BT.799	347M	344M	
				BT.799	BT.799	344M	
				BT.799	BT.799	-	
			4:2:2	BT.601	349M	292	
				BT.601	125M	259M	

Table 4-7: Switch Line Position for Digital Systems (Continued)

System	Frame Rate & Structure	Pixel St	ructure	Signal Standard	Parallel Interface	Serial Interface	Line No.
525	59.94/P	720x483	4:2:2	293M	349M	292	10
				293M	347M	344M	
				293M	293M	294M	
			4:2:0	293M	349M	292	
				293M	293M	294M	
	59.94/I	960x483	4:2:2	267M	349M	292	10/273
				267M	267M	259M	
		720x483	4:4:4	267M	349M	292	
				267M	347M	344M	
				267M	RP174	344M	
				267M	RP175	RP175	
			4:2:2	125M	349M	292	
				125M	125M	259M	
HD-SDTI	P or PsF structure	1920x1080	4:2:2	274M	274M + 348M	292	7
	I structure			274M	-		7/569
	P structure	1280x720		296M	296M + 348M		7
SDTI	50/I	720x576	4:2:2	BT.656	BT.656 + 305M	259M	6/319
	59.94/I	720x483		125M	125M + 305M		10/273

4.10 Programmable Multi-function Outputs

The GS1670A has six multi-function output pins, STAT [5:0], which are programmable via the host interface to output one of the following signals:

Table 4-8: Output Signals Available on Programmable Multi-Function Pins

Status Signal	Selection Code	Default Output Pin
H/HSYNC (according to TIM_861 Pin) Section 4.11	0000	STAT 0
V/VSYNC (according to TIM_861 Pin) Section 4.11	0001	STAT 1
F/DE (according to TIM_861 Pin) Section 4.11	0010	STAT 2
LOCKED Section 4.6	0011	STAT 3
Y/1ANC Section 4.16	0100	STAT 4
C/2ANC Section 4.16	0101	-
DATA ERROR Section 4.15	0110	STAT 5
VIDEO ERROR	0111	=
AUDIO ERROR	1000	=
EDH DETECTED	1001	_
CARRIER DETECT	1010	_
RATE_DET	1011	_
NOTE:		

Each of the STAT[5:0] pins are configurable individually using the register bits in the host interface; STAT[5:0]_CONFIG (008h/009h).

4.11 H:V:F Timing Signal Generation

The GS1670A extracts critical timing parameters from the received TRS words.

Horizontal blanking (H), Vertical blanking (V), and Field odd/even (F) timing are output on the STAT[2:0] pins by default.

Using the H_CONFIG bit in the host interface, the H signal timing can be selected as one of the following:

- 1. Active line blanking (H_CONFIG = LOW) the H output is HIGH for the horizontal blanking period, including the EAV TRS words.
- 2. TRS based blanking (H_CONFIG = HIGH) the H output is set HIGH for the entire horizontal blanking period as indicated by the H bit in the received TRS signals.

The timing of these signals is shown in the figures below.

NOTE: Both 8-bit and 10-bit TRS words are identified by the device.





Figure 4-5: H:V:F Output Timing - HDTV 20-bit Mode

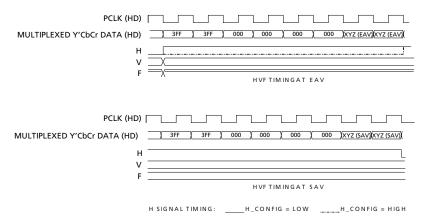


Figure 4-6: H:V:F Output Timing - HDTV 10-bit Mode

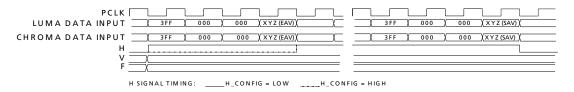


Figure 4-7: H:V:F Output Timing - HD 20-bit Output Mode

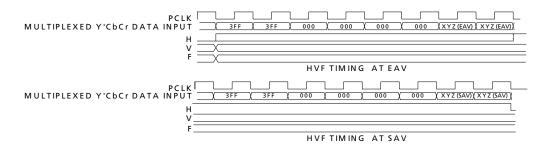


Figure 4-8: H:V:F Output Timing - HD 10-bit Output Mode

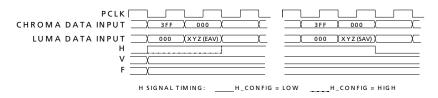


Figure 4-9: H:V:F Output Timing - SD 20-bit Output Mode

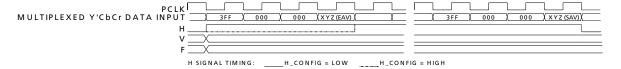


Figure 4-10: H:V:F Output Timing - SD 10-bit Output Mode

4.11.1 CEA-861 Timing Generation

The GS1670A is capable of generating CEA 861 timing instead of SMPTE HVF timing for all of the supported video formats.

This mode is selected when the TIM_861 pin is HIGH.

Horizontal sync (HSYNC), Vertical sync (VSYNC), and Data Enable (DE) timing are output on the STAT[2:0] pins by default.

Table 4-9 shows the CEA-861 formats supported by the GS1670A:

Table 4-9: Supported CEA-861 Formats

Format	CEA-861 Format	VD_STD[5:0]
720(1440) x 480i @ 59.94/60Hz	6 & 7	16h, 17h, 19h, 1Bh
720(1440) x 576i @ 50Hz	21 & 22	18h, 1Ah
1280 x 720p @ 59.94/60Hz	4	20h, 00h
1280 x 720p @ 50Hz	19	24h, 04h
1920 x 1080i @ 59.94/60Hz	5	2Ah, 0Ah
1920 x 1080i @ 50Hz	20	2Ch, 0Ch
1920 x 1080p @ 29.97/30Hz	34 ¹	2Bh, 0Bh
1920 x 1080p @ 25Hz	33 ²	2Dh, 0Dh
1920 x 1080p @ 23.98/24Hz	32	30h, 10h
NOTES:		

1,2: Timing is identical for the corresponding formats.

4.11.1.1 Vertical Timing

When CEA861 timing is selected, the device outputs standards compliant CEA861 timing signals as shown in the figures below; for example 240 active lines per field for SMPTE 125M.

The register bit TRS_861 is used to select DFP timing generator mode which follows the vertical blanking timing as defined by the embedded TRS code words.

The timing of the CEA 861 timing reference signals can be found in the CEA 861 specifications. For information, they are included in the following diagrams. These diagrams may not be comprehensive.



Table 4-10: CEA861 Timing Formats

Format	Parameters
4	H:V:DE Input Timing 1280 x 720p @ 59.94/60Hz
5	H:V:DE Input Timing 1920 x 1080i @ 59.94/60Hz
6&7	H:V:DE Input Timing 720 (1440) x 480i @ 59.94/60Hz
19	H:V:DE Input Timing 1280 x 720p @ 50Hz
20	H:V:DE Input Timing 1920 x 1080i @ 50Hz
21&22	H:V:DE Input Timing 720 (1440) x 576 @ 50Hz
32	H:V:DE Input Timing 1920 x 1080p @ 23.94/24Hz
33	H:V:DE Input Timing 1920 x 1080p @ 25Hz
34	H:V:DE Input Timing 1920 x 1080p @ 29.97/30Hz

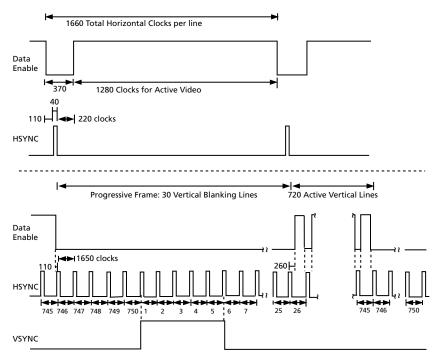


Figure 4-11: H:V:DE Output Timing 1280 x 720p @ 59.94/60 (Format 4)

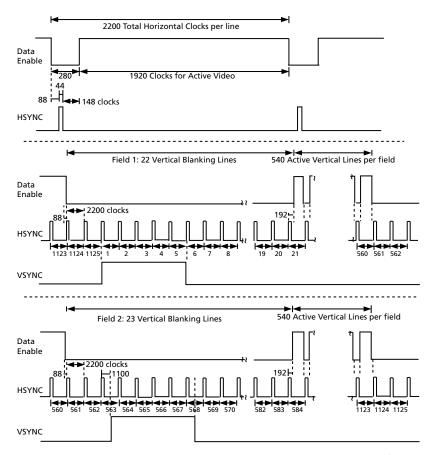


Figure 4-12: H:V:DE Output Timing 1920 x 1080i @ 59.94/60 (Format 5)

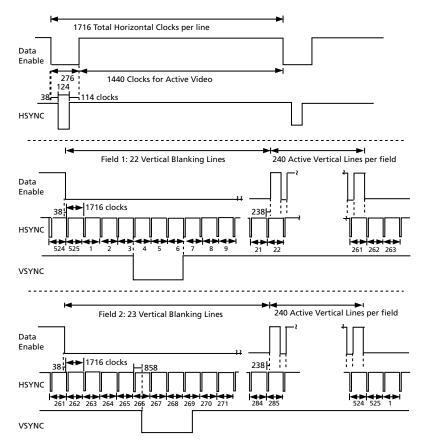


Figure 4-13: H:V:DE Output Timing 720 (1440) x 480i @ 59.94/60 (Format 6&7)

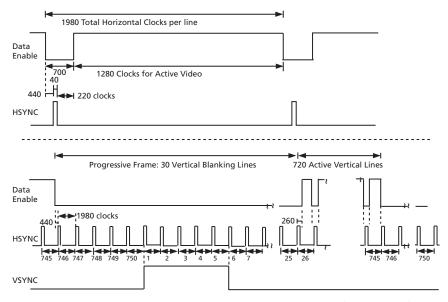


Figure 4-14: H:V:DE Output Timing 1280 x 720p @ 50 (Format 19)

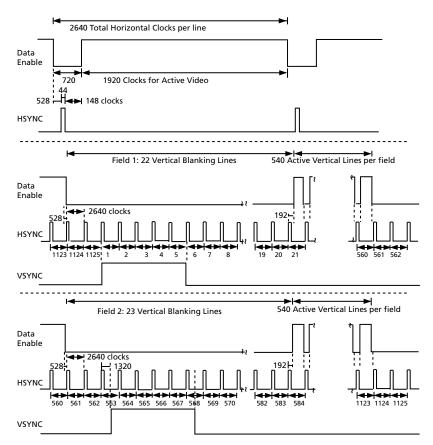


Figure 4-15: H:V:DE Output Timing 1920 x 1080i @ 50 (Format 20)

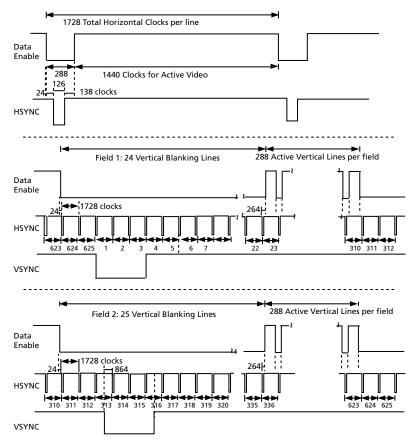


Figure 4-16: H:V:DE Output Timing 720 (1440) x 576 @ 50 (Format 21 & 22)

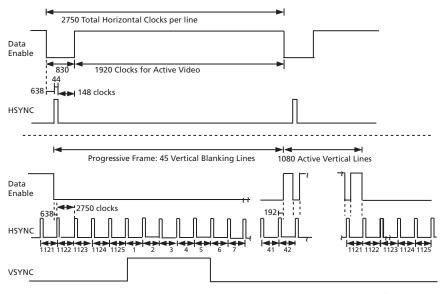


Figure 4-17: H:V:DE Output Timing 1920 x 1080p @ 23.94/24 (Format 32)

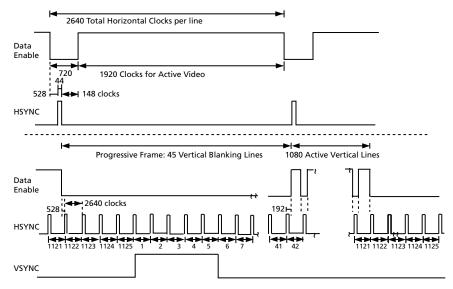


Figure 4-18: H:V:DE Output Timing 1920 x 1080p @ 25 (Format 33)

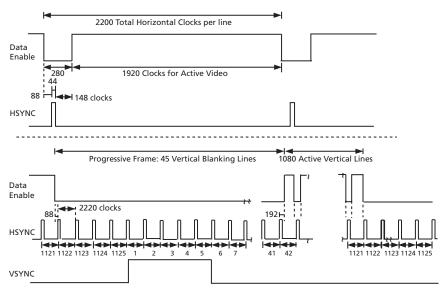


Figure 4-19: H:V:DE Output Timing 1920 x 1080p @ 29.97/30 (Format 34)

4.12 Automatic Video Standards Detection

Using the timing extracted from the received TRS signals, the GS1670A is able to identify the received video standard.

The total samples per line, active samples per line, total lines per field/frame and active lines per field/frame are all measured.

Four registers are provided to allow the system to read the video standard information from the device. These raster structure registers are provided in addition to the VIDEO_FORMAT_352_A_X and VIDEO_FORMAT_352_B_X registers, and are updated once per frame at the end of line 12.



The raster structure registers also contain three status bits: STD_LOCK, INT/PROG and M. The STD_LOCK bit is set HIGH whenever the timing signal generator is fully synchronized to the incoming standard, and detects it as one of the supported formats. The INT/PROG bit is set HIGH if the detected video standard is interlaced and LOW if the detected video standard is progressive. M is set HIGH if the clock frequency includes the "1000/1001" factor denoting a 23.98, 29.97 or 59.94Hz frame rate.

NOTE: In certain systems, due to greater ppm offsets in the crystal, the 'M' bit may not assert properly. In such cases, bits 3:0 in Register 06Fh can be increased to a maximum value of 4.

The video standard code is reported in the VD_STD bits of the host interface register. Table 4-11 describes the 5-bit codes for the recognized video standards.

Table 4-11: Supported Video Standard Codes

SMPTE Standard	Active Video Area	RATE_DET SD/HD	Lines per Frame	Active Lines per Frame	Words per Active Line	Words per Line	VD_STD [5:0]
260M (HD)	1920x1035/60 (2:1)	0	1125	1035	1920	2200	15h
259M (HD)	1920x1080/50 (2:1)	0	1250	1080	1920	2376	14h
274M (HD)	1920x1080/60 (2:1) or 1920x1080/30 (PsF)	0	1125	1080	1920	2200	0Ah
	1920x1080/50 (2:1) or 1920x1080/25 (PsF)	0	1125	1080	1920	2640	0Ch
	1920x1080/30 (1:1)	0	1125	1080	1920	2200	0Bh
	1920x1080/25 (1:1)	0	1125	1080	1920	2640	0Dh
	1920x1080/24 (1:1)	0	1125	1080	1920	2750	10h
	1920x1080/24 (PsF)	0	1125	1080	1920	2750	11h
	1920x1080/25 (1:1) –	0	1125	1080	2304	2640	0Eh
	1920x1080/25 (PsF) – EM	0	1125	1080	2304	2640	0Fh
	1920x1080/24 (1:1) –	0	1125	1080	2400	2750	12h
	1920x1080/24 (PsF) – EM	0	1125	1080	2400	2750	13h
296M (HD)	1280x720/30 (1:1)	0	750	720	1280	3300	02h
	1280x720/30 (1:1) – EM	0	750	720	2880	3300	03h
	1280x720/50 (1:1)	0	750	720	1280	1980	04h
296M (HD)	1280x720/50 (1:1) – EM	0	750	720	1728	1980	05h
	1280x720/25 (1:1)	0	750	720	1280	3960	06h
	1280x720/25 (1:1) – EM	0	750	720	3456	3960	07h
	1280x720/24 (1:1)	0	750	720	1280	4125	08h
	1280x720/24 (1:1) – EM	0	750	720	3600	4125	09h
	1280x720/60 (1:1)	0	750	720	1280	1650	00h
	1280x720/60 (1:1) – EM	0	750	720	1440	1650	01h

Table 4-11: Supported Video Standard Codes (Continued)

SMPTE Standard	Active Video Area	RATE_DET SD/HD	Lines per Frame	Active Lines per Frame	Words per Active Line	Words per Line	VD_STD [5:0]
125M (SD)	1440x487/60 (2:1)	1	525	244 or 243	1440	1716	16h
·	1440x507/60	1	525	254 or 253	1440	1716	17h
·	525-line 487 generic	1	525	=	=	1716	19h
·	525-line 507 generic	1	525	=	=	1716	1Bh
ITU-R BT.656 (SD)	1440x576/50 (2:1) Or dual link progressive)	1	625	-	1440	1728	18h
•	625-line generic	1	625	-	-	1728	1Ah
Unknown HD	SD/HD = 0	0	-	-	-	=	1Dh
Unknown SD	SD/ HD = 1	1	=	-	-	=	1Eh
2K Standards	s (see 4.12.1 2K Support	:)					
SMPTE	2048x1080/30 (1:1)	0	1125	1080	2048	2200	31h
2048-2- 200x	2048x1080/25 (1:1)	0	1125	1080	2048	2640	32h
(4:2:2)	2048x1080/24 (1:1)	0	1125	1080	2048	2750	33h
Non	2048x1080/60 (2:1)	0	1125	540	2048	2200	3Dh
SMPTE - 2048-2- 200x (4:2:2)	2048x1080/60 (2:1)	0	1125	540	2048	2640	3Eh
	2048x1080/48 (2:1)	0	1125	540	2048	2750	3Fh
Non-SMPTE	Unknown 2K	0	-	-	2048	_	3Ah

NOTES:

- 1. The Line Numbers in brackets refer to version zero SMPTE 352M packet locations, if they are different from version 1.
- 2. The part may provide full or limited functionality with standards that are not included in this table. Please consult a Semtech technical representative.
- 3. For SD-SDI streams, the device can report an incorrect M value when SMPTE-352M packets are present.9

NOTE: In certain systems, due to greater ppm offsets in the crystal, the 'M' bit may not assert properly. In such cases, bits 3:0 in Register 06Fh can be increased to a maximum value of 4.

By default (after power up or after systems reset), the four RASTER_STRUCTURE, VD_STD, STD_LOCK and INT/ \overline{PROG} fields are set to zero. These fields are also cleared when the \overline{SMPTE} _BYPASS pin is LOW.

4.12.1 2K Support

In order to fully support 2K standards without customer intervention, Semtech provides FPGA code for enhancing the GS1670A's 2K capability.

The features of the 2K FPGA enhancement are:

• Automatic video standard detection for 2K standards



- 1/1.001 rate detection for 2K standards
- CEA-861 timing generation for 2K standards
- · Automatic enabling of audio extraction

This enhancement is an interface between the GS1670A and the customer system. The behaviour of the GS1670A with or without the additional 2K enhancement FPGA code is identical from a user-perspective.

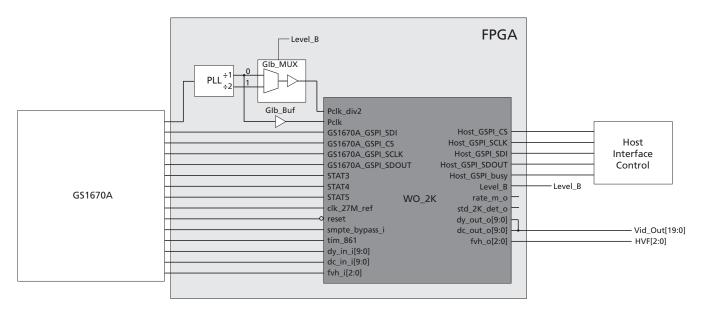


Figure 4-20: 2K Feature Enhancement

4.13 Data Format Detection & Indication

In addition to detecting the video standard, the GS1670A detects the data format, i.e. SDTI, SDI, TDM data (SMPTE 346M), etc.

This information is represented by bits in the DATA_FORMAT_DSX register accessible through the host interface.

Data format detection is only carried out when the LOCKED signal is HIGH.

By default (at power up or after system reset), the DATA_FORMAT_DSX register is set to Fh (undefined). This register is also set as undefined when the LOCKED signal is LOW and/or the SMPTE_BYPASS pin is LOW.

Table 4-12: Data Format Register Codes

YDATA_FORMAT[3:0] or CDATA_FORMAT[3:0]	Data Format	Remarks
0h ~ 05h	SDTI	SMPTE 321M, SMPTE 322M, SMPTE 326M
6h	SDI	-
7h	Reserved	-



Table 4-12: Data Format Register Codes

YDATA_FORMAT[3:0] or CDATA_FORMAT[3:0]	Data Format	Remarks
8h	TDM	SMPTE 346M
9h	HD-SDTI	÷
Ah ~ Eh	Reserved	-
Fh	Non-SMPTE data format	Detected data format is not SMPTE. LOCKED = LOW.
		NOTE: This Data Format register is invalid in SMPTE_BYPASS mode.

The data format is determined using the following criteria:

- If TRS ID words are detected but no SDTI header or TDM header is detected, then the data format is SDI
- If TRS ID words are detected and the SDTI header is available then the format is SDTI
- If TRS ID words are detected and the TDM data header is detected then the format is TDM video
- No TRS words are detected, but the PLL is locked, then the data format is unknown

NOTE: Two data format sets are provided for HD video rates. This is because the Y and Cr/Cb channels can be used separately to carry SDTI data streams of different data formats. In SD video mode only the Y data format register contains the data, and the C register is set to Fh (undefined format).

4.14 EDH Detection

4.14.1 EDH Packet Detection

The GS1670A determines if EDH packets are present in the incoming video data and asserts the EDH DETECT status according to the SMPTE standard.

EDH_DETECT is set HIGH when EDH packets have been detected and remains HIGH until EDH packets are no longer present. It is set LOW at the end of the vertical blanking (falling edge of V) if an EDH packet has not been detected during vertical blanking.

EDH_DETECT can be programmed to be output on the multi-function output port pins. The EDH_DETECT bit is also available in the host interface.

4.14.2 EDH Flag Detection

The EDH flags for ancillary data, active picture, and full field regions are extracted from the detected EDH packets and placed in the EDH_FLAG_IN register.

When the EDH_FLAG_UPDATE_MASK bit in the host interface is set HIGH, the GS1670A updates the Ancillary Data, Full Field, and Active Picture EDH flags according to SMPTE RP165. The updated EDH flags are available in the EDH_FLAG_OUT register. The EDH packet output from the device contains these updated flags.



One set of flags is provided for both fields 1 and 2. The field 1 flag data is overwritten by the field 2 flag data.

When EDH packets are not detected, the UES flags in the EDH_FLAG_OUT register are set HIGH to signify that the received signal does not support Error Detection and Handling. In addition, the EDH_DETECT bit is set LOW. These flags are set regardless of the setting of the EDH_FLAG_UPDATE_MASK bit.

EDH_FLAG_OUT and EDH_FLAG_IN may be read via the host interface at any time during the received frame except on the lines defined in SMPTE RP165, when these flags are updated.

The GS1670A indicates the CRC validity for both active picture and full field CRCs. The AP_CRC_V bit in the host interface indicates the active picture CRC validity, and the FF_CRC_V bit indicates the full field CRC validity. When EDH_DETECT = LOW, these bits are cleared.

The EDH_FLAG_OUT and EDH_FLAG_IN register values remain set until overwritten by the decoded flags in the next received EDH packet. When an EDH packet is not detected during vertical blanking, the flag registers are cleared at the end of the vertical blanking period.

4.15 Video Signal Error Detection & Indication

The GS1670A includes a number of video signal error detection functions. These are provided to enhance operation of the device when operating in SMPTE mode $(\overline{SMPTE_BYPASS} = HIGH)$. These features are not available in the other operating modes of the device (for example: when $\overline{SMPTE_BYPASS} = LOW$).

Signal errors that can be detected include:

- 1. TRS errors.
- 2. HD line based CRC errors.
- 3. EDH errors.
- 4. HD line number errors.
- 5. Video standard errors.

The device maintains an ERROR_STAT_X register. Each error condition has a specific flag in the ERROR_STAT_X register, which is set HIGH whenever an error condition is detected.

An ERROR_MASK register is also provided, allowing the user to select which error conditions are reported. Each bit of the ERROR_MASK register corresponds to a unique error type.

Separate SD_AUDIO_ERROR_MASK and HD_AUDIO_ERROR_MASK registers for SD and HD audio cores are also provided, allowing select error conditions to be reported. Each bit of each ERROR_MASK register corresponds to a unique error type.

By default (at power up or after system reset), all bits of the ERROR_MASK registers are zero, enabling all errors to be reported. Individual error detection may be disabled by setting the corresponding bit HIGH in the mask registers.



Error conditions are indicated by a $\overline{\text{VIDEO}_\text{ERROR}}$ signal and an $\overline{\text{AUDIO}_\text{ERROR}}$ signal, which are available for output on the multifunction I/O output pins. The two signals are also combined into a summary $\overline{\text{DATA}_\text{ERROR}}$ signal, which is also available on the multifunction I/O pins. These signals are normally HIGH, but are set LOW by the device when an error condition has been detected.

These signals are a logical 'NOR' of the appropriate error status flags stored in the ERROR_STAT_X register, which are gated by the bit settings in the ERROR_MASK registers. When an error status bit is HIGH and the corresponding error mask bit is LOW, the corresponding $\overline{DATA_ERROR}$ signal is set LOW by the device.

The ERROR_STAT_X registers, and correspondingly the DATA_ERROR, VIDEO_ERROR, and AUDIO_ERROR signals, are cleared at the start of the next video field or when read via the host interface, which ever condition occurs first. Note that any AUDIO_ERROR condition will cause DATA_ERROR to assert. Use the SD_AUDIO_ERROR_MASK and HD_AUDIO_ERROR_MASK registers if masking these events is desired.

All bits of the ERROR_STAT_X registers are also cleared under any of the following conditions:

- 1. LOCKED signal = LOW.
- 2. SMPTE BYPASS = LOW.
- 3. When a change in video standard has been detected.
- 4. $\overline{RESET} \overline{TRST} = LOW$

Table 4-13 shows the ERROR_STAT_X register and ERROR_MASK_X register.

NOTE 1: Since the error indication registers are cleared once per field, if an external host micro is polling the error registers periodically, an error flag may be missed if it is intermittent, and the polling frequency is less than the field rate.

Table 4-13: Error Status Register and Error Mask Register

Video Error Status Register	Video Error Mask Register
SAV_ERR (02h, 03h)	SAV_ERR_MASK (037h, 038h)
EAV_ERR (02h, 03h)	EAV_ERR_MASK (037h, 038h)
YCRC_ERR (02h, 03h)	YCRC_ERR_MASK (037h, 038h)
CCRC_ERR (02h, 03h)	CCRC_ERR_MASK (037h, 038h)
LNUM_ERR (02h, 03h)	LNUM_ERR_MASK (037h, 038h)
YCS_ERR (02h, 03h)	YCS_ERR_MASK (037h, 038h)
CCS_ERR (02h, 03h)	CCS_ERR_MASK (037h, 038h)
AP_CRC_ERR (02h)	AP_CRC_ERR_MASK (037h)
FF_CRC_ERR (02h)	FF_CRC_ERR_MASK (037h)
VD_STD_ERR (02h, 03h)	VD_STD_ERR_MASK (037h)

NOTE 2: See Section 4.18 for Audio Error Status.



4.15.1 TRS Error Detection

TRS error flags are generated by the GS1670A under the following two conditions:

- 1. A phase shift in received TRS timing is observed on a non-switching line.
- 2. The received TRS Hamming codes are incorrect.

Both SAV and EAV TRS words are checked for timing and data integrity errors.

For HD mode, only the Y channel TRS codes are checked for errors.

Both 8-bit and 10-bit TRS code words are checked for errors.

The SAV ERR bit of the ERROR STAT X register is set HIGH when an SAV TRS error is detected.

The EAV_ERR bit of the ERROR_STAT_X register is set HIGH when an EAV TRS error is detected.

4.15.2 Line Based CRC Error Detection

The GS1670A calculates line based CRCs for HD video signals. CRC calculations are done for each 10-bit channel (Y and C for HD video).

These calculated CRC values are compared with the received CRC values.

If a mismatch in the calculated and received CRC values is detected for Y channel data, the YCRC_ERR bit in the ERROR_STAT_X register is set HIGH.

If a mismatch in the calculated and received CRC values is detected for C channel data, the CCRC_ERR bit in the ERROR_STAT_X register is set HIGH.

Y or C CRC errors are also generated if CRC values are not embedded.

Line based CRC errors are only generated when the device is operating in HD mode.

NOTE: By default, 8-bit to 10-bit TRS remapping is enabled. If an 8-bit input is used, the HD CRC check is based on the 10-bit remapped value, not the 8-bit value, so the CRC Error Flag is incorrectly asserted and should be ignored. If 8-bit to 10-bit remapping is enabled, then CRC correction and insertion should be enabled by setting the CRC_INS_MASK bit in the IOPROC_DISABLE register LOW. This ensures that the CRC values are updated.

4.15.3 EDH CRC Error Detection

The GS1670A also calculates Full Field (FF) and Active Picture (AP) CRC's according to SMPTE RP165 in support of Error Detection and Handling packets in SD signals.

These calculated CRC values are compared with the received CRC values.

Error flags for AP and FF CRC errors are provided and each error flag is a logical OR of field 1 and field 2 error conditions.

The AP_CRC_ERR bit in the VIDEO_ERROR_STAT_X register is set HIGH when an Active Picture CRC mismatch has been detected in field 1 or 2.

The FF CRC ERR bit in the VIDEO ERROR STAT X register is set HIGH when a Full Field CRC mismatch has been detected in field 1 or 2.



EDH CRC errors are only indicated when the device is operating in SD mode and when the device has correctly received EDH packets.

4.15.4 HD Line Number Error Detection

If a mismatch in the calculated and received line numbers is detected, the LNUM ERR bit in the VIDEO_ERROR_STAT_X register is set HIGH.

4.16 Ancillary Data Detection & Indication

The GS1670A detects ancillary data in both the vertical and horizontal ancillary data spaces. Status signal outputs Y/1ANC and C/2ANC are provided to indicate the position of ancillary data in the output data streams. These signals may be selected for output on the multi-function I/O port pins (STAT[5:0]).

The GS1670A indicates the presence of all types of ancillary data by detecting the 000h, 3FFh, 3FFh (00h, FFh, FFh for 8-bit video) ancillary data preamble.

NOTE 1: Both 8 and 10-bit ancillary data preambles are detected by the device.

By default (at power up or after system reset) the GS1670A indicates all types of ancillary data. Up to 5 types of ancillary data can be specifically programmed for recognition.

For HD video signals, ancillary data may be placed in both the Y and Cb/Cr video data streams separately. For SD video signals, the ancillary data is multiplexed and combined into the YCbCr data space.

When operating in HD mode, the Y/1ANC signal is HIGH whenever ancillary data is detected in the Luma data stream, and C/2ANC is HIGH whenever ancillary data is detected in the Chroma data stream. The signals are asserted HIGH at the start of the ancillary data preamble, and remain HIGH until after the ancillary data checksum.

When operating in SD mode, the Y/1ANC and C/2ANC signals depend on the output data format. For 20-bit demultiplexed data, the Y/1ANC and C/2ANC signals operate independently to indicate the first and last ancillary Data Word position in the Luma and/or Chroma data streams. For 10-bit multiplexed data, the Y/1ANC signal is HIGH whenever ancillary data is detected, and the C/2ANC signal is always LOW.

These status signal outputs are synchronous with PCLK and may be used as clock-enables for external logic, or as write-enables for an external FIFO or other memory devices.

The operation of the Y/1ANC and C/2ANC signals is shown below in Figure 4-21.

NOTE 2: When I/O processing is disabled, the Y/1ANC and C/2ANC flags may toggle, but they are invalid and should be ignored.



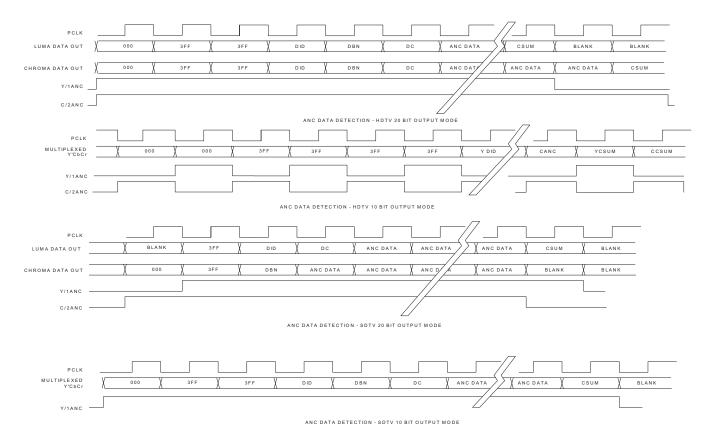


Figure 4-21: Y/1ANC and C/2ANC Signal Timing

4.16.1 Programmable Ancillary Data Detection

As described above in Section 4.16, the GS1670A detects and indicates all ancillary data types by default.

It is possible to program which ancillary data types are to be detected and indicated. Up to five different ancillary data types may be programmed for detection by the GS1670A in the ANC_TYPE_DS1 registers for SD and HD data.

When so programmed, the GS1670A only indicates the presence of the specified ancillary data types, ignoring all other ancillary data. For each data type to be detected, the user must program the DID and/or SDID of that ancillary data type. In the case where no DID or SDID values are programmed, the GS1670A indicates the presence of all ancillary data. In the case where one or more, DID and/or SDID values have been programmed, then only those matching data types are detected and indicated.

The timing of the Y/1ANC and C/2ANC signals in this case is as shown in Figure 4-21.

The GS1670A compares the received DID and/or SDID with the programmed values. If a match is found, ancillary data is indicated.

For any DID or SDID value set to zero, no comparison or match is made. For example, if the DID is programmed and the SDID is not programmed, the GS1670A only detects a match to the DID value.



If both DID and SDID values are non-zero, then the received ancillary data type must match both the DID and SDID before Y/1ANC and/or C/2ANC is set HIGH.

NOTE: SMPTE 352M Payload Identifier packets and Error Detection and Handling (EDH) Packets are always detected by the GS1670A, irrespective of the settings of the ANC_TYPE registers.

4.16.2 SMPTE 352M Payload Identifier

The GS1670A automatically extracts the SMPTE 352M payload identifier present in the input data stream for SD and HD. The four word payload identifier packets are written to VIDEO_FORMAT_X_DS1 and VIDEO_FORMAT_X_DS2 bits accessible through the host interface.

The device also indicates the version of the payload packet in the VERSION_352M bit of the DATA_FORMAT_DSX register. When the SMPTE 352M packet is formatted as a "version 1" packet, the VERSION_352M bit is set HIGH, when the packet is formatted as a "version 2" packet, this bit is set LOW.

The VIDEO_FORMAT_352_A_X and VIDEO_FORMAT_352_B_X registers are only updated if there are no checksum errors in the received SMPTE 352M packets.

By default (at power up or after system reset), the VIDEO_FORMAT_X_DS1 and VIDEO_FORMAT_X_DS2 bits are set to 0, indicating an undefined format.

4.16.2.1 SMPTE 352M Payload Identifier Usage

The SMPTE 352M Payload Identifier is used to confirm the video format identified by the Automatic Video Standards Detection block (see Section 4.16.4).

4.16.3 Ancillary Data Checksum Error

The GS1670A calculates checksums for all received ancillary data.

These calculated checksums are compared with the received ancillary data checksum words

If a mismatch in the calculated and received checksums is detected, then a checksum error is indicated.

When operating in HD mode, the device makes comparisons on both the Y and C channels separately. If an error condition in the Y channel is detected, the YCS_ERR bit in the VIDEO_ERROR_STAT_X register is set HIGH. If an error condition in the C channel is detected, the CCS_ERR bit in the VIDEO_ERROR_STAT_X register is set HIGH.

When operating in SD mode, only the YCS_ERR bit is set HIGH when checksum errors are detected.

4.16.3.1 Programmable Ancillary Data Checksum Calculation

As described above, the GS1670A calculates and compares checksum values for all ancillary data types by default. It is possible to program which ancillary data types are checked as described in Section 4.16.1.



When so programmed, the GS1670A only checks ancillary data checksums for the specified data types, ignoring all other ancillary data.

The YCS_ERR and/or CCS_ERR bits in the VIDEO_ERROR_STAT_X register are only set HIGH if an error condition is detected for the programmed ancillary data types.

4.16.4 Video Standard Error

If a mismatch between the received SMPTE 352M packets and the calculated video standard occurs, the GS1670A indicates a video standard error by setting the VD_STD_ERR bit of the VIDEO_ERROR_STAT_X register HIGH.

The device detects the SMPTE 352M Packet version as defined in the SMPTE 352M standard. If the incoming packet is Version Zero, then no comparison is made with the internally generated payload information and the VD_STD_ERR bit is not set HIGH.

NOTE 1: If the received SMPTE 352M packet indicates 25, 30 or 29.97PsF formats, the device only indicates an error when the video format is actually progressive. The device detects 24 and 23.98PsF video standards and perform error checking at these rates.

NOTE 2: VD_STD_ERR_DS1 is set incorrectly for a 1920x1080/PsF/24 payload ID. To resolve this issue, choose one of the two methods.

- Set the VD_STD_ERR_DS1 mask bit high in the ERROR_MASK_1 register to avoid having incorrect assertion of the DATA_ERROR pin.
- Monitor the received SMPTE ST0352 packet in the VIDEO_FORMAT_352_A_1 and VIDEO_FORMAT_352_B_1 registers and compare that to the video format identified in the VD_STD_DS1 bits in the DATA_FORMAT_DS1 register. Then, make the determination of whether or not there is a mismatch on their own.

4.17 Signal Processing

In addition to error detection and indication, the GS1670A can also correct errors, inserting corrected code words, checksums and CRC values into the data stream.

The following processing can be performed by the GS1670A:

- 1. TRS error correction and insertion.
- 2. HD line based CRC correction and insertion.
- 3. EDH CRC error correction and insertion.
- 4. HD line number error correction and insertion.
- 5. Illegal code re-mapping.
- 6. Ancillary data checksum error correction and insertion.
- 7. Audio extraction.

All of the above features are only available in SMPTE mode (SMPTE_BYPASS = HIGH).

To enable these features, the IOPROC_EN/ $\overline{\text{DIS}}$ pin must be set HIGH, and the individual feature must be enabled via bits in the IOPROC_DISABLE register.

The IOPROC_DISABLE register contains one bit for each processing feature allowing each one to be enabled/disabled individually.



By default (at power up or after system reset), all of the IOPROC_DISABLE register bits are LOW, enabling all of the processing features.

To disable an individual processing feature, set the corresponding IOPROC_DISABLE bit HIGH in the IOPROC_DISABLE register.

Table 4-14: IOPROC_DISABLE Register Bits

Processing Feature	IOPROC_DISABLE Register Bit
TRS error correction and insertion	TRS_INS
Y and C line based CRC error correction	CRC_INS
Y and C line number error correction	LNUM_INS
Ancillary data check sum correction	ANC_CHECKSUM_INSERTION
EDH CRC error correction	EDH_CRC_INS
Illegal code re-mapping	ILLEGAL_WORD_REMAP
H timing signal configuration	H_CONFIG
Update EDH Flags	EDH_FLAG_UPDATE
Audio Data Extraction	AUDIO_SEL
Ancillary Data Extraction	ANC_DATA_EXT
Audio Extraction	AUD_EXT
Regeneration of 352M packets	REGEN_352M

4.17.1 TRS Correction & Insertion

When TRS Error Correction and Insertion is enabled, the GS1670A generates and overwrites TRS code words as required.

TRS Word Generation and Insertion is performed using the timing generated by the Timing Signal Generator, providing an element of noise immunity over using just the received TRS information.

This feature is enabled when the IOPROC_EN/DIS pin is HIGH and the TRS_INS_DISABLE bit in the IOPROC_DISABLE register is set LOW.

NOTE: Inserted TRS code words are always 10-bit compliant, irrespective of the bit depth of the incoming video stream.

4.17.2 Line Based CRC Correction & Insertion

When CRC Error Correction and Insertion is enabled, the GS1670A generates and inserts line based CRC words into both the Y and C channels of the data stream.

Line based CRC word generation and insertion only occurs in HD mode, and is enabled in when the IOPROC_EN/\overline{DIS} pin is HIGH and the CRC_INS_DSX_MASK bit in the IOPROC_X register is set LOW.



4.17.3 Line Number Error Correction & Insertion

When Line Number Error Correction and Insertion is enabled, the GS1670A calculates and inserts line numbers into the output data stream. Re-calculated line numbers are inserted into both the Y and C channels.

Line number generation is in accordance with the relevant HD video standard as determined by the Automatic Standards Detection block.

This feature is enabled when the device is operating in HD mode, the IOPROC_EN/DIS pin is HIGH and the LNUM_INS_DSX_MASK bit in the IOPROC_X register is set LOW.

4.17.4 ANC Data Checksum Error Correction & Insertion

When ANC data Checksum Error Correction and Insertion is enabled, the GS1670A generates and inserts ancillary data checksums for all ancillary data words by default.

Where user specified ancillary data has been programmed (see Section 4.16.1), only the checksums for the programmed ancillary data are corrected.

This feature is enabled when the IOPROC_EN/DIS pin is HIGH and the ANC_CHECKSUM_INSERTION_DSX_MASK bit in the IOPROC_X register is set LOW.

4.17.5 EDH CRC Correction & Insertion

When EDH CRC Error Correction and Insertion is enabled, the GS1670A generates and overwrites full field and active picture CRC check-words.

Additionally, the device sets the active picture and full field CRC 'V' bits HIGH in the EDH packet. The AP_CRC_V and FF_CRC_V register bits only report the received EDH validity flags.

EDH FF and AP CRC's are only inserted when the device is operating in SD mode, and if the EDH data packet is detected in the received video data.

Although the GS1670A modifies and inserts EDH CRC's and EDH packet checksums, EDH error flags are only updated when the EDH_FLAG_UPDATE_MASK bit is LOW.

This feature is enabled in SD mode, when the IOPROC_EN/DIS pin is HIGH and the EDH_CRC_INS_MASK bit in the IOPROC_1 register is set LOW.

4.17.6 Illegal Word Re-mapping

All words within the active picture (outside the horizontal and vertical blanking periods), between the values of 3FCh and 3FFh are re-mapped to 3FBh. All words within the active picture area between the values of 000h and 003h are remapped to 004h.

This feature is enabled when the IOPROC_EN/DIS pin is HIGH and the ILLEGAL_WORD_REMAP_DSX_MASK bit in the IOPROC_X register is set LOW.

4.17.7 TRS and Ancillary Data Preamble Remapping

8-bit TRS and ancillary data preambles are re-mapped to 10-bit values. 8-bit to 10-bit mapping of TRS headers is only supported if the TRS values are 3FC 000 000. Other



values such as 3FD, 3FE, 3FF, 001, 002 and 003 are not supported. This feature is enabled by default, and can be disabled via the IOPROC_X register.

4.17.8 Ancillary Data Extraction

Ancillary data may be extracted externally from the GS1670A output stream using the Y/1ANC and C/2ANC signals, and external logic.

As an alternative, the GS1670A includes a FIFO, which extracts ancillary data using read access via the host interface to ease system implementation. The FIFO stores up to 2048 \times 16 bit words of ancillary data in two separate 1024 word memory banks.

Data is accessed from both memory banks using the same host interface addresses, 800h to BFFh (see Table 4-31: ANC Extraction FIFO Access Registers).

The device writes the contents of ANC packets into the FIFO, starting with the first Ancillary Data Flag (ADF), followed by up to 1024 words.

All Data Identification (DID), Secondary Data Identification (SDID), Data Count (DC), user data, and checksum words are written into the device memory.

The device detects ancillary data packet DID's placed anywhere in the video data stream, including the active picture area.

In HD mode, ancillary data from the Y channel is placed in the Least Significant Word (LSW) of the FIFO, allocated to the lower 8 bits of each FIFO address.

Ancillary data from the C channel or Data Stream Two is placed in the Most Significant Word (MSW) (upper 8 bits) of each FIFO address.

NOTE: Please refer to the ANC insertion and Extraction Application Note (Doc ID: 53410), for discrete steps and example of Ancillary data extraction.

In SD mode, ancillary data is placed in the LSW of the FIFO. The MSW is set to zero.

If the ANC_TYPE registers are all set to zero, the device extracts all types of ancillary data. If programmable ancillary data extraction is required, then up to five types of ancillary data to be extracted can be programmed in the ANC_TYPE registers (see Section 4.16.1).

Additionally, the lines from which the packets are to be extracted can be programmed into the ANC_LINEA[10:0] and ANC_LINEB[10:0] registers, allowing ancillary data from a maximum of two lines per frame to be extracted. If only one line number register is programmed (with the other set to zero), ancillary data packets are extracted from one line per frame only. When both registers are set to zero, the device extracts packets from all lines.

To start Ancillary Data Extraction, the ANC_DATA_EXT_MASK bit of the host interface must be set LOW. Ancillary data packet extraction begins in the following frame (see Figure 4-22: Ancillary Data Extraction - Step A).



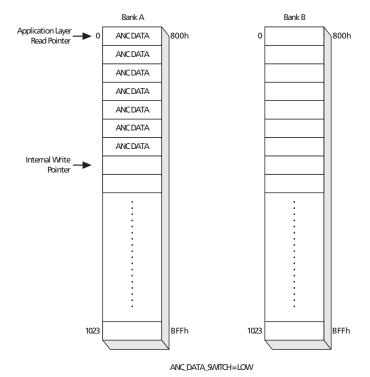


Figure 4-22: Ancillary Data Extraction - Step A

Ancillary data is written into Bank A until full. The Y/1ANC and C/2ANC output flags can be used to determine the length of the ancillary data extracted and when to begin reading the extracted data from memory.

While the ANC_DATA_EXT_MASK bit is set LOW, the ANC_DATA_SWITCH bit can be set HIGH during or after reading the extracted data. New data is then written into Bank B (up to 1024 x 16-bit words), at the corresponding host interface addresses (see Figure 4-23: Ancillary Data Extraction - Step B).

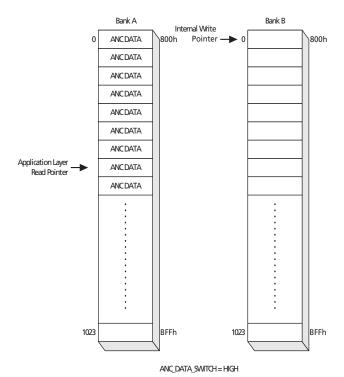
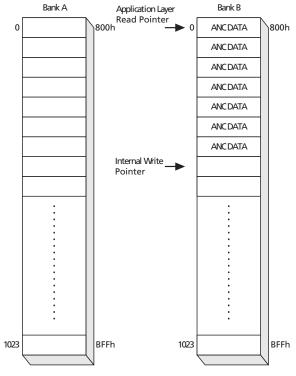


Figure 4-23: Ancillary Data Extraction - Step B

To read the new data, toggle the ANC_DATA_SWITCH bit LOW. The old data in Bank A is cleared to zero and extraction continues in Bank B (see Figure 4-24: Ancillary Data Extraction - Step C).



ANC_DATA_SWITCH = LOW

Figure 4-24: Ancillary Data Extraction - Step C

If the ANC_DATA_SWITCH bit is not toggled, extracted data is written into Bank B until full. To continue extraction in Bank A, the ANC_DATA_SWITCH bit must be toggled HIGH (see Figure 4-25: Ancillary Data Extraction - Step D).

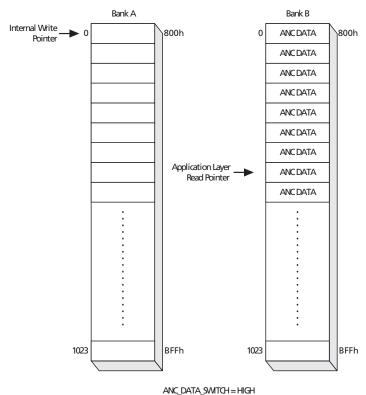


Figure 4-25: Ancillary Data Extraction - Step D

Toggling the ANC_DATA_SWITCH bit LOW returns the process to step A (Figure 4-22).

NOTE 1: Toggling the ANC_DATA_SWITCH must occur at a time when no extraction is taking place, i.e. when the both the Y/1ANC and C/2ANC signals are LOW.

To turn extraction off, the ANC_DATA_EXT_MASK bit must be set HIGH.

In HD mode, the device can detect ancillary data packets in the Luma video data only, Chroma video data only, or both. By default (at power-up or after a system reset) the device extracts ancillary data packets from the luma channel only.

To extract packets from the Chroma channel only, the HD_ANC_C2 bit of the host interface must be set HIGH. To extract packets from both Luma and Chroma video data, the HD_ANC_Y1_C2 bit must be set HIGH (the setting of the HD_ANC_C2 bit is ignored).

The default setting of both the HD_ANC_C2 and HD_ANC_Y1_C2 is LOW. The setting of these bits is ignored when the device is configured for SD video standards.

Ancillary data packet extraction and deletion is disabled when the IOPROC_EN/ $\overline{\text{DIS}}$ pin is set LOW.

After extraction, the ancillary data may be deleted from the video stream by setting the ANC_DATA_DEL bit of the host interface HIGH. When set HIGH, all existing ancillary



data is removed and replaced with blanking values. If any of the ANC TYPE registers are programmed with a DID and/or DID and SDID, only the ancillary data packets with the matching IDs are deleted from the video stream.

NOTE 2: After the ancillary data determined by the ANC TYPE X APX registers has been deleted, other existing ancillary data may not be contiguous. The device does not concatenate the remaining ancillary data.

NOTE 3: Reading extracted ancillary data from the host interface must be performed while there is a valid video signal present at the serial input and the device is locked (LOCKED signal is HIGH).

4.18 Audio De-embedder

The GS1670A includes an integrated audio de-embedder which is enabled by default in SMPTE mode. It can be disabled by setting the AUDIO_EN/DIS pin LOW, or by setting the host interface AUD EXT MASK bit to HIGH, or by keeping IOPROC EN/DIS pin LOW. In non-SMPTE modes, the audio de-embedder is not active.

Up to eight channels of audio may be extracted from the received serial digital video stream. The output signal formats supported by the device include AES/EBU, I²S (default) and industry standard serial digital formats.

16, 20 and 24-bit audio bit depths are supported for 48kHz synchronous audio for SD data rates. For HD data rates, 16, 20 and 24-bit audio bit depths are supported for 48kHz audio. The audio may be synchronous or asynchronous to the video.

Additional audio processing features include audio mute on loss of lock, de-embed and delete, group selection, audio output re-mapping, ECC error detection and correction (HD mode only), and audio channel status extraction.

4.18.1 Serial Audio Data I/O Signals

The Serial Audio Data I/O pins are listed in Table 4-15: Serial Audio Pin Descriptions.

Table 4-15: Serial Audio Pin Descriptions

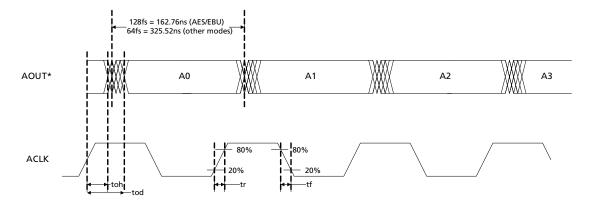
	Audio				
Pin Name	Description				
AUDIO_EN/DIS	Enable Input for Audio Processing				
AOUT_1/2	Serial Audio output; Channels 1 and 2				
AOUT_3/4	Serial Audio output; Channels 3 and 4				
AOUT_5/6	Serial Audio Output; Channels 5 and 6				
AOUT_7/8	Serial Audio Output; Channels 7 and 8				
ACLK	64fs clock				
WCLK	Word clock				
AMCLK	Audio Master Clock, selectable 128fs, 256fs, or 512fs				



The timing of the serial audio output signals, the WCLK output signal, and the ACLK output signal is as shown in Figure 4-26: ACLK to Data Signal Output Timing.

I/O Timing Specs:

Audio Outputs:



	Audio Outputs												
Г		3.3V				1.8V							
ı		toh	tr/tf (min)	Cload	tod	tr/tf (max)	Cload	toh	tr/tf (min)	Cload	tod	tr/tf (max)	Cload
Γ	AOUT	1.500ns	0.600ns	6 pF	7.000ns	2.200ns	15 pF	1.500ns	0.600ns	6 pF	7.000ns	2.300ns	15 pF

Figure 4-26: ACLK to Data Signal Output Timing

When AUDIO_EN/\overline{\text{DIS}} is set HIGH, audio extraction is enabled and the audio output signals are extracted from the video data stream. When set LOW, the serial audio outputs, ACLK and WCLK outputs are set LOW.

In addition, all functional logic associated with audio extraction is disabled to reduce power consumption.

4.18.2 Serial Audio Data Format Support

The GS1670A supports the following serial audio data formats:

- I²S (default)
- AES/EBU
- Serial Audio Left Justified, MSB First
- Serial Audio Left Justified, LSB First
- Serial Audio Right Justified, MSB First
- Serial Audio Right Justified, LSB First (this mode is not supported in SD)

By default (at power up or after system reset) I²S is selected. The other data formats are selectable via the host interface using the AMA/AMB[1:0] bits.

Table 4-16: Audio Output Formats

AMA/AMB[1:0]	Audio Output Format				
00	AES/EBU audio output				
01	Serial audio output: Left Justified; MSB first				
10	Serial audio output: Right Justified; MSB first				
11	I ² S (Default)				

The serial audio output formats may use LSB first according to the settings of the control bits LSB_FIRSTA, LSB_FIRSTB, LSB_FIRSTC, and LSB_FIRSTD. When in I²S mode, these control bits must all be set LOW (default).

When I^2S format is desired, both groups must be set to I^2S (for example: AMA = AMB = 11). This is because they share the same WCLK.

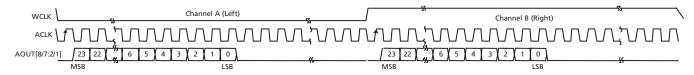


Figure 4-27: I²S Audio Output Format

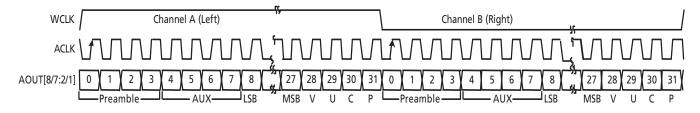


Figure 4-28: AES/EBU Audio Output Format

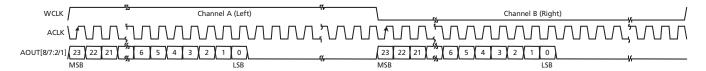


Figure 4-29: Serial Audio, Left Justified, MSB First

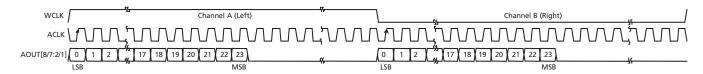


Figure 4-30: Serial Audio, Left Justified, LSB First

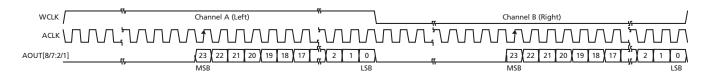


Figure 4-31: Serial Audio, Right Justified, MSB First

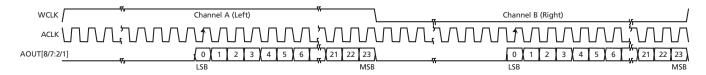


Figure 4-32: Serial Audio, Right Justified, LSB First

4.18.2.1 AES/EBU Mode

In AES/EBU output mode, the audio de-embedder uses a 128fs (6.144MHz audio bit clock) clock as shown in Figure 4-33.

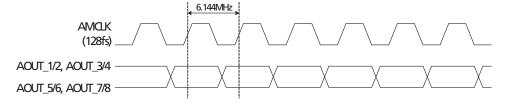


Figure 4-33: AES/EBU Audio Output to Bit Clock Timing

4.18.2.2 Audio Data Packet Extraction Block

The audio de-embedder looks for audio data packets on every line of the incoming video.

The audio data must be embedded according to SMPTE 272M (SD) or SMPTE 299M (HD).

The Audio Group Detect registers are set HIGH when audio data packets with a corresponding group DID are detected in the input video stream. The host interface reports the individual audio groups detected.

Table 4-17: Audio Data Packet Detect Register

Name	Name Description		
ADPG4_DET	Audio Group Four Data Packet Detection (1: Detected)	0	
ADPG3_DET	Audio Group Three Data Packet Detection (1: Detected)	0	
ADPG2_DET	Audio Group Two Data Packet Detection (1: Detected)	0	
ADPG1_DET	Audio Group One Data Packet Detection (1: Detected)	0	

When an audio data packet with a DID set in IDA[1:0] and IDB[1:0] is detected, the audio sample information is extracted and written into the audio FIFO.

The embedded audio group selected by IDA[1:0] is described henceforth in this document as Group A or Primary Group. The embedded audio group selected by IDB[1:0] is described henceforth in this document as Group B or Secondary Group.

Due to the large size of the horizontal ancillary data space in 720p/24, 720p/25 and 720p/30 video standards, the maximum number of ancillary data words the audio de-embedder can process is limited to 1024 when configured for these standards.

4.18.2.3 Audio Control Packets

The audio de-embedder automatically detects the presence of audio control packets in the video stream. When audio control packets for audio Group A are detected, the CTRA_DET bit of the host interface is set HIGH. When audio control packets for audio Group B are detected, the CTRB_DET bit of the host interface is set HIGH.

The audio control packet data is accessible via the host interface.

The audio control packets must be embedded according to SMPTE 272M (SD) or SMPTE 299M (HD).

NOTE: In SD, the control packet host interface registers are updated with new control packet values, after the CTRA_DET/CTRB_DET flags are cleared. In HD, the update happens automatically.

4.18.2.4 Setting Packet DID

Table 4-18 below, shows the 2-bit host interface setting for the audio group DID's.

For 24-bit audio support in SD mode, extended audio packets for Group A must have the same group DID set in IDA[1:0] of the host interface. Extended audio packets for Group B must have the same group DID set in IDB[1:0] of the host interface.

The audio de-embedder automatically detects the presence of extended audio packets. When detected, the audio output format is set to 24-bit audio sample word length.



The audio de-embedder defaults to audio Groups One and Two, where Group A is extracted from packets with audio Group One DID, and Group B from packets with audio Group Two DID.

Table 4-18: Audio Group DID Host Interface Settings

Audio Group	SD Data DID	SD Extended DID	HD Data DID	SD Control DID	HD Control DID	Host Interface Register Setting (2-bit)
1	2FFh	1FEh	2E7h	1EFh	1E3h	00b
2	1FDh	2FCh	1E6h	2EEh	2E2h	01b
3	1FBh	2FAh	1E5h	2EDh	2E1h	10b
4	2F9h	1F8h	2E4h	1ECh	1E0h	11b

Table 4-19: Audio Data and Control Packet DID Setting Register

Name	Description	Default
IDA[1-0]	Group A Audio data and control packet DID setting	00b
IDB[1-0]	Group B Audio data and control packet DID setting	01b

NOTE: To keep sample delays between audio channels the same after changing the value of IDA or IDB in the SD audio core, the audio FIFOs must be cleared. This is accomplished by asserting CLEAR_AUDIO and de-asserting at least one frame later. When the FIFOs are in the clear state, audio will be muted, but audio clocks will continue to run.

4.18.2.5 Audio Packet Delete Block

To delete all ancillary data with a group DID shown in Table 4-18, the ALL_DEL bit in the host interface must be set HIGH.

4.18.2.6 ECC Error Detection & Correction Block (HD Mode Only)

The audio de-embedder performs BCH(31,25) forward error detection and correction, as described in SMPTE 299M. The error correction for all embedded audio data packets is activated when the host interface ECC_OFF bit is set LOW (default LOW). The audio de-embedder corrects any errors in both the audio output and the embedded packet.

When a one-bit error is detected in a bit array of the ECC protected region of the audio data packet with audio group DID set in IDA[1:0], the ECCA_ERROR flag is set HIGH. When a one-bit error is detected in the ECC protected region of the audio data packet with audio group DID set in IDB[1:0], the ECCB_ERROR flag is set HIGH.

Figure 4-34 shows examples of error correction and detection. Up to 8 bits in error can be corrected, providing each bit error is in a different bit array (shown below). When there are two or more bits in error in the same 24-bit array, the errors are detected, but not corrected.



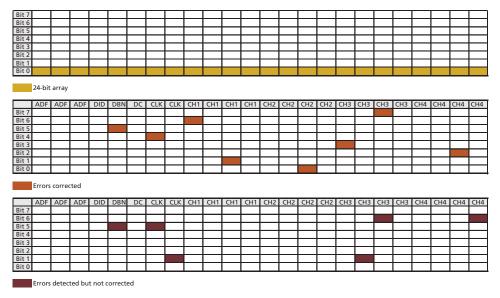


Figure 4-34: ECC 24-bit Array and Examples

4.18.3 Audio Processing

4.18.3.1 Audio Clock Generation

For SD and HD audio, a single set of audio frequencies is generated for all audio channels, using a Direct Digital Period Synthesizer (DDPS) to minimize jitter.

In SD mode, audio clocks are derived from the PCLK.

In HD mode, the input control for the DDPS is derived from the two embedded audio clock phase words in the audio data packet corresponding to Group A. The audio clock phase information used is taken from the first embedded audio packet in the HANC space. With no embedded audio present, the device will not generate ACLK or WCLK. The IGNORE_PHASE bit should be asserted in this case to ensure the proper AMCLK frequency is generated.

The audio de-embedder also includes a Flywheel block to overcome any inconsistencies in the embedded audio clock phase information.

If the audio phase data is not present in the audio data packets, or is incorrect, the NO_PHASEA_DATA bit in the host interface is set and the clock will free-run based on the detected video format, the PCLK and the M value. IGNORE_PHASE should be set HIGH when NO_PHASEA_DATA is set. This does not occur automatically.

When the IGNORE_PHASE bit in the host interface is set HIGH, it is recommended that the M value be programmed via the host interface. This can be done by setting the FORCE_M bit HIGH, and programming the desired value into FORCE_MEQ1001. The correct value can be obtained by reading the M bit from the Video Core Registers.

If the DDPS is locked to phase data and audio data packets are lost or corrupted, the Clock Generator will flywheel for up to four audio data packets. If no valid audio data packet with valid phase data is provided within this time, the Clock Generator will free-run based on the video format, the PCLK and the M value.



If the IGNORE_PHASE bit in the host interface is HIGH, the clock will free-run based on the video format, the PCLK and the M value, independent of the NO_PHASEA_DATA bit.

In the 720p/24 video format, the total line length is 4125 pixels, which requires a resolution of 13 bits for the audio clock phase words in the embedded audio data packets. SMPTE 299M only specifies a maximum of 12 bits resolution. Proposed changes to SMPTE 299M suggest using bit 5 of UDW1 (currently reserved and set to zero) in the audio data packet as the MSB (ck13) for the audio clock phase data, providing 13 bits resolution.

Some audio encoders may hold the clock phase value at a maximum value when reached, until reset at the end of the line. This produces a small amount of audio phase jitter for the period of one sample.

To overcome this issue, the audio de-embedder checks for all cases. On detection of the maximum value, a comparison is made between previous clock phases and the correct position interpolated. If the clock phase data value starts to decrease, the de-embedder checks to see if bit 5 (ck13) of UDW1 in the audio data packet is set. If ck13 is set, the correct value is used. If ck13 is not set, the correct position is interpolated.

4.18.3.2 Detect Five-Frame Sequence Block

Five-frame sequence detection is required for 525-line based video formats only. The audio de-embedder checks the Audio Frame Number sequence in the audio control packets, when present. If the audio frame sequence is running (repeated 1 to 5 count), the audio de-embedder uses this information to determine the five-frame sequence. If the audio control packet is not present, or the Audio Frame Number words are set to 200h, the audio de-embedder detects the five-frame sequence by counting the number of samples per frame. Figure 4-35 shows the number of samples per frame over a five-frame sequence.

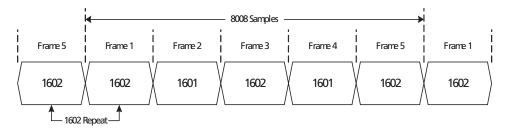


Figure 4-35: Sample Distribution Over Five Video Frames (525-line Systems)

When the audio inputs are asynchronously switched or disrupted, the audio de-embedder continues to write audio samples into the audio buffer, based on the current five-frame sequence. The de-embedder then re-locks to the new five-frame sequence, at which point a sample may be lost.

NOTE: In SD, all four channel pairs must follow the same five-frame sequence.

4.18.3.3 Audio FIFO Block

The function of the FIFO block is to change the audio data word rate from the ANC rate multiplexed with the video signal to the 48kHz audio output rate.



The audio FIFO block contains the audio sample buffers; one per audio channel. Each buffer is 36 audio samples deep. At power up or reset, the read pointer is held at the zero position until 26 samples have been written into the FIFO (allows for 6 lines per frame with no audio samples; a maximum of 4 samples per line in SD Mode). See Figure 4-36.

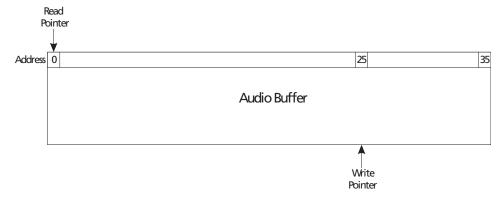


Figure 4-36: Audio Buffer After Initial 26 Sample Write

The position of the write pointer with respect to the read pointer is monitored continuously. If the write pointer is less than six samples ahead of the read pointer (point A in Figure 4-37), a sample is repeated from the read-side of the FIFO. If the write pointer is less than six samples behind the read pointer (point B in Figure 4-37), a sample is dropped. This avoids buffer underflow/overflow conditions.



Figure 4-37: Audio Buffer Pointer Boundary Checking

The repeat or drop sample operation is performed a maximum of 28 consecutive times, after which the audio outputs are muted (all sample data set to zero). In SD Mode, 26 samples are required to be written into the FIFO prior to starting the read operation again.

The audio buffer pointer offset may be reduced from 26 samples to 12 or 6 samples using the OS SEL[1:0] bits in the host interface. The default setting is 26 samples (see

When the OS_SEL[1:0] bits are set for 6-sample pointer offset, no boundary-checking is performed.

In HD mode the audio FIFO is a maximum of 10 samples deep. According to SMPTE 299M, audio samples are multiplexed immediately in the next HANC region after the audio sample occurs.

Table 4-20: Audio Buffer Pointer Offset Settings

OS_SEL[1:0]	Buffer Pointer Offset
00	26 samples (default)
01	12 samples
10	6 samples

Sample Delay

When extracting SD audio, certain conditions can cause the sample delay through the audio FIFOs to be 1-4 samples different between channels.

If delays through the audio FIFOs must be the same, it is recommended that the FIFO size gets set to 22 or 16 with OS_SEL[1:0]. Additionally, the audio FIFO must be cleared when either of the following occurs:

- 1. Loss of lock. The FIFO should be cleared when the part has relocked.
- 2. When one of the groups of audio disappears and re-appears. Poll the audio data packet detected registers ADPG1_DET, ADPG2_DET, ADPG3_DET, and ADPG4_DET once every frame. If one of the groups currently de-embedded disappears and re-appears, clear the audio FIFO after the group re-appears.

Clear the audio FIFO by asserting CLEAR_AUDIO and de-asserting at least one frame later. When the FIFOs are in the clear state, audio will be muted but audio clocks will continue to run.

When switching between 525 and 625 formats, it is recommended that the device be reset to keep the delays through the audio FIFO the same between channels.

4.18.3.4 Audio Crosspoint Block

The Audio Crosspoint is used for audio output channel re-mapping. This feature allows any of the selected audio channels in Group A or Group B to be output on any of the eight output channels. The default setting is for one to one mapping, where AOUT_1/2 is extracted from Group A CH1 and CH2, AOUT_3/4 is extracted from Group A CH3 and CH4, and so on.

NOTE: If audio samples from embedded audio packets with the group set in IDA[1:0] are to be paired with samples from the group set in IDB[1:0], all of the channels must have been derived from the same Word Clock and must be synchronous.

The output channel is set in the $OPn_SRC[2:0]$ host interface registers. Table 4-21 lists the 3-bit address for audio channel mapping.



Table 4-21: Audio Channel Mapping Codes

Audio Output Channel	3-bit Host Interface Source Address
1	000
2	001
3	010
4	011
5	100
6	101
7	110
8	111

4.18.3.5 Serial Audio Output Word Length

The audio output, in serial modes, has a selectable 24, 20 or 16-bit sample word length. The ASWL[1:0] host interface register is used to configure the audio output sample word length. Figure 4-22 shows the host interface 2-bit code for setting the audio sample word length. When the presence of extended audio packets is detected in SD modes, the audio de-embedder defaults to 24-bit audio sample word length.

Table 4-22: Audio Sample Word Lengths

ASWL[1:0]	Audio Sample Word Length (SD)	Audio Sample Word Length (HD)
00	24-bit	24-bit
01	20-bit	20-bit
10	16-bit	16-bit
11	Auto 24/20-bit (Default)	Reserved (Default)

NOTE: By default, at power-up, the word length is set to 12 bits. The desired word length should be programmed through the host interface.

4.18.3.6 Audio Channel Status

The GS1670A detects the AES/EBU Audio Channel Status (ACS) block information for each of the selected channel pairs.

ACS data detection is indicated by corresponding ACS_DET flag bits in the host interface. The flag is cleared by writing to the same location.

Audio Channel Status Read

AES/EBU ACS data is available separately for each of the channels in a stereo pair. The GS1670A defaults to reading the first channel of each pair. There are 184 bits in each



ACS packet, which are written to twelve 16-bit right-justified registers in the host interface.

The ACS_USE_SECOND bit (default LOW) selects the second channel in each audio pair when set HIGH.

Once all of the ACS data for a channel has been acquired, the corresponding ACS_DET bit is set, and acquisition stops. The ACS data is overwritten with new data when the ACS_DET bit is cleared in the system.

Audio Channel Status Regeneration

When the ACS_REGEN bit in the host interface is set HIGH, the audio de-embedder embeds the 24 bytes of the Audio Channel Status information programmed in the ACSR[183:0] registers into the 'C' bit of the AES/EBU outputs. The same Audio Channel Status information is used for all output channels.

In order to apply ACSR data;

- Set the ACS_REGEN bit to logic HIGH
- Write the desired ACSR data to the ACSR registers
- Set the ACS APPLY bit to HIGH

At the next status boundary, the device outputs the contents of the ACSR registers as ACS data. This event may occur at a different time for each of the output channels. While waiting for the status boundary, the device sets the appropriate ACS_APPLY_WAIT[A:D] flag.

Table 4-23 shows the host interface default settings for the Audio Channel Status block. The audio de-embedder automatically generates the CRC word.

Table 4-23: Audio Channel Status Information Registers

Name	Description	Default
ACSR[7-0]	Audio channel status block byte 0 set. Used when ACS_REGEN is set HIGH	85h
ACSR[15-8]	Audio channel status block byte 1 set. Used when ACS_REGEN is set HIGH	08h
ACSR[23-16]	Audio channel status block byte 2 set. Used when ACS_REGEN is set HIGH	28h (SD) 2Ch (HD)
ACSR[31-24]: ACSR[183-176]	Audio channel status block data for bytes 3 to 22. Used when ACS_REGEN is set HIGH	00h
ACS_REGEN	Audio channel status regenerate	0
ACS_APPLY	Apply new ACSR data	0
ACS_APPLY_W AIT[A:D]	Waiting to apply new ACSR data	0
ACS[7-0]: ACS[183-176]	Audio channel status block data for bytes 0 to 22	00h: 00h

Table 4-24: Audio Channel Status Block for Regenerate Mode Default Settings

Name	Byte	Bit	Default	Mode			
PRO	0	0	1b	Professional use of channel status block			
Emphasis	0	2-4	100b	100b None. Rec. manual override disabled			
Sample Frequency	0	6-7	01b	48kHz. Manual override or auto disabled			
Channel Mode	1	0-3	0001b	Two channels. Manual override disabled			
AUX	2	0-2	000b	SD Modes: Maximum audio word length is 20 bits			
			001b	HD Mode: Maximum audio word length is 24 bits			
Source Word Length	2	3-5	101b	Maximum word length (based on AUX setting). 24-bit for HD Mode; 20-bit for SD Modes			
	All other bits set to zero						

4.18.3.7 Audio Mute

When the MUTE bits in the host interface are set HIGH, the audio outputs are muted (all audio sample bits are set to zero). To set all the audio output channels to mute, set the host interface MUTE_ALL bit HIGH.

Table 4-25: Audio Mute Control Bits

Name	Description	Default
MUTE_ALL	Ch1-8 audio mute enable (1: Enabled)	0
MUTE8	Ch8 audio mute enable (1: Enabled)	0
MUTE7	Ch7 audio mute enable (1: Enabled)	0
MUTE6	Ch6 audio mute enable (1: Enabled)	0
MUTE5	Ch5 audio mute enable (1: Enabled)	0
MUTE4	Ch4 audio mute enable (1: Enabled)	0
MUTE3	Ch3 audio mute enable (1: Enabled)	0
MUTE2	Ch2 audio mute enable (1: Enabled)	0
MUTE1	Ch1 audio mute enable (1: Enabled)	0

Mute On Loss Of Lock

When the GS1670A loses lock (LOCKED signal is LOW), the audio de-embedder sets all audio outputs LOW (no audio formatting is performed). The ACLK, WCLK and AMCLK outputs are also forced LOW.



4.18.4 Error Reporting

4.18.4.1 Data Block Number Error

When the 1-255 count sequence in the Data Block Number (DBN) word of Group A audio data packets is discontinuous, the DBNA_ERR bit in the host interface AUDIO_ERROR_STAT_X register is set HIGH. When the 1-255 count sequence in the DBN word of Group B audio data packets is discontinuous, the DBNB_ERR bit in the AUDIO_ERROR_STAT_X register is set HIGH.

The DBNA_ERR and DBNB_ERR flags also have associated SD_AUDIO_ERROR_MASK and HD_AUDIO_ERROR_MASK register flags for configuration of error reporting in the Receiver. The DBNA_ERR and DBNB_ERR flags remains set until cleared by writing to these locations.

4.18.4.2 ECC Error

The GS1670A monitors the ECC error status of the two selected audio groups, as described in Section 4.18.2.6 on page 71.

The ECC[N]_ERROR flags also have associated SD_AUDIO_ERROR_MASK and HD_AUDIO_ERROR_MASK register flags for configuration of error reporting in the Receiver. The ECC[N]_ERROR flags remain set until read via the host interface.

4.19 GSPI - HOST Interface

The GSPI, or Gennum Serial Peripheral Interface, is a four-wire interface provided to allow the system to access additional status and control information through configuration registers in the GS1670A.

The GSPI is comprised of a Serial Data Input signal (SDIN), Serial Data Output signal (SDOUT), an active low Chip Select ($\overline{\text{CS}}$), and a Burst Clock (SCLK).

Because these pins are shared with the JTAG interface port, an additional control signal pin JTAG/HOST is provided.

When JTAG/HOST is LOW, the GSPI interface is enabled. When JTAG/HOST is HIGH, the JTAG interface is enabled.

When operating in GSPI mode, the SCLK, SDIN, and $\overline{\text{CS}}$ signals must be provided by the system. The SDOUT pin is a non-clocked loop-through of SDIN and may be connected to the SDIN of another device, allowing multiple devices to be connected to the GSPI chain. See Section 4.19.2 for details. The interface is illustrated in the Figure 4-38 below.



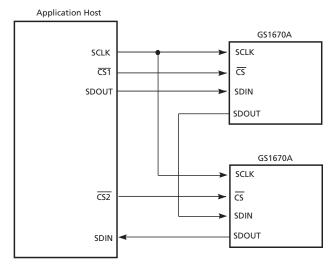


Figure 4-38: GSPI Application Interface Connection

All read or write access to the GS1670A is initiated and terminated by the system host processor. Each access always begins with a Command/Address Word, followed by a data write to, or data read from, the GS1670A.

4.19.1 Command Word Description

The Command Word consists of a 16-bit word transmitted MSB first and contains a read/write bit, an Auto-Increment bit and a 12-bit address.



Figure 4-39: Command Word Format

Command Words are clocked into the GS1670A on the rising edge of the Serial Clock SCLK, which operates in a burst fashion. The chip select (\overline{CS}) signal must be set low a minimum of 1.5ns (t0 in Figure 4-41) before the first clock edge to ensure proper operation.

When the Auto-Increment bit is set LOW, each Command Word must be followed by only one Data Word to ensure proper operation.

If the Auto-Increment bit is set HIGH, the following Data Word is written into the address specified in the Command Word, and subsequent Data Words are written into incremental addresses from the first Data Word. This facilitates multiple address writes without sending a Command Word for each Data Word.

NOTE: The RSV bits in the GSPI command word can be set to zero as placeholder, though these bits are not used.



4.19.2 Data Read or Write Access

During a read sequence (Command Word R/W bit set HIGH) serial data is transmitted or received MSB first, synchronous with the rising edge of the serial clock SCLK. The Chip Select (\overline{CS}) signal must be set low a minimum of 1.5ns (t0 in Figure 4-41) before the first clock edge to ensure proper operation. The first bit (MSB) of the Serial Output (SDOUT) is available (t5 in Figure 4-42) following the last falling SCLK edge of the read Command Word, the remaining bits are clocked out on the negative edges of SCLK.

NOTE: When several devices are connected to the GSPI chain, only one \overline{CS} may be asserted during a read sequence.

During a write sequence (Command Word R/W bit set LOW), a wait state of 37.1ns (t4 in Figure 4-41) is required between the Command Word and the following Data Word. This wait state must also be maintained between successive Command Word/Data Word write sequences. When Auto Increment mode is selected (AutoInc = 1), the wait state must be maintained between successive Data Words after the initial Command Word/Data Word sequence.

During the write sequence, all Command and following Data Words input at the SDIN pin are output at the SDOUT pin unchanged. When several devices are connected to the GSPI chain, data can be written simultaneously to all the devices which have $\overline{\text{CS}}$ set LOW.



Figure 4-40: Data Word Format

4.19.3 GSPI Timing

Write and Read Mode timing for the GSPI interface are shown in Figure 4-41 and Figure 4-42 below:

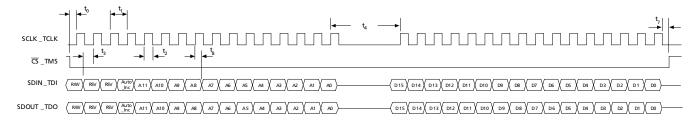


Figure 4-41: Write Mode

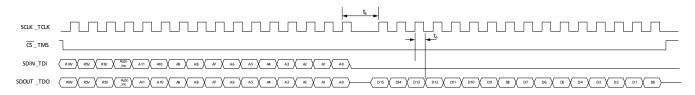


Figure 4-42: Read Mode

SDIN_TDI to SDOUT_TDO combinational path for daisy chain connection of multiple GS1670A devices.

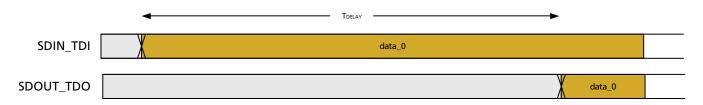


Figure 4-43: GSPI Time Delay

Table 4-26: GSPI Time Delay

Parameter	Symbol	Conditions	Min	Тур	Max	Units
Delay Time	t _{DELAY}	50% levels; 1.8V operation	-	_	13.1	ns
Delay Time	t _{DELAY}	50% levels; 3.3V operation	-	-	9.7	ns

Table 4-27: GSPI Timing Parameters (50% levels; 3.3V or 1.8V operation)

Parameter	Symbol	Mii	n	Тур	Max	Units
CS low before SCLK rising edge	t ₀	1.5	j	-	-	ns
SCLK period	t ₁	16.6	57	-	-	ns
SCLK duty cycle	t ₂	40		50	60	%
Input data setup time	t ₃	1.5	i	-	-	ns
Time between end of Command Word (or data in	t ₄	PCLK (MHz)	ns	-	-	ns
Auto-Increment mode) and the first SCLK of the following Data Word – write cycle		unlocked	100			
		27.0	37.1			
		74.25	13.5			
		148.5	6.7			
Time between end of Command Word (or data in	t ₅	PCLK (MHz)	ns	-	_	ns
Auto-Increment mode) and the first SCLK of the following Data Word – read cycle.		unlocked	-			
		27.0	148.4			
		74.25	53.9			
		148.5	27			
Time between end of Command Word (or data in Auto-Increment mode) and the first SCLK of the following Data Word – read cycle - ANC FIFO Read	t ₅	222.	6	-	-	ns
Output hold time (15pF load)	t ₆	1.5	i	-	_	ns
CS high after last SCLK rising edge	t ₇	PCLK (MHz)	ns	-	-	ns
		unlocked	445			
		27.0	37.1			
		74.25	13.5			
		148.5	6.7			
Input data hold time	t ₈	1.5	<u> </u>		_	ns

This timing must be satisfied across all ambient temperature and power supply operating conditions, as described in the Electrical Characteristics on page 16.



4.20 Host Interface Register Maps

NOTE: The GS1670A only accepts write/read commands to/from the Audio Register Maps when the audio core is locked to the incoming video data rate. The Video Register Map is always active, whether valid serial input data is present or not.

4.20.1 Video Core Registers

Table 4-28: Video Core Configuration and Status Registers

Address	Register Name	Bit Name	Bit	Description	R/W	Default
000h	IOPROC_1	RSVD	15	Reserved.	R	0
		_DISABLE for HD and SD inputs.	Disables 8-bit TRS word remapping for HD and SD inputs.	R/W	0	
		RSVD	13	Reserved.	R/W	0
		EDH_FLAG_UPDATE _MASK	12	Disables updating of EDH error flags.	R/W	0
		EDH_CRC_INS_MASK	11	Disables EDH_CRC error correction and insertion.	R/W	0
		H_CONFIG	10	Selects the H blanking indication:	R/W	0
				0: Active line blanking - the H output is HIGH for all the horizontal blanking period, including the EAV and SAV TRS words.		
				1: TRS based blanking - the H output is set HIGH for the entire horizontal blanking period as indicated by the H bit in the received TRS signals.		
				This signal is only valid when TIM_861 is set to '0' (via pin or host interface).		
		ANC_DATA_EXT_MASK	9	Disables ancillary data extraction FIFO.	R/W	0
		AUD_EXT_MASK	8	Disables audio extraction block.	R/W	0
		TIM_861_PIN_DISABLE	7	Disable TIM_861 pin control when set to '1', and use TIMING_861 bit instead.	R/W	0
		TIMING_861	6	Selects the output timing reference format: 0 = Digital FVH timing output; 1 = CEA-861 timing output.	R/W	0
		RSVD	5	Reserved.	R/W	0
		ILLEGAL_WORD_REMAP _DS1_MASK	4	Disables illegal word remapping for HD and SD inputs.	R/W	0

Table 4-28: Video Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Defaul
000h	IOPROC_1	ANC_CHECKSUM _INSERTION_DS1_MASK	3	Disables insertion of ancillary data checksums for HD and SD inputs.	R/W	0
		CRC_INS_DS1_MASK	2	Disables insertion of HD CRC words for HD inputs.	R/W	0
		LNUM_INS_DS1_MASK	1	Disables insertion of line numbers for HD inputs.	R/W	0
		TRS_INS_DS1_MASK	0	Disables insertion of TRS words for HD and SD inputs.	R/W	0
001h	01h IOPROC_2 RSV	RSVD	15	Reserved.	R/W	N/A
		NONINV	14	With DISB_AUTDET set HIGH, if this bit is asserted (HIGH), forces non-inverted MPEG-2 decoding. If deasserted (LOW), forces inverted MPEG-2 decoding. Applicable in DVB-ASI mode only.	R/W	0
		DISB_AUTDET	13	Disables auto detection of inverted DVB ASI MPEG-2 data when HIGH. When LOW, NONINV is ignored and the DVB decoder auto detects for inverted MPEG-2 data. Applicable in DVB-ASI mode only.	R/W	0
		RSVD	12-0	Reserved.	R/W	N/A
002h	ERROR_STAT_1	RSVD	15-11	Reserved.	ROCW	0
		VD_STD_ERR_DS1	10	Video Standard Error indication for HD and SD inputs.	ROCW	0
		FF_CRC_ERR	9	EDH Full Frame CRC error indication.	ROCW	0
		AP_CRC_ERR	8	EDH Active Picture CRC error indication.	ROCW	0
		RSVD	7	Reserved.	ROCW	0
		CCS_ERR_DS1	6	Chroma ancillary data checksum error indication for HD and SD inputs.	ROCW	0
		YCS_ERR_DS1	5	Luma ancillary data checksum error indication for HD and SD inputs.	ROCW	0
		CCRC_ERR_DS1	4	Chroma CRC error indication for HD inputs.	ROCW	0
		YCRC_ERR_DS1	3	Luma CRC error indication for HD inputs.	ROCW	0
		LNUM_ERR_DS1	2	Line number error indication for HD inputs.	ROCW	0
		SAV_ERR_DS1	1	SAV error indication for HD and SD inputs.	ROCW	0
		EAV_ERR_DS1	0	EAV error indication for HD and SD inputs.	ROCW	0



Table 4-28: Video Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Default
003h	RSVD	RSVD	15-0	Reserved.	ROCW	N/A
004h	EDH_FLAG_IN	EDH_DETECT	15	Embedded EDH packet detected.	R	0
		ANC_UES_IN	14	Ancillary data – unknown error status flag.	R	0
		ANC_IDA_IN	13	Ancillary data – internal error detected already flag.	R	0
		ANC_IDH_IN	12	Ancillary data – internal error detected here flag	R	0
		ANC_EDA_IN	11	Ancillary data – error detected already flag.	R	0
		ANC_EDH_IN	10	Ancillary data – error detected here flag.	R	0
		FF_UES_IN	9	EDH Full Field – unknown error status flag.	R	0
		FF_IDA_IN	8	EDH Full Field – internal error detected already flag.	R	0
		FF_IDH_IN	7	EDH Full Field – internal error detected here flag.	R	0
		FF_EDA_IN	6	EDH Full Field – error detected already flag.	R	0
		FF_EDH_IN	5	EDH Full Field – error detected here flag.	R	0
		AP_UES_IN	4	EDH Active Picture – unknown error status flag.	R	0
		AP_IDA_IN	3	EDH Active Picture – internal error detected already flag.	R	0
		AP_IDH_IN	2	EDH Active Picture – internal error detected here flag.	R	0
		AP_EDA_IN	1	EDH Active Picture – error detected already flag.	R	0
		AP_EDH_IN	0	EDH Active Picture – error detected here flag.	R	0

Table 4-28: Video Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Defau
005h	EDH_FLAG_OUT	RSVD	15	Reserved.	R	0
		ANC_UES	14	Ancillary data – Unknown Error Status flag.	R	1
		ANC_IDA	13	Ancillary data – Internal error Detected Already flag.	R	0
		ANC_IDH	12	Ancillary data – Internal error Detected Here flag.	R	0
		ANC_EDA	11	Ancillary data – Error Detected Already flag.	R	0
		ANC_EDH	10	Ancillary data – Error Detected Here flag.	R	0
		FF_UES	9	EDH Full Field – Unknown Error Status flag.	R	1
		FF_IDA	8	EDH Full Field – Internal error Detected Already flag.	R	0
		FF_IDH	7	EDH Full Field – Internal error Detected Here flag.	R	0
		FF_EDA	6	EDH Full Field – Error Detected Already flag.	R	0
		FF_EDH	5	EDH Full Field – Error Detected Here flag.	R	0
		AP_UES	4	EDH Active Picture – Unknown Error Status flag.	R	1
		AP_IDA	3	EDH Active Picture – Internal error Detected Already flag.	R	0
		AP_IDH	2	EDH Active Picture – Internal error Detected Here flag.	R	0
		AP_EDA	1	EDH Active Picture – Error Detected Already flag.	R	0
		AP_EDH	0	EDH Active Picture – Error Detected Here flag.	R	0
006h	6_DS1	FF_CRC_V	15	EDH Full Field CRC Validity bit.	R	0
		AP_CRC_V	14	EDH Active Picture CRC Validity bit.	R	0
		VD_STD_DS1	13-8	Detected Video Standard for HD and SD inputs.	R	29
		CDATA_FORMAT_DS1	7-4	Data format as indicated in Chroma channel for HD and SD inputs.	R	15
		YDATA_FORMAT_DS1	3-0	Data format as indicated in Luma channel for HD and SD inputs.	R	15
007h	DATA_FORMAT_ DS2	RSVD	15-0	Reserved.	R	N/A

Table 4-28: Video Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Defaul
008h	IO_CONFIG	RSVD	15	Reserved.	RW	0
		STAT2_CONFIG	14-10	Configure STAT2 output pin: 00000: H Blanking when TIM_861 = 0; HSYNC when TIM_861 = 1 00001: V Blanking when TIM_861 = 0; VSYNC when TIM_861 = 1 00010: F bit when TIM_861 = 0; Data Enable (DE) when TIM_861 =	RW	2
				1 00011: LOCKED 00100: Y/1ANC: ANC indication (SD), Luma ANC indication (HD) 00101: C/2ANC: Chroma ANC indication (HD) 00110: Data Error 00111: Video Error 01000: Audio Error 01001: EDH Detected 01010: Carrier Detect 01011: RATE_DET 01100 - 11111: Reserved		
		STAT1_CONFIG	9-5	Configure STAT1 output pin. (Refer to above for decoding)	RW	1
		STAT0_CONFIG	4-0	Configure STAT0 output pin. (Refer to above for decoding)	RW	0
009h	IO_CONFIG2	RSVD	15	Reserved.	RW	0
		STAT5_CONFIG	14-10	Configure STAT5 output pin. (Refer to above for decoding)	RW	6
		STAT4_CONFIG	9-5	Configure STAT4 output pin. (Refer to above for decoding)	RW	4
		STAT3_CONFIG	4-0	Configure STAT3 output pin. (Refer to above for decoding)	RW	3
00Ah	ANC_CONTROL	RSVD	15-4	Reserved.	RW	0
		ANC_DATA_SWITCH	3	Switches between FIFO memories.	RW	0
		ANC_DATA_DEL	2	Remove Ancillary Data from output video stream, set to Luma and Chroma blanking values.	RW	0
		HD_ANC_Y1_C2	1	Extract Ancillary data from Luma and Chroma channels (HD inputs)	RW	0
		HD_ANC_C2	0	Extract Ancillary data only from Chroma channel (HD inputs)	RW	0
00Bh	ANC_LINE_A	RSVD	15-11	Reserved.	R/W	0
		ANC_LINE_A	10-0	Video Line to extract Ancillary data from.	R/W	0
00Ch	ANC_LINE_B	RSVD	15-11	Reserved.	R/W	0
		ANC_LINE_B	10-0	Second video Line to extract Ancillary data from.	R/W	0



Table 4-28: Video Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Default
00Dh - 00Eh	RSVD	RSVD	15-0	Reserved.	R	0
00Fh	ANC_TYPE_1_AP 1	ANC_TYPE1_DS1	15-0	Programmable DID/SDID pair #1 to extract from HD and SD input formats ([15:8] = DID, [7:0] =SDID).	R/W	0
010h	ANC_TYPE_2_AP 1	ANC_TYPE2_DS1	15-0	Programmable DID/SDID pair #2 to extract from HD and SD input formats ([15:8] = DID, [7:0] =SDID).	R/W	0
011h	ANC_TYPE_3 _AP1	ANC_TYPE3_DS1	15-0	Programmable DID/SDID pair #3 to extract from HD and SD input formats ([15:8] = DID, [7:0] =SDID).	R/W	0
012h	ANC_TYPE_4 _AP1	ANC_TYPE4_DS1	15-0	Programmable DID/SDID pair #4 to extract from HD and SD input formats ([15:8] = DID, [7:0] =SDID).	R/W	0
013h	ANC_TYPE_5 _AP1	ANC_TYPE5_DS1	15-0	Programmable DID/SDID pair #5 to extract from HD and SD input formats ([15:8] = DID, [7:0] =SDID).	R/W	0
014h - 018h	RSVD	RSVD	15-0	Reserved.	R/W	N/A
019h	VIDEO_FORMAT _352_A_1	VIDEO_FORMAT_2_DS1	15-8	SMPTE 352M embedded packet – byte 2.	R	0
		VIDEO_FORMAT_1_DS1	7-0	SMPTE 352M embedded packet – byte 1: [7]: Version identifier [6:0]: Video Payload Identifier.	R	0
01Ah	VIDEO_FORMAT _352_B_1	VIDEO_FORMAT_4_DS1	15-8	SMPTE 352M embedded packet – byte 4.	R	0
		VIDEO_FORMAT_3_DS1	7-0	SMPTE 352M embedded packet – byte 3.	R	0
01Bh - 01Eh	RSVD	RSVD	15-0	Reserved.	R/W	N/A
01Fh	RASTER_STRUC_	RSVD	15-14	Reserved.	R	0
	1	WORDS_PER_ACTLINE	13-0	Words Per Active Line.	R	0
020h	RASTER_STRUC_	RSVD	15-14	Reserved.	R	0
	2	WORDS_PER_LINE	13-0	Total Words Per Line.	R	0
021h	RASTER_STRUC_	RSVD	15-11	Reserved.	R	0
	3	LINES_PER_FRAME	10-0	Total Lines Per Frame.	R	0

Table 4-28: Video Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Defau
022h	RASTER_STRUC_ 4	RATE_SEL_READBACK	15-14	Read back detected data rate: 0 = HD, 1,3=SD, 2=Reserved	R	0
		М	13	Specifies detected M value 0: 1.000 1: 1.001	R	0
				er ppm offsets in the crystal, the 'M' bit ster 06Fh can be increased to a maximu		
		STD_LOCK	12	Video standard lock.	R	0
		INT_PROG	11	Interlaced or progressive.	R	0
		ACTLINE_PER_FIELD	10-0	Active lines per frame.	R	0
023h	FLYWHEEL _STATUS	RSVD	15-2	Reserved.	R	0
		V_LOCK_DS1	1	Indicates that the timing signal generator is locked to vertical timing (HD and SD inputs).	R	0
		H_LOCK_DS1	0	Indicates that the timing signal generator is locked to horizontal timing (HD and SD inputs).	R	0
024h	RATE_SEL	RSVD	15-3	Reserved.	R	0
		AUTO/MAN	2	Detect data rate automatically (1) or program manually (0).	R/W	1
		RATE_SEL_TOP	1-0	Programmable rate select in manual mode: 0 = HD, 1,3=SD, 2=Reserved	R/W	0
025h	TIM_861_	RSVD	15-7	Reserved.	R	0
	FORMAT	FORMAT_ERR	6	Indicates standard is not recognized for CEA 861 conversion.	R	1
		FORMAT_ID_861	5-0	CEA-861 format ID of input video stream. Refer to Table 4-9.	R	0
026h	TIM_861_CFG	RSVD	15-3	Reserved.	R	0
		VSYNC_INVERT	2	Invert output VSYNC pulse.	R/W	0
		HSYNC_INVERT	1	Invert output HSYNC pulse.	R/W	0
		TRS_861	0	Sets the timing reference outputs to DFP timing mode when set to '1'. By default, the timing reference outputs follow CEA-861 timing mode. Only valid when TIM_861 is set to '1'.	R/W	0
027h - 036h	RSVD	RSVD	-	Reserved.	R	N/A



Table 4-28: Video Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Default
037h	ERROR_MASK_1	RSVD	15-11	Reserved.	R	0
		ERROR_MASK_1	10-0	Error mask for global error vector (HD, SD): bit[0]: EAV_ERR_DS1 mask bit[1]: SAV_ERR_DS1 mask bit[2]: LNUM_ERR_DS1 mask bit[3]: YCRC_ERR_DS1 mask bit[4]: CCRC_ERR_DS1 mask bit[5]: YCS_ERR_DS1 mask bit[6]: CCS_ERR_DS1 mask bit[6]: CCS_ERR_DS1 mask bit[7]: Reserved bit[8]: AP_CRC_ERR mask bit[9]: FF_CRC_ERR mask bit[10]: VD_STD_ERR_DS1 mask	R/W	0
038h	RSVD	RSVD	15-0	Reserved.	R	N/A
039h	AGC_CTRL	RSVD	15-5	Reserved.	R	0
		SCLK_INV	4	Invert polarity of output serial audio clock.	R/W	0
		AMCLK_INV	3	Invert polarity of output audio master clock.	R/W	0
		RSVD	2	Reserved.	R/W	0
		AMCLK_SEL	1-0	Audio Master Clock Select. 0: 128 fs 1: 256 fs 2: 512 fs	R/W	0
03Ah -6Bh	RSVD	RSVD	15-0	Reserved.	R	N/A
06Ch	CLK_GEN	RSVD	15-5	Reserved.	R/W	0
		DEL_LINE_OFFSET	4-0	Controls the offset for the delay line.	R/W	0



Table 4-28: Video Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Default
06Dh	IO_DRIVE	RSVD	15-6	Reserved.	R/W	0
	_STRENGTH	IO_DS_CTRL_DOUT_MSB	5-4	Drive strength adjustment for DOUT[19:10] outputs and PCLK output: 00: 4mA; 01: 8mA; 10: 10mA(1.8V), 12mA(3.3V); 11: 12mA(1.8V), 16mA(3.3V)	R/W	2
		IO_DS_CTRL_STAT	3-2	Drive strength adjustment for STAT[5:0] outputs: 00: 4mA; 01: 6mA; 10: 8mA(1.8V), 10mA(3.3V); 11: 10mA(1.8V), 12mA(3.3V)	R/W	2
		IO_DS_CTRL_DOUT_LSB	1-0	Drive strength adjustment for DOUT[9:0] outputs: 00: 4mA; 01: 6mA; 10: 8mA(1.8V), 10mA(3.3V); 11: 10mA(1.8V), 12mA(3.3V)	R/W	3
06Eh	RSVD	RSVD	15-0	Reserved.	R/W	N/A
06Fh	RSVD	RSVD	15-4	Reserved.	R/W	0
	M_DETECTION _TOLERANCE	M_DETECTION _TOLERANCE	3-0	Sets the detection tolerance.	R/W	2
070h -084h	RSVD	RSVD	15-0	Reserved.	R/W	0
085h	RSVD	RSVD	15-11	Reserved.	R/W	0
	LOCK_NOISE _IMM_INCR	LOCK_NOISE_IMM_INCR	10	Enables extra noise-immunity on SMPTE detected lock when HIGH by forcing detection of three TRS words with the last two TRS words having the same alignment before locking to SMPTE. Enable this only for AUTO/MAN = HIGH.	RW	0
	RSVD	RSVD	9-0	Reserved.	R/W	0



4.20.2 SD Audio Core Registers

NOTE: The GS1670A only accepts write/read commands to/from the SD Audio Register Map when the audio core is locked to the incoming SD video format.

Table 4-29: SD Audio Core Configuration and Status Registers

Address	Register Name	Bit Name	Bit	Description	R/W	Default
400h	CFG_AUD	RSVD	15-14	Reserved.	R/W	0
		ALL_DEL	13	Selects deletion of all audio data and all audio control packets. 0: Do not delete existing audio packets 1: Delete existing audio packets	R/W	0
		MUTE_ALL	12	Mute all output channels. 0: Normal 1: Muted	R/W	0
		ACS_USE_SECOND	11	Extract Audio Channel Status from second channel pair.	R/W	0
		CLEAR_AUDIO	10	Clears all audio FIFO buffers and puts them in start-up state.	R/W	0
		OS_SEL	9-8	Specifies the audio FIFO buffer size. 00: 36 samples deep, 26 sample start-up count 01: 22 samples deep, 12 sample start-up count 10: 16 samples deep, 6 sample start-up count 11: Reserved	R/W	0
				NOTE: The default 36-sample deep FIFO size is not supported if each audio channel must have the same sample delay.		
		LSB_FIRSTD	7	Causes the channel 7 and 8 output format to use LSB first. 0: MSB first 1: LSB first	R/W	0
		LSB_FIRSTC	6	Causes the channel 5 and 6 output format to use LSB first. 0: MSB first 1: LSB first	R/W	0
		LSB_FIRSTB	5	Causes the channel 3 and 4 output format to use LSB first. 0: MSB first 1: LSB first	R/W	0
		LSB_FIRSTA	4	Causes the channel 1 and 2 output format to use LSB first. 0: MSB first 1: LSB first	R/W	0

Table 4-29: SD Audio Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Defaul
400h	CFG_AUD	IDB	3-2	Specifies the Secondary audio group to extract. 00: Audio group #1 01: Audio group #2 10: Audio group #3 11: Audio group #4 NOTE 1: Should IDA and IDB be set to the same value, they automatically revert to their default values. NOTE 2: The Mute function will remove invalid data.	R/W	1
		IDA	1-0	Specifies the Primary audio group to extract. 00: Audio group #1 01: Audio group #2 10: Audio group #3 11: Audio group #4 NOTE 1: Should IDA and IDB be set to the same value, they automatically revert to their default values. NOTE 2: The Mute function will remove invalid data.	R/W	0
401h	DBN_ERR	EXT_DET3_4B	15	Set when Secondary group channels 3 and 4 have extended data. Write '1' to clear.	ROCW	0
		EXT_DET1_2B	14	Set when Secondary group channels 1 and 2 have extended data. Write '1' to clear.	ROCW	0
		EXT_DET3_4A	13	Set when Primary group channels 3 and 4 have extended data. Write '1' to clear.	ROCW	0
		EXT_DET1_2A	12	Set when Primary group channels 1 and 2 have extended data. Write '1' to clear.	ROCW	0
		CTL_DBNB_ERR	11	Set when Secondary group control packet Data Block Number sequence is discontinuous. Write '1' to clear.	ROCW	0
		CTL_DBNA_ERR	10	Set when Primary group control packet Data Block Number sequence is discontinuous. Write '1' to clear.	ROCW	0
		EXT_DBNB_ERR	9	Set when Secondary group extended data packet Data Block Number sequence is discontinuous. Write '1' to clear.	ROCW	0
		EXT_DBNA_ERR	8	Set when Primary group extended data packet Data Block Number sequence is discontinuous. Write '1' to clear.	ROCW	0



Table 4-29: SD Audio Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Default
401h	DBN_ERR	SAMP_DBNB_ERR	7	Set when Secondary group data packet Data Block Number sequence is discontinuous. Write '1' to clear.	ROCW	0
		SAMP_DBNA_ERR	6	Set when Primary group data packet Data Block Number sequence is discontinuous. Write '1' to clear.	ROCW	0
		CTRB_DET	5	Set when Secondary group audio control packet is detected. Write '1' to clear.	ROCW	0
		CTRA_DET	4	Set when Primary group audio control packet is detected. Write '1' to clear.	ROCW	0
		ACS_DET3_4B	3	Secondary group audio status detected for channels 3 and 4. Write '1' to clear.	ROCW	0
		ACS_DET1_2B	2	Secondary group audio status detected for channels 1 and 2. Write '1' to clear.	ROCW	0
		ACS_DET3_4A	1	Primary group audio status detected for channels 3 and 4. Write '1' to clear.	ROCW	0
		ACS_DET1_2A	0	Primary group audio status detected for channels 1 and 2. Write '1' to clear.	ROCW	0
402h	REGEN	RSVD	15-2	Reserved.	R/W	0
		ACS_APPLY	1	Cause channel status data in ACSR[183:0] to be transferred to the channel status replacement mechanism. The transfer does not occur until the next status boundary.	R/W	0
		ACS_REGEN	0	Specifies that Audio Channel Status of all channels should be replaced with ACSR[183:0] field. 0: Do not replace Channel Status 1: Replace Channel Status of all channels	R/W	0

Table 4-29: SD Audio Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Defaul
403h	AUD_DET	IDB_READBACK	15-14	Actual value of IDB in the hardware.	R	1
		IDA_READBACK	13-12	Actual value of IDA in the hardware.	R	0
		XDPG4_DET	11	Set while embedded Group 4 audio extended packets are detected.	R	0
		XDPG3_DET	10	Set while embedded Group 3 audio extended packets are detected.	R	0
		XDPG2_DET	9	Set while embedded Group 2 audio extended packets are detected.	R	0
		XDPG1_DET	8	Set while embedded Group 1 audio extended packets are detected.	R	0
		ADPG4_DET	7	Set while Group 4 audio data packets are detected.	R	0
		ADPG3_DET	6	Set while Group 3 audio data packets are detected.	R	0
		ADPG2_DET	5	Set while Group 2 audio data packets are detected.	R	0
		ADPG1_DET	4	Set while Group 1 audio data packets are detected.	R	0
		ACS_APPLY_WAITD	3	Set while output channels 7 and 8 are waiting for a status boundary to apply the ACSR[183:0] data.	R	0
		ACS_APPLY_WAITC	2	Set while output channels 5 and 6 are waiting for a status boundary to apply the ACSR[183:0] data.	R	0
		ACS_APPLY_WAITB	1	Set while output channels 3 and 4 are waiting for a status boundary to apply the ACSR[183:0] data.	R	0
		ACS_APPLY_WAITA	0	Set while output channels 1 and 2 are waiting for a status boundary to apply the ACSR[183:0] data.	R	0
404h	CSUM_ERR_DET	RSVD	15-1	Reserved.	R/W	0
		CSUM_ERROR	0	Embedded packet checksum error detected. Write '1' to clear.	ROCW	0
405h	CH_MUTE	RSVD	15-8	Reserved.	R/W	0
		MUTE	7-0	Mute output channels 81 Where bits 7:0 = channel 8:1 1: Mute 0: Normal	R/W	0



Table 4-29: SD Audio Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Defaul
406h	CH_VALID	RSVD	15-8	Reserved.	R/W	0
		CH4_VALIDB	7	Secondary group channel 4 sample validity flag.	R	0
	,	CH3_VALIDB	6	Secondary group channel 3 sample validity flag.	R	0
		CH2_VALIDB	5	Secondary group channel 2 sample validity flag.	R	0
		CH1_VALIDB	4	Secondary group channel 1 sample validity flag.	R	0
		CH4_VALIDA	3	Primary group channel 4 sample validity flag.	R	0
		CH3_VALIDA	2	Primary group channel 3 sample validity flag.	R	0
		CH2_VALIDA	1	Primary group channel 2 sample validity flag.	R	0
		CH1_VALIDA	0	Primary group channel 1 sample validity flag.	R	0
407h	SD_AUDIO_ERR	RSVD	15	Reserved.	R/W	0
	OR_MASK	EN_NOT_LOCKED	14	Asserts <i>interrupt</i> when LOCKED signal is not asserted.	R/W	0
		EN_NO_VIDEO	13	Asserts <i>interrupt</i> when video format is unknown.	R/W	0
		EN_CSUM_ERROR	12	Asserts <i>interrupt</i> when checksum error is detected.	R/W	0
		EN_ACS_DET3_4B	11	Asserts <i>interrupt</i> when EN_ACS_DET3_4B flag is set.	R/W	0
		EN_ACS_DET1_2B	10	Asserts <i>interrupt</i> when EN_ACS_DET1_2B flag is set.	R/W	0
		EN_ACS_DET3_4A	9	Asserts <i>interrupt</i> when EN_ACS_DET3_4A flag is set.	R/W	0
		EN_ACS_DET1_2A	8	Asserts <i>interrupt</i> when EN_ACS_DET1_2A flag is set.	R/W	0
		EN_CTRB_DET	7	Asserts <i>interrupt</i> when EN_CTRB_DET flag is set.	R/W	0
		EN_CTRA_DET	6	Asserts <i>interrupt</i> when EN_CTRA_DET flag is set.	R/W	0
		EN_DBNB_ERR	5	Asserts <i>interrupt</i> when EN_DBNB_ERR flag is set.	R/W	0
		EN_DBNA_ERR	4	Asserts <i>interrupt</i> when EN_DBNA_ERR flag is set.	R/W	0



Table 4-29: SD Audio Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Default
407h	SD_AUDIO_ERR OR_MASK	EN_ADPG4_DET	3	Asserts <i>interrupt</i> when the ADPG4_DET flag is set.	R/W	0
		EN_ADPG3_DET	2	Asserts <i>interrupt</i> when the ADPG3_DET flag is set.	R/W	0
		EN_ADPG2_DET	1	Asserts <i>interrupt</i> when the ADPG2_DET flag is set.	R/W	0
		EN_ADPG1_DET	0	Asserts <i>interrupt</i> when the ADPG1_DET flag is set.	R/W	0
408h	CFG_OUTPUT	ASWLD	15-14	Output channels 7 and 8 word length. 00: 24 bits 01: 20 bits 10: 16 bits 11: Automatic 20-bit or 24-bit	R/W	3
		ASWLC	13-12	Output channels 5 and 6 word length. (See above for decoding)	R/W	3
		ASWLB	11-10	Output channels 3 and 4 word length. (See above for decoding)	R/W	3
		ASWLA	9-8	Output channels 1 and 2 word length. (See above for decoding)	R/W	3
		AMD	7-6	Output channels 7 and 8 format selector. 00: AES/EBU audio output 01: Serial audio output: Left justified; MSB first 10: Serial audio output: Right justified; MSB first	R/W	3
		AMC	5-4	Output channels 5 and 6 format selector. (See above for decoding).	R/W	3
		AMB	3-2	Output channels 3 and 4 format selector. (See above for decoding).	R/W	3
		AMA	1-0	Output channels 1 and 2 format selector. (See above for decoding).	R/W	3

Table 4-29: SD Audio Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Default
409h	OUTPUT_SEL_1	RSVD	15-12	Reserved.	R/W	0
		OP4_SRC	11-9	Output channel 4 source selector. 000: Primary audio group channel 1 001: Primary audio group channel 2 010: Primary audio group channel 3 011: Primary audio group channel 4 100: Secondary audio group channel 1 101: Secondary audio group channel 2 110: Secondary audio group channel 3 111: Secondary audio group channel 3 111: Secondary audio group channel 4	R/W	3
		OP3_SRC	8-6	Output channel 3 source selector (Decode as above).	R/W	2
		OP2_SRC	5-3	Output channel 2 source selector (Decode as above).	R/W	1
		OP1_SRC	2-0	Output channel 1 source selector (Decode as above).	R/W	0
40Ah	OUTPUT_SEL_2	RSVD	15-12	Reserved.	R/W	0
		OP8_SRC	11-9	Output channel 8 source selector. 000: Primary audio group channel 1 001: Primary audio group channel 2 010: Primary audio group channel 3 011: Primary audio group channel 4 100: Secondary audio group channel 1 101: Secondary audio group channel 2 110: Secondary audio group channel 3 111: Secondary audio group channel 3 111: Secondary audio group channel 4	R/W	7
		OP7_SRC	8-6	Output channel 7 source selector (Decode as above).	R/W	6
		OP6_SRC	5-3	Output channel 6 source selector (Decode as above).	R/W	5
		OP5_SRC	2-0	Output channel 5 source selector (Decode as above).	R/W	4
40Bh - 41Fh	RSVD	RSVD	-	Reserved.	_	_

Table 4-29: SD Audio Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Default
420h	AFNA12	RSVD	15-9	Reserved.	R/W	0
		AFN1_2A	8-0	Primary group audio frame number for channels 1 and 2.	R	0
421h	AFNA34	RSVD	15-9	Reserved.	R/W	0
		AFN3_4A	8-0	Primary group audio frame number for channels 3 and 4.	R/W R R/W R R/W R R R R R R R R R/W R R R/W R R R/W R R R/W R R/W R R R/W R R R/W	0
422h	RATEA	RSVD	15-8	Reserved.	R/W	0
		RATE3_4A	7-5	Primary group sampling frequency for channels 3 and 4	R	0
		ASX3_4A	4	Primary group asynchronous mode for channels 3 and 4.	R	0
		RATE1_2A	3-1	Primary group sampling frequency for channels 1 and 2.	R	0
		ASX1_2A	0	Primary group asynchronous mode for channels 1 and 2.	R	0
423h	ACT_A	RSVD	15-4	Reserved.	R/W	0
		ACTA	3-0	Primary group active channels.	R	0
424h	PRIM_AUD_ DELAY_1	RSVD	15-9	Reserved.	R/W	0
	DELAT_I	DEL1A_1	8-1	Primary Audio group delay data for channel 1.	R	0
		EBIT1A	0	Primary Audio group delay data valid flag for channel 1.	R	0
425h	PRIM_AUD_	RSVD	15-9	Reserved.	R/W	0
	DELAY_2	DEL1A_2	8-0	Primary Audio group delay data for channel 1.	R R/W R R/W R R R R R R R R/W R	0
426h	PRIM_AUD_	RSVD	15-9	Reserved.	R/W	0
	DELAY_3	DEL1A_3	8-0	Primary Audio group delay data for channel 1.	R	0
427h	PRIM_AUD_	RSVD	15-9	Reserved.	R/W	0
	DELAY_4	DEL2A_4	8-1	Primary Audio group delay data for channel 2.	R	0
		EBIT2A	0	Primary Audio group delay data valid flag for channel 2.	R	0
428h	PRIM_AUD_	RSVD	15-9	Reserved.	R/W	0
	DELAY_5	DEL2A_5	8-0	Primary Audio group delay data for channel 2.	R	0
429h	PRIM_AUD_	RSVD	15-9	Reserved.	R/W	0
	DELAY_6	DEL2A_6	8-0	Primary Audio group delay data for channel 2.	R	0

Table 4-29: SD Audio Core Configuration and Status Registers (Continued)

42Ah	15-9 8-1 0 15-9 8-0 15-9 8-0	Reserved. Primary Audio group delay data for channel 3. Primary Audio group delay data valid flag for channel 3. Reserved. Primary Audio group delay data for channel 3. Reserved. Primary Audio group delay data for channel 3. Reserved. Primary Audio group delay data for channel 3.	R/W R R R/W R R/W R R/W	0 0 0 0 0
DEL3A_7 EBIT3A 42Bh PRIM_AUD_ RSVD DEL3A_8 42Ch PRIM_AUD_ RSVD DELAY_9	0 15-9 8-0 15-9 8-0	for channel 3. Primary Audio group delay data valid flag for channel 3. Reserved. Primary Audio group delay data for channel 3. Reserved. Primary Audio group delay data for channel 3.	R R/W R R/W R	0 0 0
42Bh PRIM_AUD_ RSVD DELAY_8 DEL3A_8 42Ch PRIM_AUD_ RSVD DELAY_9	15-9 8-0 15-9 8-0	valid flag for channel 3. Reserved. Primary Audio group delay data for channel 3. Reserved. Primary Audio group delay data for channel 3.	R/W R R/W R	0 0
DELAY_8 DEL3A_8 42Ch PRIM_AUD_ DELAY_9 RSVD	8-0 15-9 8-0 15-9	Primary Audio group delay data for channel 3. Reserved. Primary Audio group delay data for channel 3.	R R/W R	0
42Ch PRIM_AUD_ RSVD DELAY_9	15-9 8-0 15-9	for channel 3. Reserved. Primary Audio group delay data for channel 3.	R/W R	0
DELAY_9 ————	8-0	Primary Audio group delay data for channel 3.	R	
	15-9	for channel 3.		0
		Reserved.	R/W	
42Dh PRIM_AUD_ RSVD	8-1		R	0
DELAY_10 DEL4A_10		Primary Audio group delay data for channel 4.	R	0
EBIT4A	0	Primary Audio group delay data valid flag for channel 4.	R	0
42Eh PRIM_AUD_ RSVD	15-9	Reserved.	R/W	0
DELAY_11 DEL4A_11	8-0	Primary Audio group delay data for channel 4.	R	0
42Fh PRIM_AUD_ RSVD	15-9	Reserved.	R/W	0
DELAY_12 DEL4A_12	8-0	Primary Audio group delay data for channel 4.	R/W R R/W	0
430h AFNB12 RSVD	15-9	Reserved.	R/W	0
AFN1_2B	8-0	Secondary group audio frame number for channels 1 and 2.	R R/W R R/W R R/W R R/W R R/W R	0
431h AFNB34 RSVD	15-9	Reserved.	R/W	0
AFN3_4B	8-0	Secondary group audio frame number for channels 3 and 4.	R	0
432h RATEB RSVD	15-8	Reserved.	R	0
RATE3_4B		Secondary group sampling frequency for channels 3 and 4.	R	0
ASX3_4B	4	Secondary group asynchronous mode for channels 3 and 4.	R	0
RATE1_2B	3-1	Secondary group sampling frequency for channels 1 and 2.	R	0
ASX1_2B	0	Secondary group asynchronous mode for channels 1 and 2.	R	0
433h ACT_B RSVD	15-4	Reserved.	R/W	0
АСТВ	3-0	Secondary group active channels.	R	0



Table 4-29: SD Audio Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Defaul
434h	SEC_AUD_	RSVD	15-9	Reserved.	R/W	0
	DELAY_!	DEL1B_1	8-1	Secondary Audio group delay data for channel 1.	R	0
		EBIT1B	0	Secondary Audio group delay data valid flag for channel 1.	R	0
435h	SEC_AUD	RSVD	15-9	Reserved.	R/W	
	DELAY_2	DEL1B_2	8-0	Secondary Audio group delay data for channel 1.		0
436h	SEC_AUD_	RSVD	15-9	Reserved.	R/W	0
	DELAY_3	DEL1B_3	8-0	Secondary Audio group delay data for channel 1.	R R R/W R R/W R R/W R R R/W R R R/W R R/W R R R/W R R/W	0
437h	SEC_AUD	RSVD	15-9	Reserved.	R/W	0
	DELAY_4	DEL2B_4	8-1	Secondary Audio group delay data for channel 2.	R	0
		EBIT2B	0	Secondary Audio group delay data valid flag for channel 2.		0
438h	SEC_AUD	RSVD	15-9	Reserved.	R/W	0
	DELAY_5	DEL2B_5	8-0	Secondary Audio group delay data for channel 2.	R	0
439h	SEC_AUD	RSVD	15-9	Reserved.	R/W R R R/W R R/W R R/W R R/W	0
	DELAY_6	DEL2B_6	8-0	Secondary Audio group delay data for channel 2.		0
43Ah	SEC_AUD	RSVD	15-9	Reserved.	R/W	0
	DELAY_7	DEL3B_7	8-1	Secondary Audio group delay data for channel 3.	R	0
		EBIT3B	0	Secondary Audio group delay data valid flag for channel 3.	R	0
43Bh	SEC_AUD	RSVD	15-9	Reserved.	R/W	0
	DELAY_8	DEL3B_8	8-0	Secondary Audio group delay data for channel 3.	R	0
43Ch	SEC_AUD	RSVD	15-9	Reserved.	R/W	0
	DELAY_9	DEL3B_9	8-0	Secondary Audio group delay data for channel 3.	R	0
43Dh	SEC_AUD	RSVD	15-9	Reserved.	R/W	0
	DELAY_10	DEL4B_10	8-1	Secondary Audio group delay data for channel 4.	R	0
		EBIT4B	0	Secondary Audio group delay data valid flag for channel 4.	R	0



Table 4-29: SD Audio Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Default
43Eh	SEC_AUD_	RSVD	15-9	Reserved.	R/W	0
	DELAY_11	DEL4B_11	8-0	Secondary Audio group delay data for channel 4.	R	0
43Fh	SEC_AUD_	RSVD	15-9	Reserved.	R/W	0
	DELAY_12	DEL4B_12	8-0	Secondary Audio group delay data for channel 4.	R	0
440h	ACSR1_2A_BYTE 0_1	ACSR1_2A_0	15-0	Bytes 0 [7:0] and 1 [15:8] of audio group A channel status for channels 1 and 2	R	0
441h	ACSR1_2A_BYTE 2_3	ACSR1_2A_2	15-0	Bytes 2 [7:0] and 3 [15:8] of audio group A channel status for channels 1 and 2	R	0
442h	ACSR1_2A_BYTE 4_5	ACSR1_2A_4	15-0	Bytes 4 [7:0] and 5 [15:8] of audio group A channel status for channels 1 and 2	R	0
443h	ACSR1_2A_BYTE 6_7	ACSR1_2A_6	15-0	Bytes 6 [7:0] and 7 [15:8] of audio group A channel status for channels 1 and 2	R	0
444h	ACSR1_2A_BYTE 8_9	ACSR1_2A_8	15-0	Bytes 8 [7:0] and 9 [15:8] of audio group A channel status for channels 1 and 2.	R	0
445H	ACSR1_2A_BYTE 10_11	ACSR1_2A_10	15-0	Bytes 10 [7:0] and 11 [15:8] of audio group A channel status for channels 1 and 2.	R	0
446H	ACSR1_2A_BYTE 12_13	ACSR1_2A_12	15-0	Bytes 12 [7:0] and 13 [15:8] of audio group A channel status for channels 1 and 2.	R	0
447h	ACSR1_2A_BYTE 14_15	ACSR1_2A_14	15-0	Bytes 14 [7:0] and 15 [15:8] of audio group A channel status for channels 1 and 2.	R	0
448h	ACSR1_2A_BYTE 16_17	ACSR1_2A_16	15-0	Bytes 16 [7:0] and 17 [15:8] of audio group A channel status for channels 1 and 2.	R	0
449h	ACSR1_2A_BYTE 18_19	ACSR1_2A_18	15-0	Bytes 18 [7:0] and 19 [15:8] of audio group A channel status for channels 1 and 2.	R	0
44Ah	ACSR1_2A_BYTE 20_21	ACSR1_2A_20	15-0	Bytes 20 [7:0] and 21 [15:8] of audio group A channel status for channels 1 and 2.	R	0
44Bh	ACRS1_2A_ BYTE22	ACSR1_2A_22	15-0	Bytes 22 of audio group A channel status for channels 1 and 2.	R	0
450h	ACSR3_4A BYTE0_1	ACSR3_4A_0	15-0	Bytes 0 [7:0] and 1 [15:8] of audio group A channel status for channels 3 and 4.	R	0
451h	ACSR3_4A BYTE2_3	ACSR3_4A_2	15-0	Bytes 2 [7:0] and 3 [15:8] of audio group A channel status for channels 3 and 4.	R	0



Table 4-29: SD Audio Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Defaul
452h	ACSR3_4A_BYTE 4_5	ACSR3_4A_4	15-0	Bytes 4 [7:0] and 5 [15:8] of audio group A channel status for channels 3 and 4.	R	0
453h	ACSR3_4A_BYTE 6_7	ACSR3_4A_6	15-0	Bytes 6 [7:0] and 7 [15:8] of audio group A channel status for channels 3 and 4.	R	0
454h	ACSR3_4A_BYTE 8_9	ACSR3_4A_8	15-0	Bytes 8 [7:0] and 9 [15:8] of audio group A channel status for channels 3 and 4.	R	0
455h	ACSR3_4A_BYTE 10_11	ACSR3_4A_10	15-0	Bytes 10 [7:0] and 11 [15:8] of audio group A channel status for channels 3 and 4.	R	0
456h	ACSR3_4A_BYTE 12_13	ACSR3_4A_12	15-0	Bytes 12 [7:0] and 13 [15:8] of audio group A channel status for channels 3 and 4.	R	0
457h	ACSR3_4A_BYTE 14_15	ACSR3_4A_14	15-0	Bytes 14 [7:0] and 15 [15:8] of audio group A channel status for channels 3 and 4.	R	0
458h	ACSR3_4A_BYTE 16_17	ACSR3_4A_16	15-0	Bytes 16 [7:0] and 17 [15:8] of audio group A channel status for channels 3 and 4.	R	0
459h	ACSR3_4A_BYTE 18_19	ACSR3_4A_18	15-0	Bytes 18 [7:0] and 19 [15:8] of audio group A channel status for channels 3 and 4.	R	0
45Ah	ACSR3_4A_BYTE 20_21	ACSR3_4A_20	15-0	Bytes 20 [7:0] and 21 [15:8] of audio group A channel status for channels 3 and 4.	R	0
45Bh	ACSR3_4A_BYTE	RSVD	15-8	Reserved.	R/W	0
	22	ACSR3_4A_22	7-0	Bytes 22 of audio group A channel status for channels 3 and 4.	R	0
460h	ACSR1_2B_BYTE 0_1	ACSR1_2B_0	15-0	Bytes 0 [7:0] and 1 [15:8] of audio group B channel status for channels 1 and 2.	R	0
461h	ACSR1_2B_BYTE 2_3	ACSR1_2B_2	15-0	Bytes 2 [7:0] and 3 [15:8] of audio group B channel status for channels 1 and 2.	R	0
462h	ACSR1_2B_BYTE 4_5	ACSR1_2B_4	15-0	Bytes 4 [7:0] and 5 [15:8] of audio group B channel status for channels 1 and 2.	R	0
463h	ACSR1_2B_BYTE 6_7	ACSR1_2B_6	15-0	Bytes 6 [7:0] and 7 [15:8] of audio group B channel status for channels 1 and 2.	R	0
464h	ACSR1_2B_BYTE 8_9	ACSR1_2B_8	15-0	Bytes 8 [7:0] and 9 [15:8] of audio group B channel status for channels 1 and 2.	R	0
465h	ACSR1_2B_BYTE 10_11	ACSR1_2B_10	15-0	Bytes 10 [7:0] and 11 [15:8] of audio group B channel status for channels 1 and 2.	R	0



Table 4-29: SD Audio Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Default
466h	ACSR1_2B_BYTE 12_13	ACSR1_2B_12	15-0	Bytes 12 [7:0] and 13 [15:8] of audio group B channel status for channels 1 and 2.	R	0
467h	ACSR1_2B_BYTE 14_15	ACSR1_2B_14	15-0	Bytes 14 [7:0] and 15 [15:8] of audio group B channel status for channels 1 and 2.	R	0
468h	ACSR1_2B_BYTE 16_17	ACSR1_2B_16	15-0	Bytes 16 [7:0] and 17 [15:8] of audio group B channel status for channels 1 and 2.	R	0
469h	ACSR1_2B_BYTE 18_19	ACSR1_2B_18	15-0	Bytes 18 [7:0] and 19 [15:8] of audio group B channel status for channels 1 and 2.	R	0
46Ah	ACSR1_2B_BYTE 20_21	ACSR1_2B_20	15-0	Bytes 20 [7:0] and 21 [15:8] of audio group B channel status for channels 1 and 2.	R	0
46Bh	ACSR1_2B_BYTE	RSVD	15-8	Reserved.	R/W	0
	22	ACSR1_2B_22	7-0	Bytes 22 of audio group B channel status for channels 1 and 2.	R	0
470h	ACSR3_4B_BYTE 0_1	ACSR3_4B_0	15-0	Bytes 0 [7:0] and 1 [15:8] of audio group B channel status for channels 3 and 4.	R	0
471h	ACSR3_4B_BYTE 2_3	ACSR3_4B_2	15-0	Bytes 2 [7:0] and 3 [15:8] of audio group B channel status for channels 3 and 4.	R	0
472h	ACSR3_4B_BYTE 4_5	ACSR3_4B_4	15-0	Bytes 4 [7:0] and 5 [15:8] of audio group B channel status for channels 3 and 4.	R	0
473h	ACSR3_4B_BYTE 6_7	ACSR3_4B_6	15-0	Bytes 6 [7:0] and 7 [15:8] of audio group B channel status for channels 3 and 4.	R	0
474h	ACSR3_4B_BYTE 8_9	ACSR3_4B_8	15-0	Bytes 8 [7:0] and 9 [15:8] of audio group B channel status for channels 3 and 4.	R	0
475h	ACSR3_4B_BYTE 10_11	ACSR3_4B_10	15-0	Bytes 10 [7:0] and 11 [15:8] of audio group B channel status for channels 3 and 4.	R	0
476h	ACSR3_4B_BYTE 12_13	ACSR3_4B_12	15-0	Bytes 12 [7:0] and 13 [15:8] of audio group B channel status for channels 3 and 4.	R	0
477h	ACSR3_4B_BYTE 14_15	ACSR3_4B_14	15-0	Bytes 14 [7:0] and 15 [15:8] of audio group B channel status for channels 3 and 4.	R	0
478h	ACSR3_4A_BYTE 16_17	ACSR3_4B_16	15-0	Bytes 16 [7:0] and 17 [15:8] of audio group B channel status for channels 3 and 4.	R	0
479h	ACSR3_4A_BYTE 18_19	ACSR3_4B_18	15-0	Bytes 18 [7:0] and 19 [15:8] of audio group B channel status for channels 3 and 4.	R	0



Table 4-29: SD Audio Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Default
47Ah	ACSR3_4A_BYTE 20_21	ACSR3_4B_20	15-0	Bytes 20 [7:0] and 21 [15:8] of audio group B channel status for channels 3 and 4.	R	0
47Bh	ACSR3_4A_BYTE 22	ACSR3_4B_22	15-0	Bytes 22 of audio group B channel status for channels 3 and 4.	R	0
480h	ACSR_BYTE_0	ACSR_BYTE0	7-0	Audio channel status to use when ACS_REGEN is set or when adding audio channel status to non-AES/EBU audio. 8 bits per register for 23 registers.	R	0
481h	ACSR_BYTE_1	ACSR_BYTE1	7-0	-	W	0
482h	ACSR_BYTE_2	ACSR_BYTE2	7-0	-	W	0
483h	ACSR_BYTE_3	ACSR_BYTE3	7-0	-	W	0
484h	ACSR_BYTE_4	ACSR_BYTE4	7-0	-	W	0
485h	ACSR_BYTE_5	ACSR_BYTE5	7-0	-	W	0
486h	ACSR_BYTE_6	ACSR_BYTE6	7-0	-	W	0
487h	ACSR_BYTE_7	ACSR_BYTE7	7-0	-	W	0
488h	ACSR_BYTE_8	ACSR_BYTE8	7-0	-	W	0
489h	ACSR_BYTE_9	ACSR_BYTE9	7-0	-	W	0
48Ah	ACSR_BYTE_10	ACSR_BYTE10	7-0	-	W	0
48Bh	ACSR_BYTE_11	ACSR_BYTE11	7-0	-	W	0
48Ch	ACSR_BYTE_12	ACSR_BYTE12	7-0	_	W	0
48Dh	ACSR_BYTE_13	ACSR_BYTE13	7-0	-	W	0
48Eh	ACSR_BYTE_14	ACSR_BYTE14	7-0	_	W	0
48Fh	ACSR_BYTE_15	ACSR_BYTE15	7-0	-	W	0
490h	ACSR_BYTE_16	ACSR_BYTE16	7-0	_	W	0
491h	ACSR_BYTE_17	ACSR_BYTE17	7-0	_	W	0
492h	ACSR_BYTE_18	ACSR_BYTE18	7-0	-	W	0
493h	ACSR_BYTE_19	ACSR_BYTE19	7-0	-	W	0
494h	ACSR_BYTE_20	ACSR_BYTE20	7-0	-	R/W	0
495h	ACSR_BYTE_21	ACSR_BYTE21	7-0	-	R/W	0
496h	ACSR_BYTE_22	ACSR_BYTE22	7-0	-	R/W	0



4.20.3 HD Audio Core Registers

NOTE: The GS1670A only accepts write/read commands to/from the HD Audio Register Map when the audio core is locked to the incoming HD or video format.

Table 4-30: HD Audio Core Configuration and Status Registers

Address	Register Name	Bit Name	Bit	Description	R/W	Default
200h	CFG_AUD	ECC_OFF	15	Disables ECC error correction.	R/W	0
		ALL_DEL	14	Selects deletion of all audio data and all audio control packets	R/W	0
				O: Do not delete existing audio control packets Delete existing audio control packets.		
		MUTE_ALL	13	Mute all output channels 0: Normal 1: Muted	R/W	0
		ACS_USE_SECOND	12	Extract Audio Channel Status from second channel pair.	R/W	0
		ASWLB	11-10	Secondary group output word length.	R/W	3
		00: 24 bits 01: 20 bits 10: 16 bits 11: invalid	01: 20 bits 10: 16 bits			
		ASWLA	9-8	Primary group output word length.	R/W	3
				00: 24 bits 01: 20 bits 10: 16 bits 11: invalid		
		AMB	7-6	Secondary group output format selector.	R/W	3
				00: AES/EBU audio output 01: Serial audio output: left justified MSB first 10: Serial audio output: right justified. MSB first 11: I2S serial audio output		
		AMA	5-4	Primary group output format selector.	R/W	3
				00: AES/EBU audio output 01: Serial audio output: left justified MSB first 10: Serial audio output: right justified MSB first 11: I2S serial audio output		

Table 4-30: HD Audio Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Default
200h	CFG_AUD	IDB	3-2	Specifies the Secondary audio group to extract. 00: Audio group #1 01: Audio group #2 10: Audio group #3 11: Audio group #4 NOTE: Should IDA and IDB be set to the same value, they automatically revert to their default values.	R/W	1
		IDA	1-0	Specifies the Primary audio group to extract. 00: Audio group #1 01: Audio group #2 10: Audio group #3 11: Audio group #4 NOTE: Should IDA and IDB be set to the same value, they automatically revert to their default values.	R/W	0
201h	ACS_DET	RSVD	15-8	Reserved.	R/W	0
		DBNB_ERR	7	Set when Secondary group audio Data Block Number sequence is discontinuous.	ROCW	0
		DBNA_ERR	6	Set when Primary group audio Data Block Number sequence is discontinuous.	ROCW	0
		CTRB_DET	5	Set when Secondary group audio control packet is detected.	ROCW	0
		CTRA_DET	4	Set when Primary group audio control packet is detected.	ROCW	0
		ACS_DET3_4B	3	Secondary group audio status detected for channels 3 and 4.	ROCW	0
		ACS_DET1_2B	2	Secondary group audio status detected for channels 1 and 2.	ROCW	0
		ACS_DET3_4A	1	Primary group audio status detected for channels 3 and 4.	ROCW	0
		ACS_DET1_2A	0	Primary group audio status detected for channels 1 and 2.	ROCW	0

Table 4-30: HD Audio Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Defaul
202h	AUD_DET1	RSVD	15-9	Reserved.	R	0
		IDB_READBACK	8-7	Actual value of IDB in the hardware.	R	1
		IDA_READBACK	6-5	Actual value of IDA in the hardware.	R	0
		ADPG4_DET	4	Set while Group 4 audio data packets are detected.	R	0
		ADPG3_DET	3	Set while Group 3 audio data packets are detected.	R	0
		ADPG2_DET	2	Set while Group 2 audio data packets are detected.	R	0
		ADPG1_DET	1	Set while Group 1 audio data packets are detected.	R	0
		ACS_APPLY_WAIT	0	ACS_APPLY_WAIT: Set while output channels 1 and 2 are waiting for a status boundary to apply the ACSR[183:0] data.	R	0
203h	AUD_DET2	RSVD	15-2	Reserved.	R/W	0
		ECCA_ERROR	1	Primary group audio data packet error detected.	ROCW	0
		ECCB_ERROR	0	Secondary group audio data packet error detected.	ROCW	0
204h	REGEN	RSVD	15-2	Reserved.	R/W	0
		ACS_APPLY	1	Cause channel status data in ACSR[183:0] to be transferred to the channel status replacement mechanism. The transfer does not occur until the next status boundary.	R/W	0
		ACS_REGEN	0	Specifies that Audio Channel Status of all channels should be replaced with ACSR[183:0] field.	R/W	0
				0: Do not replace Channel Status 1: Replace Channel Status of all channels		
205h	CH_MUTE	RSVD	15	Reserved.	R/W	0
		MUTEB	7-4	Mute Secondary output channels 41 Where bits 7:4 = channel 4:1	R/W	0
				1: Mute 0: Normal		
		MUTEA	3-0	Mute Primary output channels 41 Where bits 3:0 = channel 4:1	R/W	0
				1: Mute 0: Normal		

Table 4-30: HD Audio Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Default
206h	CH_VALID	RSVD	15-8	Reserved.	R/W	0
		CH4_VALIDB	7	Secondary group channel 4 sample validity flag.	R	0
		CH3_VALIDB	6	Secondary group channel 3 sample validity flag.	R	0
		CH2_VALIDB	5	Secondary group channel 2 sample validity flag.	R	0
		CH1_VALIDB	4	Secondary group channel 1 sample validity flag.	R	0
		CH4_VALIDA	3	Primary group channel 4 sample validity flag.	R	0
		CH3_VALIDA	2	Primary group channel 3 sample validity flag.	R	0
		CH2_VALIDA	1	Primary group channel 2 sample validity flag.	R	0
		CH1_VALIDA	0	Primary group channel 1 sample validity flag.	R	0



Table 4-30: HD Audio Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Default
207h	HD_AUDIO_ERR OR_MASK	RSVD	15	Reserved.	R/W	0
		EN_MISSING_PHASE	14	Asserts AUDIO_ERROR interrupt when chosen group's phase data is missing	R/W	0
		EN_ACS_DET3_4B	13	Asserts AUDIO_ERROR when ACS_DET3_4B flag is set.	R/W	0
		EN_ACS_DET1_2B	12	Asserts AUDIO_ERROR when ACS_DET1_2B flag is set.	R/W	0
		EN_ACS_DET3_4A	11	Asserts AUDIO_ERROR when ACS_DET3_4A flag is set.	R/W	0
		EN_ACS_DET1_2A	10	Asserts AUDIO_ERROR when ACS_DET1_2A flag is set.	R/W	0
		EN_CTRB_DET	9	Asserts AUDIO_ERROR when CTRB_DET flag is set.	R/W	0
		EN_CTRA_DET	8	Asserts AUDIO_ERROR when CTRA_DET flag is set.	R/W	0
		EN_DBNB_ERR	7	Asserts AUDIO_ERROR when DBNB_ERR flag is set.	R/W	0
		EN_DBNA_ERR	6	Asserts AUDIO_ERROR when DBNA_ERR flag is set.	R/W	0
		EN_ECCB_ERR	5	Asserts AUDIO_ERROR when ECCB_ERR flag is set.	R/W	0
		EN_ECCA_ERR	4	Asserts AUDIO_ERROR when ECCA_ERR flag is set.	R/W	0
		EN_ADPG4_DET	3	Asserts AUDIO_ERROR when ADPG4_DET flag is set.	R/W	0
		EN_ADPG3_DET	2	Asserts AUDIO_ERROR when ADPG3_DET flag is set.	R/W	0
		EN_ADPG2_DET	1	Asserts AUDIO_ERROR when ADPG2_DET flag is set.	R/W	0
		EN_ADPG1_DET	0	Asserts AUDIO_ERROR when ADPG1_DET flag is set.	R/W	0

Table 4-30: HD Audio Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Defau
208h	CFG_AUD_2	RSVD	15-11	Reserved.	R/W	0
		SEL_PHASE_SRC	10	Selects between the Primary and Secondary embedded phase info.	R/W	0
		LSB_FIRSTB	9	Causes the Secondary group serial output formats to use LSB first.	R/W	0
		LSB_FIRSTA	8	Causes the Primary group serial output formats to use LSB first.	R/W	0
		FORCE_M	7	Disables M value detection and forces M value to that specified by FORCE_MEQ1001.	R/W	0
		FORCE_MEQ1001	6	Specifies M value when FORCE_M is set.	R/W	0
				1: M= 1.001 0: M = 1.000		
		IGNORE_PHASE	5	Causes the Demultiplexer to ignore the embedded clock info in both the Primary and Secondary group audio data packets. Clock is generated based on the video format and M value.	R/W	0
		FORCE_ACLK128	4	Causes the core to ignore embedded clock info and derive phase information from ACLK128.	R/W	0
		EN_NOT_LOCKED	3	Asserts AUDIO_ERROR when locked is not asserted.	R/W	0
		EN_NO_VIDEO	2	Asserts AUDIO_ERROR when the video format is unknown.	R/W	0
		EN_NO_PHASEB	1	Asserts AUDIO_ERROR when NO_PHASEB_DATA is set.	R/W	0
		EN_NO_PHASEA	0	Asserts AUDIO_ERROR when NO_PHASEA_DATA is set.	R/W	0
OTE: With	these bits enabled,	a change status will cause A	UDIO_ERROF	to assert, DATA_ERROR will assert each	time AUD	OIO_ERRO
209h	CFG_AUD_3	RSVD	15-3	Reserved.	R/W	0
		MISSING_PHASE	2	Embedded phase info for chosen group missing or incorrect.	R	0
		NO_PHASEB_DATA	1	Secondary group has invalid embedded clock information.	R	0
		NO_PHASEA_DATA	0	Primary group has invalid embedded clock information.	R	0

Table 4-30: HD Audio Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Defaul
20Ah	OUTPUT_SEL_1	RSVD	15-12	Reserved.	R	0
		OP4_SRC	11-9	Output channel 4 source selector. 000: Primary audio group channel 1 001: Primary audio group channel 2 010: Primary audio group channel 3 011: Primary audio group channel 4 100: Secondary audio group channel 1 101: Secondary audio group channel 2 110: Secondary audio group channel 3 111: Secondary audio group channel 4	R/W	3
		OP3_SRC	8-6	Output channel 3 source selector (Decode as above).	R/W	2
		OP2_SRC	5-3	Output channel 2 source selector (Decode as above).	R/W	1
		OP1_SRC	2-0	Output channel 1 source selector (Decode as above).	R/W	0
20Bh	OUTPUT_SEL_2	RSVD	15-12	Reserved.	R/W	0
		OP8_SRC	11-9	Output channel 8 source selector. 000: Primary audio group channel 1 001: Primary audio group channel 2 010: Primary audio group channel 3 011: Primary audio group channel 4 100: Secondary audio group channel 1 101: Secondary audio group channel 2 110: Secondary audio group channel 3 111: Secondary audio group channel 4	R/W	7
		OP7_SRC	8-6	Output channel 7 source selector (Decode as above).	R/W	6
		OP6_SRC	5-3	Output channel 6 source selector (Decode as above).	R/W	5
		OP5_SRC	2-0	Output channel 5 source selector (Decode as above).	R/W	4
20Ch - 21Fh	RSVD	RSVD	_	Reserved.	-	-
220h	AFNA	RSVD	15-9	Reserved.	R/W	0
		AFNA	8-0	Primary group audio frame number.	R	0

Table 4-30: HD Audio Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Defaul
221h	RATEA	RSVD	15-4	Reserved.	R/W	0
		RATEA	3-1	Primary group sampling frequency for channels 1 and 2.	R	0
		ASXA	0	Primary group asynchronous mode for channels 1 and 2.	R	0
222h	ACTA	RSVD	15-4	Reserved.	R/W	0
		ACTA	3-0	Primary group active channels.	R	0
223h	PRIM_AUD _DELAY_1	RSVD	15-9	Reserved.	R/W	0
	_DELAT_I	DEL1_2A_1	8-1	Primary Audio group delay data for channels 1 and 2 [7:0].	R	0
		EBIT1_2A	0	Primary Audio group delay data valid flag for channels 1 and 2.	R	0
224h	PRIM_AUD	RSVD	15-9	Reserved.	R/W	0
	_DELAY_2	DEL1_2A_2	8-0	Primary Audio group delay data for channels 1 and 2 [16:8].	R	0
225h	PRIM_AUD	RSVD	15-9	Reserved.	R/W	0
	_DELAY_3	DEL1_2A_3	8-0	Primary Audio group delay data for channels 1 and 2 [25:17].	R	0
226h	PRIM_AUD	RSVD	15-9	Reserved.	R/W	0
	_DELAY_4	DEL3_4A_4	8-1	Primary Audio group delay data for channels 3 and 4 [7:0].	R	0
		EBIT3_4A	0	Primary Audio group delay data valid flag for channels 3 and 4.	R	0
227h	PRIM_AUD	RSVD	15-9	Reserved.	R/W	0
	_DELAY_5	DEL3_4A_5	8-0	Primary Audio group delay data for channels 3 and 4 [16:8].	R	0
228h	PRIM_AUD	RSVD	15-9	Reserved.	R/W	0
	_DELAY_6	DEL3_4A_6	8-0	Primary Audio group delay data for channels 3 and 4 [25:17].	R	0
229h - 22Fh	RSVD	RSVD	-	Reserved.	R/W	0
230h	AFNB	RSVD	15-9	Reserved.	R/W	0
		AFNB	8-0	Secondary group audio frame number.	R	0
231h	RATEB	RSVD	15-4	Reserved.	R/W	0
		RATEB	3-1	Secondary group sampling frequency for channels 1 and 2.	R	0
		ASXB	0	Secondary group asynchronous mode for channels 1 and 2.	R	0

Table 4-30: HD Audio Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Default
232h	АСТВ	RSVD	15-4	Reserved.	R/W	0
		АСТВ	3-0	Secondary group active channels.	R	0
233h	SEC_AUD_DELAY	RSVD	15-9	Reserved.	R/W	0
	_1	DEL1_2B_1	8-1	Secondary Audio group delay data valid flag for channels 1 and 2.	R	0
		EBIT1_2B	0	Secondary Audio group delay data for channels 1 and 2 [7:0].	R	0
234h	SEC_AUD_DELAY	RSVD	15-9	Reserved.	R/W	0
	_2	DEL1_2B_2	8-0	Secondary Audio group delay data for channels 1 and 2 [16:8].	R	0
235h	SEC_AUD_DELAY	RSVD	15-9	Reserved.	R/W	0
	_3	DEL1_2B_3	8-0	Secondary Audio group delay data for channels 1 and 2 [25:17].	R	0
236h	SEC_AUD_DELAY	RSVD	15-9	Reserved.	R/W	0
	_4	DEL3_4B_4	8-1	Secondary Audio group delay data for channels 3 and 4 [7:0].	R	0
		EBIT3_4B	0	Secondary Audio group delay data valid flag for channels 3 and 4.	R	0
237h	SEC_AUD_DELAY	RSVD	15-9	Reserved.	R/W	0
	_5	DEL3_4B_5	8-0	Secondary Audio group delay data for channels 3 and 4 [16:8].	R	0
238h	SEC_AUD_DELAY	RSVD	15-9	Reserved.	R/W	0
	_6	DEL3_4B_6	8-0	Secondary Audio group delay data for channels 3 and 4 [25:17].	R	0
239h - 23Fh	RSVD	RSVD	-	Reserved.	R/W	0
240h	ACSR1_2A_BYTE 0_1	ACSR1_2A_0	15-0	Bytes 0 [7:0] and 1 [15:8] of audio group A channel status for channels 1 and 2.	R	0
241h	ACSR1_2A_BYTE 2_3	ACSR1_2A_2	15-0	Bytes 2 [7:0] and 3 [15:8] of audio group A channel status for channels 1 and 2.	R	0
242h	ACSR1_2A_BYTE 4_5	ACSR1_2A_4	15-0	Bytes 4 [7:0] and 5 [15:8] of audio group A channel status for channels 1 and 2.	R	0
243h	ACSR1_2A_BYTE 6_7	ACSR1_2A_6	15-0	Bytes 6 [7:0] and 7 [15:8] of audio group A channel status for channels 1 and 2.	R	0
244h	ACSR1_2A_BYTE 8_9	ACSR1_2A_8	15-0	Bytes 8 [7:0] and 9 [15:8] of audio group A channel status for channels 1 and 2.	R	0

Table 4-30: HD Audio Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Defaul
245h	ACSR1_2A_BYTE 10_11	ACSR1_2A_10	15-0	Bytes 10 [7:0] and 11 [15:8] of audio group A channel status for channels 1 and 2.	R	0
246h	ACSR1_2A_BYTE 12_13	ACSR1_2A_12	15-0	Bytes 12 [7:0] and 13 [15:8] of audio group A channel status for channels 1 and 2.	R	0
247h	ACSR1_2A_BYTE 14_15	ACSR1_2A_14	15-0	Bytes 14 [7:0] and 15 [15:8] of audio group A channel status for channels 1 and 2.	R	0
248h	ACSR1_2A_BYTE 16_17	ACSR1_2A_16	15-0	Bytes 16 [7:0] and 17 [15:8] of audio group A channel status for channels 1 and 2.	R	0
249h	ACSR1_2A_BYTE 18_19	ACSR1_2A_18	15-0	Bytes 18 [7:0] and 19 [15:8] of audio group A channel status for channels 1 and 2.	R	0
24Ah	ACSR1_2A_BYTE 20_21	ACSR1_2A_20	15-0	Bytes 20 [7:0] and 21 [15:8] of audio group A channel status for channels 1 and 2.	R	0
24Bh	ACSR1_2A_BYTE	RSVD	15-8	Reserved.	R/W	0
22	22	ACSR1_2A_22	7-0	Bytes 22 of audio group A channel status for channels 1 and 2.	R	0
24Ch - 24Fh	RSVD	RSVD	15-0	Reserved.	R/W	0
250h	ACSR3_4A_BYTE 0_1	ACSR3_4A_0	15-0	Bytes 0 [7:0] and 1 [15:8][of audio group A channel status for channels 3 and 4.	R	0
251h	ACSR3_4A_BYTE 2_3	ACSR3_4A_2	15-0	Bytes 2 [7:0] and 3 [15:8] of audio group A channel status for channels 3 and 4.	R	0
252h	ACSR3_4A_BYTE 4_5	ACSR3_4A_4	15-0	Bytes 4 [7:0] and 5 [15:8] of audio group A channel status for channels 3 and 4.	R	0
253h	ACSR3_4A_BYTE 6_7	ACSR3_4A_6	15-0	Bytes 6 [7:0] and 7 [15:8] of audio group A channel status for channels 3 and 4.	R	0
254h	ACSR3_4A_BYTE 8_9	ACSR3_4A_8	15-0	Bytes 8 [7:0] and 9 [15:8] of audio group A channel status for channels 3 and 4.	R	0
255h	ACSR3_4A_BYTE 10_11	ACSR3_4A_10	15-0	Bytes 10 [7:0] and 11 [15:8] of audio group A channel status for channels 3 and 4.	R	0
256h	ACSR3_4A_BYTE 12_13	ACSR3_4A_12	15-0	Bytes 12 [7:0] and 13 [15:8] of audio group A channel status for channels 3 and 4.	R	0
257h	ACSR3_4A_BYTE 14_15	ACSR3_4A_14	15-0	Bytes 14 [7:0] and 15 [15:8] of audio group A channel status for channels 3 and 4.	R	0



Table 4-30: HD Audio Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Defaul
258h	ACSR3_4A_BYTE 16_17	ACSR3_4A_16	15-0	Bytes 16 [7:0] and 17 [15:8] of audio group A channel status for channels 3 and 4.	R	0
259h	ACSR3_4A_BYTE 18_19	ACSR3_4A_18	15-0	Bytes 18 [7:0] and 19 [15:8] of audio group A channel status for channels 3 and 4.	R	0
25Ah	ACSR3_4A_BYTE 20_21	ACSR3_4A_20	15-0	Bytes 20 [7:0] and 21 [15:8] of audio group A channel status for channels 3 and 4.	R	0
25Bh	ACSR3_4A_BYTE 22	RSVD	15-8	Reserved.	R/W	0
	22	ACSR3_4A_22	7-0	Bytes 22 of audio group A channel status for channels 3 and 4.	R	0
25Ch - 25Fh	RSVD	RSVD	15-0	Reserved.	R/W	0
260h	ACSR1_2B_BYTE 0_1	ACSR1_2B_0	15-0	Bytes 0 [7:0] and 1 [15:8] of audio group B channel status for channels 1 and 2.	R	0
261h	ACSR1_2B_BYTE 2_3	ACSR1_2B_2	15-0	Bytes 2 [7:0] and 3 [15:8] of audio group B channel status for channels 1 and 2.	R	0
262h	ACSR1_2B_BYTE 4_5	ACSR1_2B_4	15-0	Bytes 4 [7:0] and 5 [15:8] of audio group B channel status for channels 1 and 2.	R	0
263h	ACSR1_2B_BYTE 6_7	ACSR1_2B_6	15-0	Bytes 6 [7:0] and 7 [15:8] of audio group B channel status for channels 1 and 2.	R	0
264h	ACSR1_2B_BYTE 8_9	ACSR1_2B_8	15-0	Bytes 8 [7:0] and 9 [15:8] of audio group B channel status for channels 1 and 2.	R	0
265h	ACSR1_2B_BYTE 10_11	ACSR1_2B_10	15-0	Bytes 10 [7:0] and 11 [15:8] of audio group B channel status for channels 1 and 2.	R	0
266h	ACSR1_2B_BYTE 12_13	ACSR1_2B_12	15-0	Bytes 12 [7:0] and 13 [15:8] of audio group B channel status for channels 1 and 2.	R	0
267h	ACSR1_2B_BYTE 14_15	ACSR1_2B_14	15-0	Bytes 14 [7:0] and 15 [15:8] of audio group B channel status for channels 1 and 2.	R	0
268h	ACSR1_2B_BYTE 16_17	ACSR1_2B_16	15-0	Bytes 16 [7:0] and 17 [15:8] of audio group B channel status for channels 1 and 2.	R	0
269h	ACSR1_2B_BYTE 18_19	ACSR1_2B_18	15-0	Bytes 18 [7:0] and 19 [15:8] of audio group B channel status for channels 1 and 2.	R	0
26Ah	ACSR1_2B_BYTE 20_21	ACSR1_2B_20	15-0	Bytes 20 [7:0] and 21 [15:8] of audio group B channel status for channels 1 and 2.	R	0



Table 4-30: HD Audio Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Defau
26Bh	ACSR1_2B_BYTE	RSVD	15-8	Reserved.	R/W	0
	22	ACSR1_2B_22	7-0	Bytes 22 of audio group B channel status for channels 1 and 2.	R	0
26Ch - 26Fh	RSVD	RSVD	15-0	Reserved.	R/W	0
270h	ACSR3_4B_BYTE 0_1	ACSR3_4B_0	15-0	Bytes 0 [7:0] and 1 [15:8] of audio group B channel status for channels 3 and 4.	R	0
271h	ACSR3_4B_BYTE 2_3	ACSR3_4B_2	15-0	Bytes 2 [7:0] and 3 [15:8] of audio group B channel status for channels 3 and 4.	R	0
272h	ACSR3_4B_BYTE 4_5	ACSR3_4B_4	15-0	Bytes 4 [7:0] and 5 [15:8] of audio group B channel status for channels 3 and 4.	R	0
273h	ACSR3_4B_BYTE 6_7	ACSR3_4B_6	15-0	Bytes 6 [7:0] and 7 [15:8] of audio group B channel status for channels 3 and 4.	R	0
274h	ACSR3_4B_BYTE 8_9	ACSR3_4B_8	15-0	Bytes 8 [7:0] and 9 [15:8] of audio group B channel status for channels 3 and 4.	R	0
275h	ACSR3_4B_BYTE 10_11	ACSR3_4B_10	15-0	Bytes 10 [7:0] and 11 [15:8] of audio group B channel status for channels 3 and 4.	R	0
276h	ACSR3_4B_BYTE 12_13	ACSR3_4B_12	15-0	Bytes 12 [7:0] and 13 [15:8] of audio group B channel status for channels 3 and 4.	R	0
277h	ACSR3_4B_BYTE 14_15	ACSR3_4B_14	15-0	Bytes 14 [7:0] and 15 [15:8] of audio group B channel status for channels 3 and 4.	R	0
278h	ACSR3_4B_BYTE 16_17	ACSR3_4B_16	15-0	Bytes 16 [7:0] and 17 [15:8] of audio group B channel status for channels 3 and 4.	R	0
279h	ACSR3_4B_BYTE 18_19	ACSR3_4B_18	15-0	Bytes 18 [7:0] and 19 [15:8] of audio group B channel status for channels 3 and 4.	R	0
27Ah	ACSR3_4B_BYTE 20_21	ACSR3_4B_20	15-0	Bytes 20 [7:0] and 21 [15:8] of audio group B channel status for channels 3 and 4.	R	0
27Bh	ACSR3_4B_BYTE	RSVD	15-8	Reserved.	R/W	0
	22	ACSR3_4B_22	7-0	Bytes 22 of audio group B channel status for channels 3 and 4.	R	0
27Ch - 27Fh	RSVD	RSVD	15-0	Reserved.	R/W	0



Table 4-30: HD Audio Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Default
280h	ACSR_BYTE_0	RSVD	15-8	Reserved.	R/W	0
		ACSR0	7-0	Audio channel status to use when ACS_REGEN is set or when adding audio channel status to non-AES/EBU audio. 8 bits per register starting at register 280h and ending at register 296h.	W	0
281h	ACSR_BYTE_1	RSVD	15-8	Reserved.	R/W	0
		ACSR1	7-0	Audio channel status to use when ACS_REGEN is set or when adding audio channel status to non-AES/EBU audio. 8 bits per register starting at register 280h and ending at register 296h.	W	0
282h	ACSR_BYTE_2	RSVD	15-8	Reserved.	R/W	0
		ACSR2	7-0	Audio channel status to use when ACS_REGEN is set or when adding audio channel status to non-AES/EBU audio. 8 bits per register starting at register 280h and ending at register 296h.	W	0
283h	ACSR_BYTE_3	RSVD	15-8	Reserved.	R/W	0
		ACSR3	7-0	Audio channel status to use when ACS_REGEN is set or when adding audio channel status to non-AES/EBU audio. 8 bits per register starting at register 280h and ending at register 296h.	W	0
284h	ACSR_BYTE_4	RSVD	15-8	Reserved.	R/W	0
		ACSR4	7-0	Audio channel status to use when ACS_REGEN is set or when adding audio channel status to non-AES/EBU audio. 8 bits per register starting at register 280h and ending at register 296h.	W	0
285h	ACSR_BYTE_5	RSVD	15-8	Reserved.	R/W	0
		ACSR5	7-0	Audio channel status to use when ACS_REGEN is set or when adding audio channel status to non-AES/EBU audio. 8 bits per register starting at register 280h and ending at register 296h.	W	0
286h	ACSR_BYTE_6	RSVD	15-8	Reserved.	R/W	0
		ACSR6	7-0	Audio channel status to use when ACS_REGEN is set or when adding audio channel status to non-AES/EBU audio. 8 bits per register starting at register 280h and ending at register 296h.	W	0



Table 4-30: HD Audio Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Default
287h	ACSR_BYTE_7	RSVD	15-8	Reserved.	R/W	0
		ACSR7	7-0	Audio channel status to use when ACS_REGEN is set or when adding audio channel status to non-AES/EBU audio. 8 bits per register starting at register 280h and ending at register 296h.	W	0
288h	ACSR_BYTE_8	RSVD	15-8	Reserved.	R/W	0
		ACSR8	7-0	Audio channel status to use when ACS_REGEN is set or when adding audio channel status to non-AES/EBU audio. 8 bits per register starting at register 280h and ending at register 296h.	W	0
289h	ACSR_BYTE_9	RSVD	15-8	Reserved.	R/W	0
		ACSR9	7-0	Audio channel status to use when ACS_REGEN is set or when adding audio channel status to non-AES/EBU audio. 8 bits per register starting at register 280h and ending at register 296h.	W	0
28Ah	ACSR_BYTE_10	RSVD	15-8	Reserved.	R/W	0
		ACSR10	7-0	Audio channel status to use when ACS_REGEN is set or when adding audio channel status to non-AES/EBU audio. 8 bits per register starting at register 280h and ending at register 296h.	W	0
28Bh	ACSR_BYTE_11	RSVD	15-8	Reserved.	R/W	0
		ACSR11	7-0	Audio channel status to use when ACS_REGEN is set or when adding audio channel status to non-AES/EBU audio. 8 bits per register starting at register 280h and ending at register 296h.	W	0
28Ch	ACSR_BYTE_12	RSVD	15-8	Reserved.	R/W	0
		ACSR12	7-0	Audio channel status to use when ACS_REGEN is set or when adding audio channel status to non-AES/EBU audio. 8 bits per register starting at register 280h and ending at register 296h.	W	0
28Dh	ACSR_BYTE_13	RSVD	15-8	Reserved.	R/W	0
		ACSR13	7-0	Audio channel status to use when ACS_REGEN is set or when adding audio channel status to non-AES/EBU audio. 8 bits per register starting at register 280h and ending at register 296h.	W	0



Table 4-30: HD Audio Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Default
28Eh	ACSR_BYTE_14	RSVD	15-8	Reserved.	R/W	0
		ACSR14	7-0	Audio channel status to use when ACS_REGEN is set or when adding audio channel status to non-AES/EBU audio. 8 bits per register starting at register 280h and ending at register 296h.	W	0
28Fh	ACSR_BYTE_15	RSVD	15-8	Reserved.	R/W	0
		ACSR15	7-0	Audio channel status to use when ACS_REGEN is set or when adding audio channel status to non-AES/EBU audio. 8 bits per register starting at register 280h and ending at register 296h.	W	0
290h	ACSR_BYTE_16	RSVD	15-8	Reserved.	R/W	0
		ACSR16	7-0	Audio channel status to use when ACS_REGEN is set or when adding audio channel status to non-AES/EBU audio. 8 bits per register starting at register 280h and ending at register 296h.	W	0
291h	ACSR_BYTE_17	RSVD	15-8	Reserved.	R/W	0
		ACSR17	7-0	Audio channel status to use when ACS_REGEN is set or when adding audio channel status to non-AES/EBU audio. 8 bits per register starting at register 280h and ending at register 296h.	W	0
292h	ACSR_BYTE_18	RSVD	15-8	Reserved.	R/W	0
		ACSR18	7-0	Audio channel status to use when ACS_REGEN is set or when adding audio channel status to non-AES/EBU audio. 8 bits per register starting at register 280h and ending at register 296h.	W	0
293h	ACSR_BYTE_19	RSVD	15-8	Reserved.	R/W	0
		ACSR19	7-0	Audio channel status to use when ACS_REGEN is set or when adding audio channel status to non-AES/EBU audio. 8 bits per register starting at register 280h and ending at register 296h.	W	0
294h	ACSR_BYTE_20	RSVD	15-8	Reserved.	R/W	0
		ACSR20	7-0	Audio channel status to use when ACS_REGEN is set or when adding audio channel status to non-AES/EBU audio. 8 bits per register starting at register 280h and ending at register 296h.	W	0



Table 4-30: HD Audio Core Configuration and Status Registers (Continued)

Address	Register Name	Bit Name	Bit	Description	R/W	Default
295h	ACSR_BYTE_21	RSVD	15-8	Reserved.	R/W	0
		ACSR21	7-0	Audio channel status to use when ACS_REGEN is set or when adding audio channel status to non-AES/EBU audio. 8 bits per register starting at register 280h and ending at register 296h.	W	0
296h	ACSR_BYTE_22	RSVD	15-8	Reserved.	R/W	0
		ACSR22	7-0	Audio channel status to use when ACS_REGEN is set or when adding audio channel status to non-AES/EBU audio. 8 bits per register starting at register 280h and ending at register 296h.	W	0
297h	RSVD	RSVD	15-0	Reserved.	R	29

Table 4-31: ANC Extraction FIFO Access Registers

Address	Register Name	Bit	Description	R/W	Default
800h - BFFh	ANC_PACKET_BANK	15-0	Extracted Ancillary Data 91024 words. Bit 15-8: Most Significant Word (MSW). Bit 7-0: Least Significant Word (LSW). See Section 4.17.8.	R	0

Legend:

R = Read only ROCW = Read Only, Clear on Write R/W = Read or Write W = Write only

4.21 JTAG Test Operation

When the JTAG/ $\overline{\text{HOST}}$ pin of the GS1670A is set HIGH, the host interface port is configured for JTAG test operation. In this mode, pins E7, F8, F7, and E8 become TDO, TCK, TMS, and TDI. In addition, the $\overline{\text{RESET_TRST}}$ pin operates as the test reset pin.

Boundary scan testing using the JTAG interface is enabled in this mode.

There are two ways in which JTAG can be used:

- 1. As a stand-alone JTAG interface to be used at in-circuit ATE (Automatic Test Equipment) during PCB assembly.
- 2. Under control of a host processor for applications such as system power on self tests.

When the JTAG tests are applied by ATE, care must be taken to disable any other devices driving the digital I/O pins. If the tests are to be applied only at ATE, this can be



accomplished with tri-state buffers used in conjunction with the JTAG/ $\overline{\text{HOST}}$ input signal. This is shown in Figure 4-44.

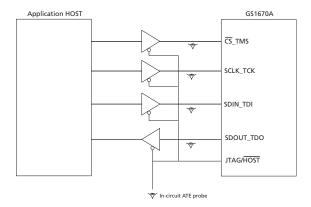


Figure 4-44: In-Circuit JTAG

Alternatively, if the test capabilities are to be used in the system, the host processor may still control the $\overline{JTAG/HOST}$ input signal, but some means for tri-stating the host must exist in order to use the interface at ATE. This is represented in Figure 4-45.

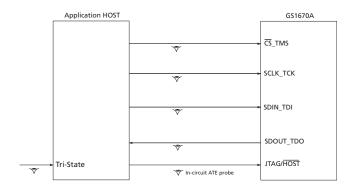


Figure 4-45: System JTAG

Scan coverage is limited to digital pins only. There is no scan coverage for analog pins VCO, SDO/ $\overline{\text{SDO}}$, RSET, LF, and CP_RES.

The JTAG/HOST pin must be held LOW during scan and therefore has no scan coverage.

Please contact your Semtech representative to obtain the BSDL model for the GS1670A.

4.22 Device Power-up

Because the GS1670A is designed to operate in a multi-voltage environment, any power-up sequence is allowed. The charge pump, phase detector, core logic, serial digital output and I/O buffers can all be powered up in any order.

NOTE: Power ramp-up time (10% to 90%) \geq 40 μ s.

4.23 Device Reset

NOTE: At power-up, the device must be reset to operate correctly.

In order to initialize all internal operating conditions to their default states, hold the $\overline{RESET_TRST}$ signal LOW for a minimum of t_{reset} = 1ms after all power supplies are stable. There are no requirements for power supply sequencing.

When held in reset, all device outputs are driven to a high-impedance state.

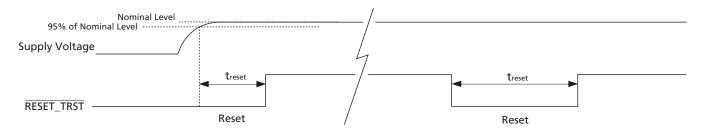


Figure 4-46: Reset Pulse

4.24 Standby Mode

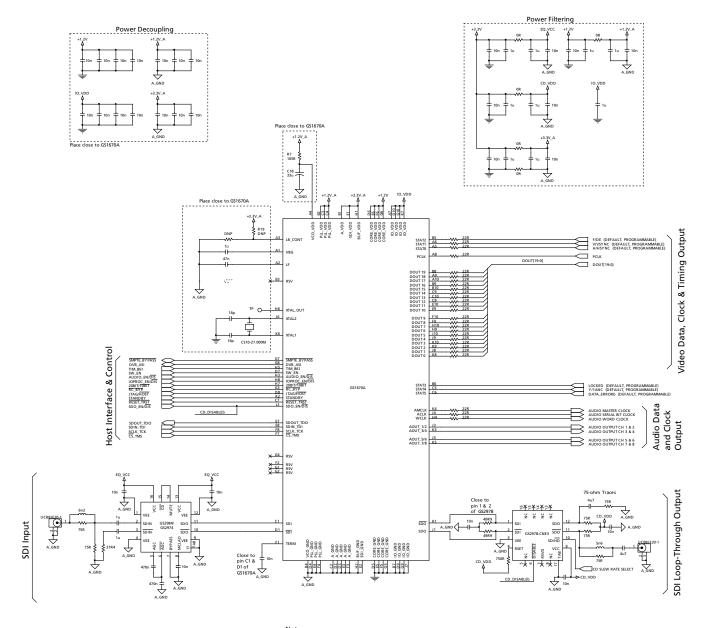
The STANDBY pin reduces power to a minimum by disabling all circuits except for the register configuration. Upon removal of the signal to the STANDBY pin, the device returns to its previous operating condition within 1 second, without requiring input from the host interface.

NOTE: In standby mode or reset, the crystal buffer output remains enabled. This allows users to reset the GS1670A device without resetting other downstream devices that are using the same reference. This also allows users to put the GS1670A device in standby mode and still use the loop-through mode.



5. Application Reference Design

5.1 Typical Application Circuit



Notes:

1. DNP (Do Not Ropulate).

2. The value of the series resistors on video data, clock, and timing connections should be determined by board signal integrity test.

3. For analog power and ground isolation refer to RR layout guide.

4. For impedance controlled signal layout refer to RCB layout guide.

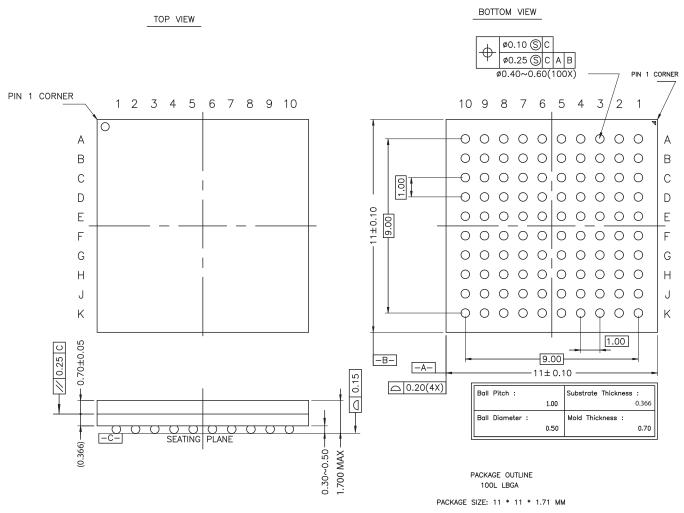
6. References & Relevant Standards

SMPTE 125M	Component video signal 4:2:2 – bit parallel interface	
SMPTE 259M 10-bit 4:2:2 Component and 4fsc Composite Digital Signals - Serial Dig Interface		
SMPTE 260M	1125 / 60 high definition production system – digital representation and bit parallel interface	
SMPTE 267M	Bit parallel digital interface – component video signal 4:2:2 16 x 9 aspect ratio	
SMPTE 272M	Formatting AES/EBU Audio and Auxiliary Data into Digital Video Ancillary Data Space	
SMPTE 274M	1920 x 1080 scanning analog and parallel digital interfaces for multiple picture rates	
SMPTE 291M	Ancillary Data Packet and Space Formatting	
SMPTE 292	Bit-Serial Digital Interface for High-Definition Television Systems	
SMPTE 293M	720x483 active line at 59.94 Hz progressive scan production – digital representation	
SMPTE 296M	1280 x 720 scanning, analog and digital representation and analog interface	
SMPTE 299M	24-Bit Digital Audio Format for HDTV Bit-Serial Interface	
SMPTE 352M	Video Payload Identification for Digital Television Interfaces	
SMPTE RP165	Error Detection Checkwords and Status Flags for Use in Bit-Serial Digital Interfaces for Television	
SMPTE RP168	Definition of Vertical Interval Switching Point for Synchronous Video Switching	



7. Package & Ordering Information

7.1 Package Dimensions



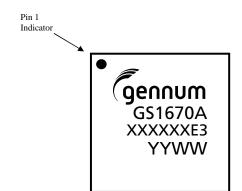
^{*} THE BALL DIAMETER, BALL PITCH, STAND-OFF & PACKAGE THICKNESS ARE DIFFERENT FROM JEDEC SPEC MO192 (LOW PROFILE BGA FAMILY)

7.2 Packaging Data

Table 7-1: Packaging Data

Parameter	Value
Package Type	11mm x 11mm 100-ball LBGA
Package Drawing Reference	JEDEC M0192 (with exceptions noted in Package Dimensions on page 127).
Moisture Sensitivity Level	3
Junction to Case Thermal Resistance, θ_{j-c}	15.4°C/W
Junction to Air Thermal Resistance, θ_{j-a} (at zero airflow)	37.1°C/W
Junction to Board Thermal Resistance, $\theta_{j\text{-}b}$	26.4°C/W
Psi, ψ	0.4°C/W
Pb-free and RoHS Compliant	Yes

7.3 Marking Diagram



XXXXXX - Last 6 digits (excluding decimal) of SAP Batch Assembly (FIN) as listed on Packing Slip

E3 - Pb-free & Green indicator

YYWW - Date Code

7.4 Solder Reflow Profiles

The GS1670A is available in a Pb-free package. It is recommended that the Pb-free package be soldered with Pb-free paste using the reflow profile shown in Figure 7-1.

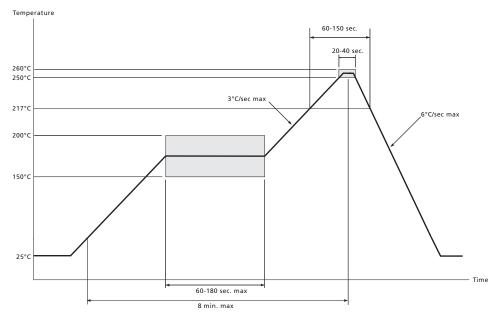


Figure 7-1:Pb-Free Solder Reflow Profile

7.5 Ordering Information

Part Number	Package	Pb-free	Temperature Range
GS1670AIBE3	100-ball BGA	Yes	-40°C to 85°C
GS1670AIBTE3 (250pc tape and reel)	100-ball BGA	Yes	-40°C to 85°C

Revision History

Version	ECR	PCN	Date	Changes and/or Modifications
1	158468	-	September 2012	Changes throughout the document.
0	154534	-	July 2010	New document.



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